### **Freescale Semiconductor**

Data Sheet: Technical Data

Document Number: DSP56366 Rev. 3.1, 1/2007

# DSP56366

24-Bit Audio Digital Signal Processor

# 1 Overview

The DSP56366 supports digital audio applications requiring sound field processing, acoustic equalization, and other digital audio algorithms. The DSP56366 uses the high performance, single-clock-per-cycle DSP56300 core family of programmable CMOS digital signal processors (DSPs) combined with the audio signal processing capability of the Freescale Symphony<sup>™</sup> DSP family, as shown in Figure 1-1. This design provides a two-fold performance increase over Freescale's popular 56000 Symphony family of DSPs while retaining code compatibility. Significant architectural enhancements include a barrel shifter, 24-bit addressing, instruction cache, and direct memory access (DMA). The DSP56366 offers 120 million instructions per second (MIPS) using an internal 120 MHz clock at 3.3 V.

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A Power Consumption Benchmark ..... A-1

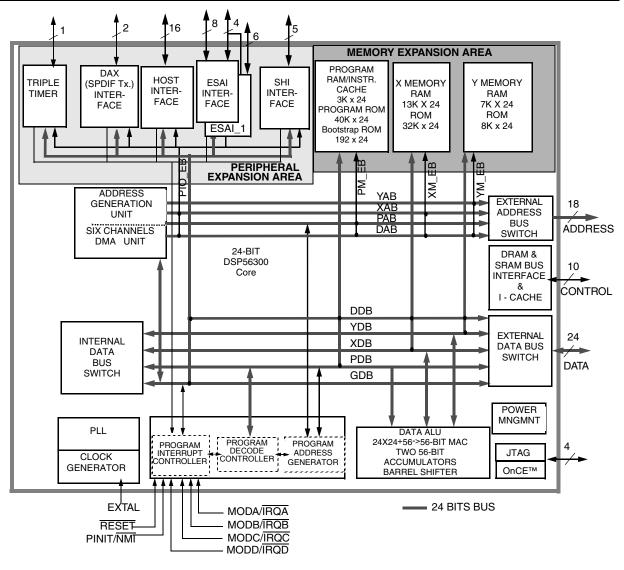
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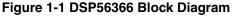


#### Overview

| Data Sheet Conventions<br>This data sheet uses the following conventions: |   |   |            |                                   |  |  |
|---|---|---|------------|-----------------------------------|--|--|
| OVERBAR   | Used to indicate a signal that is active when pulled low (For example, the RESET pin is active when low.) |   |            |                                   |  |  |
| "asserted"  | Means that a high true  | Means that a high true (active high) signal is high or that a low true (active low) signal is low |            |                                   |  |  |
| "deasserted"  | Means that a high true (active high) signal is low or that a low true (active low) signal is high         |   |            |                                   |  |  |
| Examples:   | Signal/Symbol Logic State Signal State Voltage  |   |            |                                   |  |  |
|   | PIN   | True  | Asserted   | V <sub>IL</sub> / V <sub>OL</sub> |  |  |
| PIN False   |   | False   | Deasserted | V <sub>IH</sub> / V <sub>OH</sub> |  |  |
|   | PIN   | True  | Asserted   | V <sub>IH</sub> / V <sub>OH</sub> |  |  |
|   | PIN False Deasserted $V_{IL} / V_{OL}$  |   |            |                                   |  |  |

Note: \*Values for V<sub>IL</sub>, V<sub>OL</sub>, V<sub>IH</sub>, and V<sub>OH</sub> are defined by individual product specifications.





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### 1.1 Features

### 1.1.1 DSP56300 Modular Chassis

- 120 Million Instructions Per Second (MIPS) with an 120 MHz clock at 3.3V.
- Object Code Compatible with the 56K core.
- Data ALU with a 24 x 24 bit multiplier-accumulator and a 56-bit barrel shifter. 16-bit arithmetic support.
- Program Control with position independent code support and instruction cache support.
- Six-channel DMA controller.
- PLL based clocking with a wide range of frequency multiplications (1 to 4096), predivider factors (1 to 16) and power saving clock divider (2<sup>i</sup>: i=0 to 7). Reduces clock noise.
- Internal address tracing support and OnCE™ for Hardware/Software debugging.
- JTAG port.
- Very low-power CMOS design, fully static design with operating frequencies down to DC.
- STOP and WAIT low-power standby modes.

### 1.1.2 On-chip Memory Configuration

- 7Kx24 Bit Y-Data RAM and 8Kx24 Bit Y-Data ROM.
- 13Kx24 Bit X-Data RAM and 32Kx24 Bit X-Data ROM.
- 40Kx24 Bit Program ROM.
- 3Kx24 Bit Program RAM and 192x24 Bit Bootstrap ROM. 1K of Program RAM may be used as Instruction Cache or for Program ROM patching.
- 2Kx24 Bit from Y Data RAM and 5Kx24 Bit from X Data RAM can be switched to Program RAM resulting in up to 10Kx24 Bit of Program RAM.

### 1.1.3 Off-chip Memory Expansion

- External Memory Expansion Port.
- Off-chip expansion up to two 16M x 24-bit word of Data memory.
- Off-chip expansion up to 16M x 24-bit word of Program memory.
- Simultaneous glueless interface to SRAM and DRAM.

### 1.1.4 Peripheral Modules

- Serial Audio Interface (ESAI): up to 4 receivers and up to 6 transmitters, master or slave. I<sup>2</sup>S, Sony, AC97, network and other programmable protocols.
- Serial Audio Interface I(ESAI\_1): up to 4 receivers and up to 6 transmitters, master or slave. I<sup>2</sup>S, Sony, AC97, network and other programmable protocols The ESAI\_1 shares four of the data pins with ESAI, and ESAI\_1 does NOT support HCKR and HCKT (high frequency clocks)

#### Overview

- Serial Host Interface (SHI): SPI and I<sup>2</sup>C protocols, multi master capability, 10-word receive FIFO, support for 8, 16 and 24-bit words.
- Byte-wide parallel Host Interface (HDI08) with DMA support.
- Triple Timer module (TEC).
- Digital Audio Transmitter (DAX): 1 serial transmitter capable of supporting the SPDIF, IEC958, CP-340 and AES/EBU digital audio formats.
- Pins of unused peripherals (except SHI) may be programmed as GPIO lines.

### 1.1.5 Packaging

• 144-pin plastic LQFP package.

### 1.2 Documentation

Table 1-1 lists the documents that provide a complete description of the DSP56366 and are required to design properly with the part. Documentation is available from a local Freescale distributor, a Freescale semiconductor sales office, a Freescale Literature Distribution Center, or through the Freescale DSP home page on the Internet (the source for the latest information).

| Document Name                                    | Description   | Order Number   |
|--|---|--|
| DSP56300 Family Manual                           | Detailed description of the 56300-family architecture and the 24-bit core processor and instruction set | DSP56300FM   |
| DSP56366 User's Manual                           | Detailed description of memory, peripherals, and interfaces   | DSP56366UM   |
| DSP56366 Product Brief                           | Brief description of the chip   | DSP56366P  |
| DSP56366 Technical Data Sheet<br>(this document) | Electrical and timing specifications; pin and package descriptions                                      | DSP56366   |
| IBIS Model                                       | Input Output Buffer Information Specification.  | For software or simulation<br>models, contact sales or<br>go to www.freescale.com. |

# 2 Signal/Connection Descriptions

### 2.1 Signal Groupings

The input and output signals of the DSP56366 are organized into functional groups, which are listed in Table 2-1 and illustrated in Figure 2-1.

The DSP56366 is operated from a 3.3 V supply; however, some of the inputs can tolerate 5 V. A special notice for this feature is added to the signal descriptions of those inputs.

| Functional Group                | Number of<br>Signals | Detailed<br>Description |            |
|---------------------------------|----------------------|-------------------------|------------|
| Power (V <sub>CC</sub> )        |                      | 20                      | Table 2-2  |
| Ground (GND)                    | und (GND) 18         |                         | Table 2-3  |
| Clock and PLL                   | 3                    |                         | Table 2-4  |
| Address bus                     |                      | 18                      | Table 2-5  |
| Data bus                        | Port A <sup>1</sup>  | 24                      | Table 2-6  |
| Bus control                     | 10                   | Table 2-7               |            |
| Interrupt and mode control      | I                    | 5                       | Table 2-8  |
| HDI08                           | 16                   | Table 2-9               |            |
| SHI                             | 5                    | Table 2-10              |            |
| ESAI                            | Port C <sup>3</sup>  | 12                      | Table 2-11 |
| ESAI_1                          | Port E <sup>4</sup>  | 6                       | Table 2-12 |
| Digital audio transmitter (DAX) | 2                    | Table 2-13              |            |
| Timer                           | 1                    | Table 2-14              |            |
| JTAG/OnCE Port                  | 4                    | Table 2-15              |            |

Table 2-1 DSP56366 Functional Signal Groupings

<sup>1</sup> Port A is the external memory interface port, including the external address bus, data bus, and control signals.

<sup>2</sup> Port B signals are the GPIO port signals which are multiplexed with the HDI08 signals.

<sup>3</sup> Port C signals are the GPIO port signals which are multiplexed with the ESAI signals.

<sup>4</sup> Port E signals are the GPIO port signals which are multiplexed with the ESAI\_1 signals.

<sup>5</sup> Port D signals are the GPIO port signals which are multiplexed with the DAX signals.

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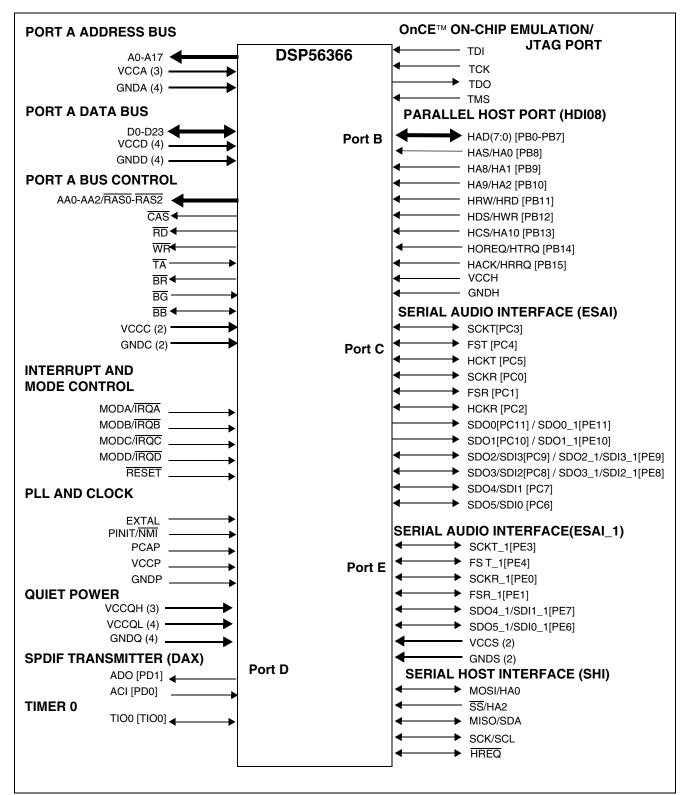


Figure 2-1 Signals Identified by Functional Group

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### 2.2 Power

| Power Name            | Description  |
|-----------------------|--|
| V <sub>CCP</sub>      | <b>PLL Power</b> — $V_{CCP}$ is $V_{CC}$ dedicated for PLL use. The voltage should be well-regulated and the input should be provided with an extremely low impedance path to the $V_{CC}$ power rail. There is one $V_{CCP}$ input.   |
| V <sub>CCQL</sub> (4) | <b>Quiet Core (Low) Power</b> — $V_{CCQL}$ is an isolated power for the internal processing logic. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There are four $V_{CCQL}$ inputs.                           |
| V <sub>CCQH</sub> (3) | <b>Quiet External (High) Power</b> — $V_{CCQH}$ is a quiet power source for I/O lines. This input must be tied externally to all other chip power inputs. The user must provide adequate decoupling capacitors. There are three $V_{CCQH}$ inputs.   |
| V <sub>CCA</sub> (3)  | Address Bus Power—V <sub>CCA</sub> is an isolated power for sections of the address bus I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There are three V <sub>CCA</sub> inputs.                  |
| V <sub>CCD</sub> (4)  | <b>Data Bus Power</b> — $V_{CCD}$ is an isolated power for sections of the data bus I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There are four $V_{CCD}$ inputs.                              |
| V <sub>CCC</sub> (2)  | <b>Bus Control Power</b> — $V_{CCC}$ is an isolated power for the bus control I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There are two $V_{CCC}$ inputs.                                     |
| V <sub>CCH</sub>      | Host Power— $V_{CCH}$ is an isolated power for the HDI08 I/O drivers. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There is one $V_{CCH}$ input.  |
| V <sub>CCS</sub> (2)  | SHI, ESAI, ESAI_1, DAX and Timer Power —V <sub>CCS</sub> is an isolated power for the SHI, ESAI, ESAI_1, DAX and Timer. This input must be tied externally to all other chip power inputs. The user must provide adequate external decoupling capacitors. There are two V <sub>CCS</sub> inputs. |

## 2.3 Ground

#### Table 2-3 Grounds

| Ground Name          | Description  |
|----------------------|--|
| GND <sub>P</sub>     | <b>PLL Ground</b> —GND <sub>P</sub> is a ground dedicated for PLL use. The connection should be provided with an extremely low-impedance path to ground. V <sub>CCP</sub> should be bypassed to GND <sub>P</sub> by a 0.47 $\mu$ F capacitor located as close as possible to the chip package. There is one GND <sub>P</sub> connection. |
| GND <sub>Q</sub> (4) | <b>Quiet Ground</b> — $GND_Q$ is an isolated ground for the internal processing logic. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There are four $GND_Q$ connections.  |
| GND <sub>A</sub> (4) | <b>Address Bus Ground</b> — $GND_A$ is an isolated ground for sections of the address bus I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There are four $GND_A$ connections.  |

| Table 2-3 | Grounds | (continued) |
|-----------|---------|-------------|
|-----------|---------|-------------|

| Ground Name          | Description   |
|----------------------|---|
| GND <sub>D</sub> (4) | <b>Data Bus Ground</b> — $GND_D$ is an isolated ground for sections of the data bus I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There are four $GND_D$ connections.                                 |
| GND <sub>C</sub> (2) | <b>Bus Control Ground</b> —GND <sub>C</sub> is an isolated ground for the bus control I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There are two GND <sub>C</sub> connections.                       |
| GND <sub>H</sub>     | <b>Host Ground</b> —GND <sub>h</sub> is an isolated ground for the HD08 I/O drivers. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There is one $\text{GND}_{\text{H}}$ connection.                                |
| GND <sub>S</sub> (2) | SHI, ESAI, ESAI_1, DAX and Timer Ground—GND <sub>S</sub> is an isolated ground for the SHI, ESAI, ESAI_1, DAX and Timer. This connection must be tied externally to all other chip ground connections. The user must provide adequate external decoupling capacitors. There are two GND <sub>S</sub> connections. |

### 2.4 Clock and PLL

| Signal<br>Name | Туре  | State<br>during<br>Reset | Signal Description   |
|----------------|-------|--------------------------|--|
| EXTAL          | Input | Input                    | <b>External Clock Input</b> —An external clock source must be connected to EXTAL in order to supply the clock to the internal clock generator and PLL. <i>This input cannot tolerate 5 V.</i>  |
| PCAP           | Input | Input                    | <b>PLL Capacitor</b> —PCAP is an input connecting an off-chip capacitor to the PLL filter.<br>Connect one capacitor terminal to PCAP and the other terminal to $V_{CCP}$<br>If the PLL is not used, PCAP may be tied to $V_{CC}$ , GND, or left floating.  |
| PINIT/NMI      | Input | Input                    | <b>PLL Initial/Nonmaskable Interrupt</b> —During assertion of RESET, the value of PINIT/NMI is written into the PLL Enable (PEN) bit of the PLL control register, determining whether the PLL is enabled or disabled. After RESET de assertion and during normal instruction processing, the PINIT/NMI Schmitt-trigger input is a negative-edge-triggered nonmaskable interrupt (NMI) request internally synchronized to internal system clock. <i>This input cannot tolerate 5 V.</i> |

#### Table 2-4 Clock and PLL Signals

### 2.5 External Memory Expansion Port (Port A)

When the DSP56366 enters a low-power standby mode (stop or wait), it releases bus mastership and tri-states the relevant port A signals: A0–A17, D0–D23, AA0/RAS0–AA2/RAS2, RD, WR, BB, CAS.

### 2.5.1 External Address Bus

| Signal<br>Name | Туре   | State<br>during<br>Reset | Signal Description  |
|----------------|--------|--------------------------|---|
| A0–A17         | Output | Tri-stated               | <b>Address Bus</b> —When the DSP is the bus master, A0–A17 are active-high outputs that specify the address for external program and data memory accesses. Otherwise, the signals are tri-stated. To minimize power dissipation, A0–A17 do not change state when external memory spaces are not being accessed. |

#### Table 2-5 External Address Bus Signals

### 2.5.2 External Data Bus

#### Table 2-6 External Data Bus Signals

| Signal<br>Name | Туре         | State<br>during<br>Reset | Signal Description  |
|----------------|--------------|--------------------------|---|
| D0-D23         | Input/Output | Tri-stated               | <b>Data Bus</b> —When the DSP is the bus master, D0–D23 are active-high, bidirectional input/outputs that provide the bidirectional data bus for external program and data memory accesses. Otherwise, D0–D23 are tri-stated. |

### 2.5.3 External Bus Control

#### Table 2-7 External Bus Control Signals

| Signal Name           | Туре   | State during<br>Reset | Signal Description  |
|-----------------------|--------|-----------------------|---|
| AA0-AA2/<br>RAS0-RAS2 | Output | Tri-stated            | Address Attribute or Row Address Strobe—When defined as AA, these signals can be used as chip selects or additional address lines. When defined as RAS, these signals can be used as RAS for DRAM interface. These signals are tri-statable outputs with programmable polarity. |
| CAS                   | Output | Tri-stated            | <b>Column Address Strobe</b> — When the DSP is the bus master, CAS is an active-low output used by DRAM to strobe the column address. Otherwise, if the bus mastership enable (BME) bit in the DRAM control register is cleared, the signal is tri-stated.                      |
| RD                    | Output | Tri-stated            | <b>Read Enable</b> —When the DSP is the bus master, $\overline{RD}$ is an active-low output that is asserted to read external memory on the data bus (D0-D23). Otherwise, $\overline{RD}$ is tri-stated.  |
| WR                    | Output | Tri-stated            | <b>Write Enable</b> —When the DSP is the bus master, $\overline{WR}$ is an active-low output that is asserted to write external memory on the data bus (D0-D23). Otherwise, $\overline{WR}$ is tri-stated.  |

| Signal Name | Туре   | State during<br>Reset  | Signal Description   |
|-------------|--------|------------------------|--|
| TA          | Input  | Ignored Input          | <b>Transfer Acknowledge</b> —If the DSP is the bus master and there is no external bus activity, or the DSP is not the bus master, the TA input is ignored. The TA input is a data transfer acknowledge (DTACK) function that can extend an external bus cycle indefinitely. Any number of wait states (1, 2 infinity) may be added to the wait states inserted by the BCR by keeping TA deasserted. In typical operation, TA is deasserted at the start of a bus cycle, is asserted to enable completion of the bus cycle, and is deasserted before the next bus cycle. The current bus cycle completes one clock period after TA is asserted synchronous to the internal system clock. The number of wait states in external bus cycles. In order to use the TA functionality, the BCR must be programmed to at least one wait state. A zero wait state access cannot be extended by TA deassertion, otherwise improper operation may result. TA can operate synchronously or asynchronously, depending on the setting of the TAS bit in the operating mode register (OMR).        |
| BR          | Output | Output<br>(deasserted) | <b>Bus Request</b> — $\overline{BR}$ is an active-low output, never tri-stated. $\overline{BR}$ is asserted<br>when the DSP requests bus mastership. $\overline{BR}$ is deasserted when the DSP no<br>longer needs the bus. $\overline{BR}$ may be asserted or deasserted independent of<br>whether the DSP56366 is a bus master or a bus slave. Bus "parking" allows $\overline{BR}$<br>to be deasserted even though the DSP56366 is the bus master. (See the<br>description of bus "parking" in the $\overline{BB}$ signal description.) The bus request hold<br>(BRH) bit in the BCR allows $\overline{BR}$ to be asserted under software control even<br>though the DSP does not need the bus. $\overline{BR}$ is typically sent to an external bus<br>arbitrator that controls the priority, parking, and tenure of each master on the<br>same external bus. $\overline{BR}$ is only affected by DSP requests for the external bus,<br>never for the internal bus. During hardware reset, $\overline{BR}$ is deasserted and the<br>arbitration is reset to the bus slave state. |

#### Table 2-7 External Bus Control Signals (continued)

| Signal Name | Туре         | State during<br>Reset | Signal Description   |
|-------------|--------------|-----------------------|--|
| BG          | Input        | Ignored Input         | <b>Bus Grant</b> — $\overline{BG}$ is an active-low input. $\overline{BG}$ is asserted by an external bus arbitration circuit when the DSP56366 becomes the next bus master. When $\overline{BG}$ is asserted, the DSP56366 must wait until $\overline{BB}$ is deasserted before taking bus mastership. When $\overline{BG}$ is deasserted, bus mastership is typically given up at the end of the current bus cycle. This may occur in the middle of an instruction that requires more than one external bus cycle for execution.<br>For proper $\overline{BG}$ operation, the asynchronous bus arbitration enable bit (ABE) in the OMR register must be set.   |
| BB          | Input/Output | Input                 | <b>Bus Busy</b> —BB is a bidirectional active-low input/output. BB indicates that the bus is active. Only after BB is deasserted can the pending bus master become the bus master (and then assert the signal again). The bus master may keep BB asserted after ceasing bus activity regardless of whether BR is asserted or deasserted. This is called "bus parking" and allows the current bus master to reuse the bus without rearbitration until another device requires the bus. The deassertion of BB is done by an "active pull-up" method (i.e., BB is driven high and then released and held high by an external pull-up resistor). For proper BB operation, the asynchronous bus arbitration enable bit (ABE) in the OMR register must be set. |

| Table 2-7 External Bus Control Signals (continued | Table 2-7 | External Bus Control Signals (continued) |
|---|-----------|--|
|---|-----------|--|

## 2.6 Interrupt and Mode Control

The interrupt and mode control signals select the chip's operating mode as it comes out of hardware reset. After RESET is deasserted, these inputs are hardware interrupt request lines.

| Signal Name | Туре  | State<br>during<br>Reset | Signal Description   |
|-------------|-------|--------------------------|--|
| MODA/IRQA   | Input | Input                    | <b>Mode Select A/External Interrupt Request A</b> —MODA/IRQA is an active-low<br>Schmitt-trigger input, internally synchronized to the DSP clock. MODA/IRQA selects the<br>initial chip operating mode during hardware reset and becomes a level-sensitive or<br>negative-edge-triggered, maskable interrupt request input during normal instruction<br>processing. MODA, MODB, MODC, and MODD select one of 16 initial chip operating<br>modes, latched into the OMR when the RESET signal is deasserted. If the processor is<br>in the stop standby state and the MODA/IRQA pin is pulled to GND, the processor will<br>exit the stop state.<br><i>This input is 5 V tolerant.</i> |
| MODB/IRQB   | Input | Input                    | <b>Mode Select B/External Interrupt Request B</b> —MODB/IRQB is an active-low<br>Schmitt-trigger input, internally synchronized to the DSP clock. MODB/IRQB selects the<br>initial chip operating mode during hardware reset and becomes a level-sensitive or<br>negative-edge-triggered, maskable interrupt request input during normal instruction<br>processing. MODA, MODB, MODC, and MODD select one of 16 initial chip operating<br>modes, latched into OMR when the RESET signal is deasserted.<br>This input is 5 V tolerant.  |
| MODC/IRQC   | Input | Input                    | <b>Mode Select C/External Interrupt Request C</b> —MODC/IRQC is an active-low<br>Schmitt-trigger input, internally synchronized to the DSP clock. MODC/IRQC selects the<br>initial chip operating mode during hardware reset and becomes a level-sensitive or<br>negative-edge-triggered, maskable interrupt request input during normal instruction<br>processing. MODA, MODB, MODC, and MODD select one of 16 initial chip operating<br>modes, latched into OMR when the RESET signal is deasserted.<br>This input is 5 V tolerant.  |
| MODD/IRQD   | Input | Input                    | <b>Mode Select D/External Interrupt Request D</b> —MODD/IRQD is an active-low<br>Schmitt-trigger input, internally synchronized to the DSP clock. MODD/IRQD selects the<br>initial chip operating mode during hardware reset and becomes a level-sensitive or<br>negative-edge-triggered, maskable interrupt request input during normal instruction<br>processing. MODA, MODB, MODC, and MODD select one of 16 initial chip operating<br>modes, latched into OMR when the RESET signal is deasserted.<br>This input is 5 V tolerant.  |
| RESET       | Input | Input                    | <b>Reset</b> —RESET is an active-low, Schmitt-trigger input. When asserted, the chip is placed in the Reset state and the internal phase generator is reset. The Schmitt-trigger input allows a slowly rising input (such as a capacitor charging) to reset the chip reliably. When the RESET signal is deasserted, the initial chip operating mode is latched from the MODA, MODB, MODC, and MODD inputs. The RESET signal must be asserted during power up. A stable EXTAL signal must be supplied while RESET is being asserted. <i>This input is 5 V tolerant.</i>   |

#### Table 2-8 Interrupt and Mode Control

# 2.7 Parallel Host Interface (HDI08)

The HDI08 provides a fast, 8-bit, parallel data port that may be connected directly to the host bus. The HDI08 supports a variety of standard buses and can be directly connected to a number of industry standard microcomputers, microprocessors, DSPs, and DMA hardware.

| Signal Name | Туре                              | State during<br>Reset | Signal Description  |
|-------------|-----------------------------------|-----------------------|---|
| H0–H7       | Input/<br>output                  | GPIO<br>disconnected  | <b>Host Data</b> —When HDI08 is programmed to interface a nonmultiplexed host bus and the HI function is selected, these signals are lines 0–7 of the bidirectional, tri-state data bus.  |
| HAD0-HAD7   | Input/<br>output                  | GPIO<br>disconnected  | Host Address/Data—When HDI08 is programmed to interface a multiplexed host bus and the HI function is selected, these signals are lines 0–7 of the address/data bidirectional, multiplexed, tri-state bus.  |
| PB0–PB7     | Input, output, or disconnected    | GPIO<br>disconnected  | <b>Port B 0–7</b> —When the HDI08 is configured as GPIO, these signals are individually programmable as input, output, or internally disconnected.  |
|             |                                   |                       | The default state after reset for these signals is GPIO disconnected.<br>These inputs are 5 V tolerant.   |
| HA0         | Input                             | GPIO<br>disconnected  | <b>Host Address Input 0</b> —When the HDI08 is programmed to interface a nonmultiplexed host bus and the HI function is selected, this signal is line 0 of the host address input bus.  |
| HAS/HAS     | Input                             | GPIO<br>disconnected  | <b>Host Address Strobe</b> —When HDI08 is programmed to interface a multiplexed host bus and the HI function is selected, this signal is the host address strobe (HAS) Schmitt-trigger input. The polarity of the address strobe is programmable, but is configured active-low (HAS) following reset. |
| PB8         | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 8</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected.<br>The default state after reset for this signal is GPIO disconnected.<br><i>This input is 5 V tolerant.</i>  |
| HA1         | Input                             | GPIO<br>disconnected  | Host Address Input 1—When the HDI08 is programmed to interface a nonmultiplexed host bus and the HI function is selected, this signal is line 1 of the host address (HA1) input bus.  |
| HA8         | Input                             | GPIO<br>disconnected  | <b>Host Address 8</b> —When HDI08 is programmed to interface a multiplexed host bus and the HI function is selected, this signal is line 8 of the host address (HA8) input bus.   |
| PB9         | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 9</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected.<br>The default state after reset for this signal is GPIO disconnected.<br>This input is 5 V tolerant.   |

#### Table 2-9 Host Interface

| Signal Name | Туре                              | State during<br>Reset | Signal Description  |
|-------------|-----------------------------------|-----------------------|---|
| HA2         | Input                             | GPIO<br>disconnected  | <b>Host Address Input 2</b> —When the HDI08 is programmed to interface a non-multiplexed host bus and the HI function is selected, this signal is line 2 of the host address (HA2) input bus.   |
| HA9         | Input                             | GPIO<br>disconnected  | <b>Host Address 9</b> —When HDI08 is programmed to interface a multiplexed host bus and the HI function is selected, this signal is line 9 of the host address (HA9) input bus.   |
| PB10        | Input, Output, or<br>Disconnected | GPIO<br>disconnected  | <b>Port B 10</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. <i>This input is 5 V tolerant.</i>   |
| HRW         | Input                             | GPIO<br>disconnected  | Host Read/Write—When HDI08 is programmed to interface a single-data-strobe host bus and the HI function is selected, this signal is the Host Read/Write (HRW) input.  |
| HRD/<br>HRD | Input                             | GPIO<br>disconnected  | <b>Host Read Data</b> —When HDI08 is programmed to interface a double-data-strobe host bus and the HI function is selected, this signal is the host read data strobe (HRD) Schmitt-trigger input. The polarity of the data strobe is programmable, but is configured as active-low (HRD) after reset.       |
| PB11        | Input, Output, or<br>Disconnected | GPIO<br>disconnected  | <b>Port B 11</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. This input is 5 V tolerant.  |
| HDS/<br>HDS | Input                             | GPIO<br>disconnected  | <b>Host Data Strobe</b> —When HDI08 is programmed to interface a single-data-strobe host bus and the HI function is selected, this signal is the host data strobe (HDS) Schmitt-trigger input. The polarity of the data strobe is programmable, but is configured as active-low (HDS) following reset.      |
| HWR/<br>HWR | Input                             | GPIO<br>disconnected  | <b>Host Write Data</b> —When HDI08 is programmed to interface a double-data-strobe host bus and the HI function is selected, this signal is the host write data strobe (HWR) Schmitt-trigger input. The polarity of the data strobe is programmable, but is configured as active-low (HWR) following reset. |
| PB12        | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 12</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. This input is 5 V tolerant.  |
| HCS         | Input                             | GPIO<br>disconnected  | <b>Host Chip Select</b> —When HDI08 is programmed to interface a nonmultiplexed host bus and the HI function is selected, this signal is the host chip select (HCS) input. The polarity of the chip select is programmable, but is configured active-low (HCS) after reset.                                 |

#### Table 2-9 Host Interface (continued)

| Signal Name     | Туре                              | State during<br>Reset | Signal Description   |
|-----------------|-----------------------------------|-----------------------|--|
| HA10            | Input                             | GPIO<br>disconnected  | <b>Host Address 10</b> —When HDI08 is programmed to interface a multiplexed host bus and the HI function is selected, this signal is line 10 of the host address (HA10) input bus.   |
| PB13            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 13</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. This input is 5 V tolerant.   |
| HOREQ/<br>HOREQ | Output                            | GPIO<br>disconnected  | <b>Host Request</b> —When HDI08 is programmed to interface a single host request host bus and the HI function is selected, this signal is the host request (HOREQ) output. The polarity of the host request is programmable, but is configured as active-low (HOREQ) following reset. The host request may be programmed as a driven or open-drain output.                 |
| HTRQ/<br>HTRQ   |                                   |                       | <b>Transmit Host Request</b> —When HDI08 is programmed to interface a double host request host bus and the HI function is selected, this signal is the transmit host request (HTRQ) output. The polarity of the host request is programmable, but is configured as active-low (HTRQ) following reset. The host request may be programmed as a driven or open-drain output. |
| PB14            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 14</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. This input is 5 V tolerant.   |
| HACK/<br>HACK   | Input                             | GPIO<br>disconnected  | <b>Host Acknowledge</b> —When HDI08 is programmed to interface a single<br>host request host bus and the HI function is selected, this signal is the host<br>acknowledge (HACK) Schmitt-trigger input. The polarity of the host<br>acknowledge is programmable, but is configured as active-low (HACK) after<br>reset.   |
| HRRQ/<br>HRRQ   | Output                            | GPIO<br>disconnected  | <b>Receive Host Request</b> —When HDI08 is programmed to interface a double host request host bus and the HI function is selected, this signal is the receive host request (HRRQ) output. The polarity of the host request is programmable, but is configured as active-low (HRRQ) after reset. The host request may be programmed as a driven or open-drain output.       |
| PB15            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port B 15</b> —When the HDI08 is configured as GPIO, this signal is individually programmed as input, output, or internally disconnected. The default state after reset for this signal is GPIO disconnected. <i>This input is 5 V tolerant.</i>  |

#### Table 2-9 Host Interface (continued)

## 2.8 Serial Host Interface

The SHI has five I/O signals that can be configured to allow the SHI to operate in either SPI or I<sup>2</sup>C mode.

| Signal<br>Name | Signal Type                      | State during<br>Reset | Signal Description  |
|----------------|----------------------------------|-----------------------|---|
| SCK            | Input or<br>output               | Tri-stated            | <b>SPI Serial Clock</b> —The SCK signal is an output when the SPI is configured as a master and a Schmitt-trigger input when the SPI is configured as a slave. When the SPI is configured as a master, the SCK signal is derived from the internal SHI clock generator. When the SPI is configured as a slave, the SCK signal is an input, and the clock signal from the external master synchronizes the data transfer. The SCK signal is ignored by the SPI if it is defined as a slave and the slave select (SS) signal is not asserted. In both the master and slave SPI devices, data is shifted on one edge of the SCK signal and is sampled on the opposite edge where data is stable. Edge polarity is determined by the SPI transfer protocol.   |
| SCL            | Input or<br>output               | Tri-stated            | <b>I<sup>2</sup>C Serial Clock</b> —SCL carries the clock for I <sup>2</sup> C bus transactions in the I <sup>2</sup> C mode.<br>SCL is a Schmitt-trigger input when configured as a slave and an open-drain output when configured as a master. SCL should be connected to $V_{CC}$ through a pull-up resistor.<br>This signal is tri-stated during hardware, software, and individual reset. Thus, there is no need for an external pull-up in this state.<br>This input is 5 V tolerant.   |
| MISO           | Input or<br>output               | Tri-stated            | <b>SPI Master-In-Slave-Out</b> —When the SPI is configured as a master, MISO is the master data input line. The MISO signal is used in conjunction with the MOSI signal for transmitting and receiving serial data. This signal is a Schmitt-trigger input when configured for the SPI Master mode, an output when configured for the SPI Slave mode, and tri-stated if configured for the SPI Slave mode when $\overline{SS}$ is deasserted. An external pull-up resistor is not required for SPI operation.   |
| SDA            | Input or<br>open-drain<br>output | Tri-stated            | $I^2$ C Data and Acknowledge—In $I^2$ C mode, SDA is a Schmitt-trigger input when receiving and an open-drain output when transmitting. SDA should be connected to $V_{CC}$ through a pull-up resistor. SDA carries the data for $I^2$ C transactions. The data in SDA must be stable during the high period of SCL. The data in SDA is only allowed to change when SCL is low. When the bus is free, SDA is high. The SDA line is only allowed to change during the time SCL is high in the case of start and stop events. A high-to-low transition of the SDA line while SCL is high is a unique situation, and is defined as the start event. A low-to-high transition of SDA while SCL is high is a unique situation defined as the stop event. Thus, there is no need for an external pull-up in this state. This input is 5 V tolerant. |
| MOSI           | Input or<br>output               | Tri-stated            | <b>SPI Master-Out-Slave-In</b> —When the SPI is configured as a master, MOSI is the master data output line. The MOSI signal is used in conjunction with the MISO signal for transmitting and receiving serial data. MOSI is the slave data input line when the SPI is configured as a slave. This signal is a Schmitt-trigger input when configured for the SPI Slave mode.  |

#### Table 2-10 Serial Host Interface Signals

| Signal<br>Name | Signal Type        | State during<br>Reset | Signal Description  |
|----------------|--------------------|-----------------------|---|
| HA0            | Input              |                       | $I^2$ C Slave Address 0—This signal uses a Schmitt-trigger input when configured for the $I^2$ C mode. When configured for $I^2$ C slave mode, the HA0 signal is used to form the slave device address. HA0 is ignored when configured for the $I^2$ C master mode.   |
|                |                    |                       | This signal is tri-stated during hardware, software, and individual reset. Thus, there is no need for an external pull-up in this state.  |
|                |                    |                       | This input is 5 V tolerant.   |
| SS             | Input              | Tri-stated            | <b>SPI Slave Select</b> —This signal is an active low Schmitt-trigger input when configured for the SPI mode. When configured for the SPI Slave mode, this signal is used to enable the SPI slave for transfer. When configured for the SPI master mode, this signal should be kept deasserted (pulled high). If it is asserted while configured as SPI master, a bus error condition is flagged. If SS is deasserted, the SHI ignores SCK clocks and keeps the MISO output signal in the high-impedance state.   |
| HA2            | Input              |                       | $I^2$ C Slave Address 2—This signal uses a Schmitt-trigger input when configured for the $I^2$ C mode. When configured for the $I^2$ C Slave mode, the HA2 signal is used to form the slave device address. HA2 is ignored in the $I^2$ C master mode.  |
|                |                    |                       | This signal is tri-stated during hardware, software, and individual reset. Thus, there is no need for an external pull-up in this state.  |
|                |                    |                       | This input is 5 V tolerant.   |
| HREQ           | Input or<br>Output | Tri-stated            | <b>Host Request</b> —This signal is an active low Schmitt-trigger input when configured for the master mode but an active low output when configured for the slave mode.  |
|                |                    |                       | When configured for the slave mode, $\overline{\text{HREQ}}$ is asserted to indicate that the SHI is ready for the next data word transfer and deasserted at the first clock pulse of the new data word transfer. When configured for the master mode, $\overline{\text{HREQ}}$ is an input. When asserted by the external slave device, it will trigger the start of the data word transfer by the master. After finishing the data word transfer, the master will await the next assertion of $\overline{\text{HREQ}}$ to proceed to the next transfer. |
|                |                    |                       | This signal is tri-stated during hardware, software, personal reset, or when the HREQ1–HREQ0 bits in the HCSR are cleared. There is no need for external pull-up in this state.   |
|                |                    |                       | <i>This input is 5 V tole</i> rant.   |

| Table 2-10 | Serial Host Interface Signals | (continued) |
|------------|-------------------------------|-------------|
|------------|-------------------------------|-------------|

# 2.9 Enhanced Serial Audio Interface

| Signal<br>Name | Signal Type                       | State during<br>Reset | Signal Description   |
|----------------|-----------------------------------|-----------------------|--|
| HCKR           | Input or output                   | GPIO<br>disconnected  | <b>High Frequency Clock for Receiver</b> —When programmed as an input, this signal provides a high frequency clock source for the ESAI receiver as an alternate to the DSP core clock. When programmed as an output, this signal can serve as a high-frequency sample clock (e.g., for external digital to analog converters [DACs]) or as an additional system clock.   |
| PC2            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 2</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br><i>This input is 5 V tolerant.</i>  |
| НСКТ           | Input or output                   | GPIO<br>disconnected  | <b>High Frequency Clock for Transmitter</b> —When programmed as an input, this signal provides a high frequency clock source for the ESAI transmitter as an alternate to the DSP core clock. When programmed as an output, this signal can serve as a high frequency sample clock (e.g., for external DACs) or as an additional system clock.  |
| PC5            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 5</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |
| FSR            | Input or output                   | GPIO<br>disconnected  | Frame Sync for Receiver—This is the receiver frame sync input/output signal. In the asynchronous mode (SYN=0), the FSR pin operates as the frame sync input or output used by all the enabled receivers. In the synchronous mode (SYN=1), it operates as either the serial flag 1 pin (TEBE=0), or as the transmitter external buffer enable control (TEBE=1, RFSD=1). When this pin is configured as serial flag pin, its direction is determined by the RFSD bit in the RCCR register. When configured as the output flag OF1, this pin will reflect the value of the OF1 bit in the SAICR register, and the data in the OF1 bit will show up at the pin synchronized to the frame sync in normal mode or the slot in network mode. When configured as the input flag IF1, the data value at the pin will be stored in the IF1 bit in the SAISR register, synchronized by the frame sync in normal mode or the slot in network mode. |
| PC1            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 1</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |

| Table 2-11 | Enhanced Serial Audio Interface Signals | (continued) |
|------------|---|-------------|
|------------|---|-------------|

| Signal<br>Name | Signal Type                       | State during<br>Reset | Signal Description  |
|----------------|-----------------------------------|-----------------------|---|
| FST            | Input or output                   | GPIO<br>disconnected  | <b>Frame Sync for Transmitter</b> —This is the transmitter frame sync input/output signal. For synchronous mode, this signal is the frame sync for both transmitters and receivers. For asynchronous mode, FST is the frame sync for the transmitters only. The direction is determined by the transmitter frame sync direction (TFSD) bit in the ESAI transmit clock control register (TCCR).  |
| PC4            | Input, output, or<br>disconnected |                       | <b>Port C 4</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected. The default state after reset is GPIO disconnected. This input is 5 V tolerant.  |
| SCKR           | Input or output                   | GPIO<br>disconnected  | <b>Receiver Serial Clock</b> —SCKR provides the receiver serial bit clock for the ESAI. The SCKR operates as a clock input or output used by all the enabled receivers in the asynchronous mode (SYN=0), or as serial flag 0 pin in the synchronous mode (SYN=1).   |
|                |                                   |                       | When this pin is configured as serial flag pin, its direction is determined by the RCKD bit in the RCCR register. When configured as the output flag OF0, this pin will reflect the value of the OF0 bit in the SAICR register, and the data in the OF0 bit will show up at the pin synchronized to the frame sync in normal mode or the slot in network mode. When configured as the input flag IF0, the data value at the pin will be stored in the IF0 bit in the SAISR register, synchronized by the frame sync in normal mode or the slot in network mode. |
| PC0            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 0</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.  |
| SCKT           | Input or output                   | GPIO<br>disconnected  | <b>Transmitter Serial Clock</b> —This signal provides the serial bit rate clock for the ESAI. SCKT is a clock input or output used by all enabled transmitters and receivers in synchronous mode, or by all enabled transmitters in asynchronous mode.  |
| PC3            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 3</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.  |
| SDO5           | Output                            | GPIO<br>disconnected  | <b>Serial Data Output 5</b> —When programmed as a transmitter, SDO5 is used to transmit data from the TX5 serial transmit shift register.   |
| SDI0           | Input                             | GPIO<br>disconnected  | Serial Data Input 0—When programmed as a receiver, SDI0 is used to receive serial data into the RX0 serial receive shift register.  |

| Table 2-11 E | nhanced Serial Audio In | nterface Signals | (continued) |
|--------------|-------------------------|------------------|-------------|
|--------------|-------------------------|------------------|-------------|

| Signal<br>Name  | Signal Type                       | State during<br>Reset | Signal Description   |
|-----------------|-----------------------------------|-----------------------|--|
| PC6             | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 6</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |
| SDO4            | Output                            | GPIO<br>disconnected  | <b>Serial Data Output 4</b> —When programmed as a transmitter, SDO4 is used to transmit data from the TX4 serial transmit shift register.  |
| SDI1            | Input                             | GPIO<br>disconnected  | Serial Data Input 1—When programmed as a receiver, SDI1 is used to receive serial data into the RX1 serial receive shift register.   |
| PC7             | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 7</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |
| SDO3/SD<br>O3_1 | Output                            | GPIO<br>disconnected  | Serial Data Output 3—When programmed as a transmitter, SDO3 is used to transmit data from the TX3 serial transmit shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Output 3.   |
| SDI2/<br>SDI2_1 | Input                             | GPIO<br>disconnected  | Serial Data Input 2—When programmed as a receiver, SDI2 is used to receive serial data into the RX2 serial receive shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Input 2.   |
| PC8/PE8         | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 8</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>When enabled for ESAI_1 GPIO, this is the Port E 8 signal.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant. |
| SDO2/<br>SDO2_1 | Output                            | GPIO<br>disconnected  | Serial Data Output 2—When programmed as a transmitter, SDO2 is used to transmit data from the TX2 serial transmit shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Output 2.   |
| SDI3/SDI3<br>_1 | Input                             | GPIO<br>disconnected  | Serial Data Input 3—When programmed as a receiver, SDI3 is used to receive serial data into the RX3 serial receive shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Input 3.   |
| PC9/PE9         | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 9</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>When enabled for ESAI_1 GPIO, this is the Port E 9 signal.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant. |

| Signal<br>Name  | Signal Type                       | State during<br>Reset | Signal Description   |
|-----------------|-----------------------------------|-----------------------|--|
| SDO1/<br>SDO1_1 | Output                            | GPIO<br>disconnected  | Serial Data Output 1—SDO1 is used to transmit data from the TX1 serial transmit shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Output 1.   |
| PC10/<br>PE10   | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 10</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>When enabled for ESAI_1 GPIO, this is the Port E 10 signal.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant. |
| SDO0/SD<br>O0_1 | Output                            | GPIO<br>disconnected  | Serial Data Output 0—SDO0 is used to transmit data from the TX0 serial transmit shift register.<br>When enabled for ESAI_1 operation, this is the ESAI_1 Serial Data Output 0.   |
| PC11/<br>PE11   | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port C 11</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>When enabled for ESAI_1 GPIO, this is the Port E 11 signal.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant. |

| Table 2-11 | Enhanced Serial Audio Interface Signals (continued) |
|------------|---|
|------------|---|

## 2.10 Enhanced Serial Audio Interface\_1

| Signal<br>Name | Signal Type                       | State during<br>Reset | Signal Description  |
|----------------|-----------------------------------|-----------------------|---|
| FSR_1          | Input or output                   | GPIO<br>disconnected  | <b>Frame Sync for Receiver_1</b> —This is the receiver frame sync input/output signal. In the asynchronous mode (SYN=0), the FSR pin operates as the frame sync input or output used by all the enabled receivers. In the synchronous mode (SYN=1), it operates as either the serial flag 1 pin (TEBE=0), or as the transmitter external buffer enable control (TEBE=1, RFSD=1).  |
|                |                                   |                       | When this pin is configured as serial flag pin, its direction is determined by the RFSD bit in the RCCR register. When configured as the output flag OF1, this pin will reflect the value of the OF1 bit in the SAICR register, and the data in the OF1 bit will show up at the pin synchronized to the frame sync in normal mode or the slot in network mode. When configured as the input flag IF1, the data value at the pin will be stored in the IF1 bit in the SAISR register, synchronized by the frame sync in normal mode or the slot in network mode. |
| PE1            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 1</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.  |
|                |                                   |                       | The default state after reset is GPIO disconnected.<br>This input cannot tolerate 5 V.  |
| FST_1          | Input or output                   | GPIO<br>disconnected  | <b>Frame Sync for Transmitter_1</b> —This is the transmitter frame sync input/output signal. For synchronous mode, this signal is the frame sync for both transmitters and receivers. For asynchronous mode, FST is the frame sync for the transmitters only. The direction is determined by the transmitter frame sync direction (TFSD) bit in the ESAI transmit clock control register (TCCR).  |
| PE4            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 4</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input cannot tolerate 5 V.  |
| SCKR_1         | Input or output                   | GPIO<br>disconnected  | <b>Receiver Serial Clock_1</b> —SCKR provides the receiver serial bit clock for the ESAI. The SCKR operates as a clock input or output used by all the enabled receivers in the asynchronous mode (SYN=0), or as serial flag 0 pin in the synchronous mode (SYN=1).   |
|                |                                   |                       | When this pin is configured as serial flag pin, its direction is determined by the RCKD bit in the RCCR register. When configured as the output flag OF0, this pin will reflect the value of the OF0 bit in the SAICR register, and the data in the OF0 bit will show up at the pin synchronized to the frame sync in normal mode or the slot in network mode. When configured as the input flag IF0, the data value at the pin will be stored in the IF0 bit in the SAISR register, synchronized by the frame sync in normal mode or the slot in network mode. |

#### Table 2-12 Enhanced Serial Audio Interface\_1 Signals

| Signal<br>Name | Signal Type                       | State during<br>Reset | Signal Description   |
|----------------|-----------------------------------|-----------------------|--|
| PE0            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 0</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input cannot tolerate 5 V.                   |
| SCKT_1         | Input or output                   | GPIO<br>disconnected  | <b>Transmitter Serial Clock_1</b> —This signal provides the serial bit rate clock for the ESAI. SCKT is a clock input or output used by all enabled transmitters and receivers in synchronous mode, or by all enabled transmitters in asynchronous mode. |
| PE3            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 3</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input cannot tolerate 5 V.                   |
| SDO5_1         | Output                            | GPIO<br>disconnected  | <b>Serial Data Output 5_1</b> —When programmed as a transmitter, SDO5 is used to transmit data from the TX5 serial transmit shift register.  |
| SDI0_1         | Input                             | GPIO<br>disconnected  | <b>Serial Data Input 0_1</b> —When programmed as a receiver, SDI0 is used to receive serial data into the RX0 serial receive shift register.   |
| PE6            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 6</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input cannot tolerate 5 V.                   |
| SDO4_1         | Output                            | GPIO<br>disconnected  | Serial Data Output 4_1—When programmed as a transmitter, SDO4 is used to transmit data from the TX4 serial transmit shift register.  |
| SDI1_1         | Input                             | GPIO<br>disconnected  | Serial Data Input 1_1—When programmed as a receiver, SDI1 is used to receive serial data into the RX1 serial receive shift register.   |
| PE7            | Input, output, or<br>disconnected | GPIO<br>disconnected  | <b>Port E 7</b> —When the ESAI is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected. The default state after reset is GPIO disconnected. This input is 5 V tolerant.                             |

 Table 2-12
 Enhanced Serial Audio Interface\_1 Signals

## 2.11 SPDIF Transmitter Digital Audio Interface

| Signal<br>Name | Туре                              | State During<br>Reset | Signal Description  |
|----------------|-----------------------------------|-----------------------|---|
| ACI            | Input                             | GPIO<br>Disconnected  | Audio Clock Input—This is the DAX clock input. When programmed to use<br>an external clock, this input supplies the DAX clock. The external clock<br>frequency must be 256, 384, or 512 times the audio sampling frequency<br>(256 × Fs, 384 × Fs or 512 × Fs, respectively). |
| PD0            | Input, output, or<br>disconnected | GPIO<br>Disconnected  | <b>Port D 0</b> —When the DAX is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |
| ADO            | Output                            | GPIO<br>Disconnected  | <b>Digital Audio Data Output</b> —This signal is an audio and non-audio output in the form of AES/EBU, CP340 and IEC958 data in a biphase mark format.  |
| PD1            | Input, output, or<br>disconnected | GPIO<br>Disconnected  | <b>Port D 1</b> —When the DAX is configured as GPIO, this signal is individually programmable as input, output, or internally disconnected.<br>The default state after reset is GPIO disconnected.<br>This input is 5 V tolerant.   |

#### Table 2-13 Digital Audio Interface (DAX) Signals

### 2.12 Timer

Table 2-14Timer Signal

| Signal<br>Name | Туре            | State during<br>Reset | Signal Description   |
|----------------|-----------------|-----------------------|--|
| ΤΙΟΟ           | Input or Output | Input                 | <b>Timer 0 Schmitt-Trigger Input/Output</b> —When timer 0 functions as an external event counter or in measurement mode, TIO0 is used as input. When timer 0 functions in watchdog, timer, or pulse modulation mode, TIO0 is used as output.   |
|                |                 |                       | The default mode after reset is GPIO input. This can be changed to output or configured as a timer input/output through the timer 0 control/status register (TCSR0). If TIO0 is not being used, it is recommended to either define it as GPIO output immediately at the beginning of operation or leave it defined as GPIO input but connected to Vcc through a pull-up resistor in order to ensure a stable logic level at this input. <i>This input is 5 V tolerant.</i> |

# 2.13 JTAG/OnCE Interface

| Signal<br>Name | Signal<br>Type | State during<br>Reset | Signal Description   |
|----------------|----------------|-----------------------|--|
| ТСК            | Input          | Input                 | <b>Test Clock</b> —TCK is a test clock input signal used to synchronize the JTAG test logic. It has an internal pull-up resistor. <i>This input is 5 V tolerant.</i>   |
| TDI            | Input          | Input                 | <b>Test Data Input</b> —TDI is a test data serial input signal used for test instructions and data. TDI is sampled on the rising edge of TCK and has an internal pull-up resistor. This input is 5 V tolerant.                           |
| TDO            | Output         | Tri-stated            | <b>Test Data Output</b> —TDO is a test data serial output signal used for test instructions and data. TDO is tri-statable and is actively driven in the shift-IR and shift-DR controller states. TDO changes on the falling edge of TCK. |
| TMS            | Input          | Input                 | <b>Test Mode Select</b> —TMS is an input signal used to sequence the test controller's state machine. TMS is sampled on the rising edge of TCK and has an internal pull-up resistor.<br>This input is 5 V tolerant.                      |

#### Table 2-15 JTAG/OnCE Interface

NOTES

# 3 Specifications

### 3.1 Introduction

The DSP56366 is a high density CMOS device with Transistor-Transistor Logic (TTL) compatible inputs and outputs. The DSP56366 specifications are preliminary and are from design simulations, and may not be fully tested or guaranteed. Finalized specifications will be published after full characterization and device qualifications are complete.

### 3.2 Maximum Ratings

### CAUTION

This device contains circuitry protecting against damage due to high static voltage or electrical fields. However, normal precautions should be taken to avoid exceeding maximum voltage ratings. Reliability of operation is enhanced if unused inputs are pulled to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). The suggested value for a pullup or pulldown resistor is 10 kΩ.

#### NOTE

In the calculation of timing requirements, adding a maximum value of one specification to a minimum value of another specification does not yield a reasonable sum. A maximum specification is calculated using a worst case variation of process parameter values in one direction. The minimum specification is calculated using the worst case for the same parameters in the opposite direction. Therefore, a "maximum" value for a specification will never occur in the same device that has a "minimum" value for another specification; adding a maximum to a minimum represents a condition that can never exist.

| Rating <sup>1</sup>   | Symbol           | Value <sup>1, 2</sup>               | Unit |
|---|------------------|-------------------------------------|------|
| Supply Voltage  | V <sub>CC</sub>  | -0.3 to +4.0                        | V    |
| All input voltages excluding "5 V tolerant" inputs <sup>3</sup> | V <sub>IN</sub>  | GND -0.3 to V <sub>CC</sub> + 0.3   | V    |
| All "5 V tolerant" input voltages <sup>3</sup>                  | V <sub>IN5</sub> | GND - 0.3 to V <sub>CC</sub> + 3.95 | V    |
| Current drain per pin excluding $V_{CC}$ and $GND$              | I                | 10                                  | mA   |

| Rating <sup>1</sup>         | Symbol           | Value <sup>1, 2</sup> | Unit |
|-----------------------------|------------------|-----------------------|------|
| Operating temperature range | TJ               | -40 to +110           | °C   |
| Storage temperature         | T <sub>STG</sub> | 55 to +125            | °C   |

 Table 3-1
 Maximum Ratings (continued)

<sup>1</sup> GND = 0 V,  $V_{CC}$  = 3.3 V ± 0.16 V,  $T_{J}$  = -40°C to +110°C,  $C_{L}$  = 50 pF

<sup>2</sup> Absolute maximum ratings are stress ratings only, and functional operation at the maximum is not guaranteed. Stress beyond the maximum rating may affect device reliability or cause permanent damage to the device.

<sup>3</sup> CAUTION: All "5 V Tolerant" input voltages must not be more than 3.95 V greater than the supply voltage; this restriction applies to "power on", as well as during normal operation. In any case, the input voltages cannot be more than 5.75 V. "5 V Tolerant" inputs are inputs that tolerate 5 V.

## 3.3 Thermal Characteristics

|  | Table 3-2 | Thermal | <b>Characteristics</b> |
|--|-----------|---------|------------------------|
|--|-----------|---------|------------------------|

| Characteristic  | Symbol                             | LQFP Value | Unit |
|---|------------------------------------|------------|------|
| Junction-to-ambient thermal resistance <sup>1, 2</sup> Natural Convection | $R_{\theta J A}$ or $\theta_{J A}$ | 37         | °C/W |
| Junction-to-case thermal resistance <sup>3</sup>                          | $R_{\theta JC}$ or $\theta_{JC}$   | 7          | °C/W |
| Thermal characterization parameter <sup>4</sup> Natural Convection        | $\Psi_{JT}$                        | 2.0        | °C/W |

<sup>1</sup> Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per SEMI G38-87 and JEDEC JESD51-2 with the single layer board horizontal.

<sup>3</sup> Thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC-883 Method 1012.1).

<sup>4</sup> Thermal characterization parameter indicating the temperature difference between package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

#### 3.4 **DC Electrical Characteristics**

| Characteristics   | Symbol           | Min                    | Тур | Мах                    | Unit |
|---|------------------|------------------------|-----|------------------------|------|
| Supply voltage  | V <sub>CC</sub>  | 3.14                   | 3.3 | 3.46                   | V    |
| Input high voltage  |                  |                        |     |                        | V    |
| • D(0:23), BG, BB, TA, ESAI_1 <sub>(except SDO4_1)</sub>  | V <sub>IH</sub>  | 2.0                    | —   |                        |      |
| <ul> <li>MOD<sup>2</sup>/IRQ<sup>2</sup>, RESET, PINIT/NMI and all<br/>JTAG/ESAI/Timer/HDI08/DAX/ESAI_1<sub>(only SDO4_1)</sub>/SHI<sub>(SPI mode)</sub></li> </ul> | V <sub>IHP</sub> | 2.0                    | —   | V <sub>CC</sub> + 3.95 |      |
| • SHI <sub>(I2C mode)</sub>   | V <sub>IHP</sub> | 1.5                    | _   | V <sub>CC</sub> + 3.95 |      |
| • EXTAL <sup>3</sup>  | V <sub>IHX</sub> | $0.8 	imes V_{CC}$     | —   | V <sub>CC</sub>        |      |
| Input low voltage   |                  |                        |     |                        | V    |
| <ul> <li>D(0:23), BG, BB, TA, ESAI_1<sub>(except SDO4_1)</sub></li> </ul>   | V <sub>IL</sub>  | -0.3                   | —   | 0.8                    |      |
| <ul> <li>MOD<sup>2</sup>/IRQ<sup>2</sup>, RESET, PINIT/NMI and all<br/>JTAG/ESAI/Timer/HDI08/DAX/ESAI_1<sub>(only SDO4_1)</sub>/SHI<sub>(SPI mode)</sub></li> </ul> | V <sub>ILP</sub> | -0.3                   | —   | 0.8                    |      |
| • SHI <sub>(I2C mode)</sub>   | V <sub>ILP</sub> | -0.3                   | _   | 0.3 x V <sub>CC</sub>  |      |
| • EXTAL <sup>3</sup>  | V <sub>ILX</sub> | -0.3                   | —   | 0.2 x V <sub>CC</sub>  |      |
| Input leakage current   | I <sub>IN</sub>  | -10                    | —   | 10                     | μA   |
| High impedance (off-state) input current (@ 2.4 V / 0.4 V)  | I <sub>TSI</sub> | -10                    | _   | 10                     | μA   |
| Output high voltage   |                  |                        |     |                        | V    |
| • TTL (I <sub>OH</sub> = -0.4 mA) <sup>4,5</sup>  | V <sub>OH</sub>  | 2.4                    | —   | —                      |      |
| <ul> <li>CMOS (I<sub>OH</sub> = -10 μA)<sup>4</sup></li> </ul>  | V <sub>OH</sub>  | V <sub>CC</sub> – 0.01 | —   | —                      |      |
| Output low voltage  |                  |                        |     |                        | V    |
| • TTL ( $I_{OL}$ = 3.0 mA, open-drain pins $I_{OL}$ = 6.7 mA) <sup>4,5</sup>  | V <sub>OL</sub>  | —                      | —   | 0.4                    |      |
| <ul> <li>CMOS (I<sub>OL</sub> = 10 μA)<sup>4</sup></li> </ul>   | V <sub>OL</sub>  | —                      | —   | 0.01                   |      |
| Internal supply current <sup>6</sup> at internal clock of 120MHz  |                  |                        |     |                        | mA   |
| In Normal mode  | I <sub>CCI</sub> | —                      | 116 | 200                    |      |
| In Wait mode  | Iccw             | —                      | 7.3 | 25                     |      |
| <ul> <li>In Stop mode<sup>7</sup></li> </ul>  | I <sub>CCS</sub> | —                      | 1   | 10                     |      |
| PLL supply current  |                  | _                      | 1   | 2.5                    | mA   |
| Input capacitance <sup>4</sup>  | C <sub>IN</sub>  | —                      | —   | 10                     | pF   |

Table 3-3 DC Electrical Characteristics<sup>1</sup>

<sup>3</sup> Driving EXTAL to the low V<sub>IHX</sub> or the high V<sub>ILX</sub> value may cause additional power consumption (DC current). To minimize power consumption, the minimum V<sub>IHX</sub> should be no lower than  $0.9 \times V_{CC}$  and the maximum V<sub>ILX</sub> should be no higher than  $0.1\times V_{CC}.$ 

<sup>4</sup> Periodically sampled and not 100% tested.

<sup>5</sup> This characteristic does not apply to PCAP.

- <sup>6</sup> Appendix A, "Power Consumption Benchmark" provides a formula to compute the estimated current requirements in Normal mode. In order to obtain these results, all inputs must be terminated (i.e., not allowed to float). Measurements are based on synthetic intensive DSP benchmarks. The power consumption numbers in this specification are 90% of the measured results of this benchmark. This reflects typical DSP applications. Typical internal supply current is measured with  $V_{CC} = 3.3 V$  at
- $T_J = 110^{\circ}$ C. Maximum internal supply current is measured with  $V_{CC} = 3.46$  V at  $T_J = 110^{\circ}$ C.
- <sup>7</sup> In order to obtain these results, all inputs, which are not disconnected at Stop mode, must be terminated (i.e., not allowed to float).

### 3.5 AC Electrical Characteristics

The timing waveforms shown in the AC electrical characteristics section are tested with a  $V_{IL}$  maximum of 0.3 V and a  $V_{IH}$  minimum of 2.4 V for all pins except EXTAL, which is tested using the input levels shown in Note 3 of the previous table. AC timing specifications, which are referenced to a device input signal, are measured in production with respect to the 50% point of the respective input signal's transition. DSP56366 output levels are measured with the production test machine  $V_{OL}$  and  $V_{OH}$  reference levels set at 0.4 V and 2.4 V, respectively.

#### NOTE

Although the minimum value for the frequency of EXTAL is 0 MHz, the device AC test conditions are 15 MHz and rated speed.

### 3.6 Internal Clocks

| Characteristics                                    | Symbol         | Expression <sup>1, 2</sup>                 |                                  |  |  |
|--|----------------|--|----------------------------------|--|--|
| Characteristics                                    | Symbol         | Min  | Тур                              | Мах  |  |
| Internal operation frequency with PLL enabled      | f              | _  | $(Ef \times MF)/(PDF \times DF)$ | _  |  |
| Internal operation frequency with PLL disabled     | f              | _  | Ef/2                             | _  |  |
| Internal clock high period                         | Т <sub>Н</sub> |  |                                  |  |  |
| With PLL disabled                                  |                | _  | ET <sub>C</sub>                  | _  |  |
| • With PLL enabled and MF $\leq$ 4                 |                | $0.49 \times ET_C \times PDF \times DF/MF$ | _                                | $0.51 \times ET_{C} \times PDF \times DF/MF$                             |  |
| <ul> <li>With PLL enabled and MF &gt; 4</li> </ul> |                | $0.47 \times ET_C \times PDF \times DF/MF$ | _                                | $0.53 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ |  |
| Internal clock low period                          | Т              |  |                                  |  |  |
| With PLL disabled                                  |                | _  | ET <sub>C</sub>                  | _  |  |
| • With PLL enabled and MF $\leq 4$                 |                | $0.49 \times ET_C \times PDF \times DF/MF$ | _                                | $0.51 \times ET_{C} \times PDF \times DF/MF$                             |  |
| <ul> <li>With PLL enabled and MF &gt; 4</li> </ul> |                | $0.47 \times ET_C \times PDF \times DF/MF$ | _                                | $0.53 \times \text{ET}_{\text{C}} \times \text{PDF} \times \text{DF/MF}$ |  |
| Internal clock cycle time with PLL enabled         | T <sub>C</sub> | _  | $ET_{C} \times PDF \times DF/MF$ | _  |  |

#### Table 3-4 Internal Clocks

Table 3-4 Internal Clocks

| Characteristics                             | Symbol           | Expression <sup>1, 2</sup> |                     |     |
|---|------------------|----------------------------|---------------------|-----|
| Characteristics                             | Symbol           | Min                        | Тур                 | Max |
| Internal clock cycle time with PLL disabled | T <sub>C</sub>   | _                          | 2 × ET <sub>C</sub> | _   |
| Instruction cycle time                      | I <sub>CYC</sub> | —                          | T <sub>C</sub>      | —   |

<sup>1</sup> DF = Division Factor

Ef = External frequency

 $ET_C = External clock cycle$ 

MF = Multiplication Factor

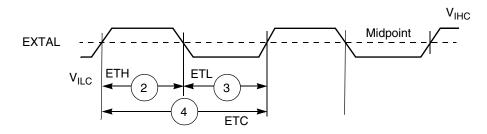
PDF = Predivision Factor

T<sub>C</sub> = internal clock cycle

<sup>2</sup> See the PLL and Clock Generation section in the *DSP56300 Family Manual* for a detailed discussion of the PLL.

## 3.7 EXTERNAL CLOCK OPERATION

The DSP56366 system clock is an externally supplied square wave voltage source connected to EXTAL (See Figure 3-1).



Notes The midpoint is 0.5 (V<sub>IHC</sub> + V<sub>ILC</sub>).

#### Figure 3-1 External Clock Timing

#### Table 3-5 Clock Operation

| No. | Characteristics  | Symbol          | Min                | Max           |
|-----|--|-----------------|--------------------|---------------|
| 1   | Frequency of EXTAL (EXTAL Pin Frequency)<br>The rise and fall time of this external clock should be 3 ns maximum.  | Ef              | 0                  | 120.0         |
| 2   | EXTAL input high <sup>1, 2</sup> <ul> <li>With PLL disabled (46.7%–53.3% duty cycle<sup>3</sup>)</li> <li>With PLL enabled (42.5%–57.5% duty cycle<sup>3</sup>)</li> </ul> | ET <sub>H</sub> | 3.89 ns<br>3.54 ns | ∞<br>157.0 μs |
| 3   | EXTAL input low <sup>1, 2</sup> <ul> <li>With PLL disabled (46.7%–53.3% duty cycle<sup>3</sup>)</li> <li>With PLL enabled (42.5%–57.5% duty cycle<sup>3</sup>)</li> </ul>  | ETL             | 3.89 ns<br>3.54 ns | ∞<br>157.0 μs |

| No. | Characteristics                                 | Symbol           | Min      | Max      |
|-----|---|------------------|----------|----------|
| 4   | EXTAL cycle time <sup>2</sup>                   | ET <sub>C</sub>  |          |          |
|     | With PLL disabled                               |                  | 8.33 ns  | $\infty$ |
|     | With PLL enabled                                |                  | 8.33 ns  | 273.1 μs |
| 7   | Instruction cycle time = $I_{CYC} = T_C^{4, 2}$ | I <sub>CYC</sub> |          |          |
|     | With PLL disabled                               |                  | 16.66 ns | $\infty$ |
|     | With PLL enabled                                |                  | 8.33 ns  | 8.53 μs  |

Table 3-5 Clock Operation (continued)

<sup>1</sup> Measured at 50% of the input transition.

2 The maximum value for PLL enabled is given for minimum V<sub>CO</sub> and maximum MF.

The indicated duty cycle is for the specified maximum frequency for which a part is rated. The minimum clock high or low time 3 required for correct operation, however, remains the same at lower operating frequencies; therefore, when a lower clock frequency is used, the signal symmetry may vary from the specified duty cycle as long as the minimum high time and low time requirements are met.

<sup>4</sup> The maximum value for PLL enabled is given for minimum VCO and maximum DF.

#### Phase Lock Loop (PLL) Characteristics 3.8

#### Table 3-6 PLL Characteristics

| Characteristics   | Min              | Мах              | Unit |
|---|------------------|------------------|------|
| $V_{CO}$ frequency when PLL enabled (MF $\times$ E_f $\times$ 2/PDF)        | 30               | 240              | MHz  |
| PLL external capacitor (PCAP pin to $V_{CCP}$ ) ( $C_{PCAP}$ ) <sup>1</sup> |                  |                  | pF   |
| • @ MF ≤ 4  | (MF × 580) – 100 | (MF × 780) – 140 |      |
| • @ MF > 4  | MF 	imes 830     | MF × 1470        |      |

C<sub>PCAP</sub> is the value of the PLL capacitor (connected between the PCAP pin and V<sub>CCP</sub>). The recommended value in pF 1 for  $C_{PCAP}$  can be computed from one of the following equations:

 $(MF \times 680)$ -120, for  $MF \le 4$  or  $MF \times 1100$ , for MF > 4.

#### 3.9 Reset, Stop, Mode Select, and Interrupt Timing

#### Table 3-7 Reset, Stop, Mode Select, and Interrupt Timing<sup>1</sup>

| No. | Characteristics  | Expression                       | Min   | Max   | Unit |
|-----|--|----------------------------------|-------|-------|------|
| 8   | Delay from RESET assertion to all pins at reset value <sup>2</sup>   | —                                | —     | 26.0  | ns   |
| 9   | Required RESET duration <sup>3</sup>   |                                  |       |       |      |
|     | <ul> <li>Power on, external clock generator, PLL disabled</li> </ul>   | $50 \times \text{ET}_{\text{C}}$ | 416.7 | —     | ns   |
|     | <ul> <li>Power on, external clock generator, PLL enabled</li> </ul>  | $1000 \times ET_C$               | 8.3   | —     | μs   |
|     | During normal operation  | $2.5 	imes T_C$                  | 20.8  | —     | ns   |
| 10  | Delay from asynchronous $\overline{\text{RESET}}$ deassertion to first external address output (internal reset deassertion) <sup>4</sup> |                                  |       |       |      |
|     | • Minimum  | $3.25 \times T_{C} + 2.0$        | 29.1  | —     | ns   |
|     | • Maximum  | 20.25 T <sub>C</sub> + 7.50      | —     | 176.2 | ns   |
| 13  | Mode select setup time   |                                  | 30.0  | _     | ns   |

| No. | Characteristics   | Expression   | Min  | Max               | Unit |
|-----|---|--|------|-------------------|------|
| 14  | Mode select hold time   |  | 0.0  | —                 | ns   |
| 15  | Minimum edge-triggered interrupt request assertion width  |  | 5.5  | —                 | ns   |
| 16  | Minimum edge-triggered interrupt request deassertion width  |  | 5.5  | —                 | ns   |
| 17  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to<br>external memory access address out valid   |  |      |                   |      |
|     | Caused by first interrupt instruction fetch   | $4.25 \times T_{C} + 2.0$  | 37.4 |                   | ns   |
|     | Caused by first interrupt instruction execution   | 7.25 × T <sub>C</sub> + 2.0  | 62.4 |                   | ns   |
| 18  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to general-purpose transfer output valid caused by first interrupt instruction execution                       | 10 × T <sub>C</sub> + 5.0  | 88.3 | _                 | ns   |
| 19  | Delay from address output valid caused by first interrupt instruction execute to interrupt request deassertion for level sensitive fast interrupts <sup>5</sup> | $3.75 \times T_{C} + WS \times T_{C} - 10.94$  | —    | Note <sup>6</sup> | ns   |
| 20  | Delay from $\overline{\text{RD}}$ assertion to interrupt request deassertion for level sensitive fast interrupts $^5$   | $3.25 \times T_{C} + WS \times T_{C} - 10.94$  | —    | Note 6            | ns   |
| 21  | Delay from $\overline{\text{WR}}$ assertion to interrupt request deassertion for level sensitive fast interrupts $^5$   |  |      |                   | ns   |
|     | DRAM for all WS   | $(WS + 3.5) \times T_C - 10.94$  | —    | Note 6            |      |
|     | • SRAM WS = 1   | $(WS + 3.5) \times T_C - 10.94$  | —    | Note 6            |      |
|     | • SRAM WS = 2, 3  | $(WS + 3) \times T_C - 10.94$  | —    | Note 6            |      |
|     | • SRAM WS ≥ 4   | (WS + 2.5) × T <sub>C</sub> – 10.94  | —    | Note 6            |      |
| 24  | Duration for IRQA assertion to recover from Stop state  |  | 4.9  | —                 |      |
| 25  | Delay from $\overline{\text{IRQA}}$ assertion to fetch of first instruction (when exiting Stop)^{2, 7}  |  |      |                   |      |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and Stop<br/>delay is enabled (OMR Bit 6 = 0)</li> </ul>   | $\begin{array}{c} PLC\timesET_C\timesPDF+(128\;K-\\ PLC/2)\timesT_C \end{array}$   | _    | _                 | ms   |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and Stop<br/>delay is not enabled (OMR Bit 6 = 1)</li> </ul>   | $\begin{array}{c} PLC\timesET_C\timesPDF\ \texttt{+}\ \texttt{(23.75}\ \pm\\ \texttt{0.5)}\timesT_C \end{array}$                       | _    | _                 | ms   |
|     | <ul> <li>PLL is active during Stop (PCTL Bit 17 = 1) (Implies No<br/>Stop Delay)</li> </ul>   | $(8.25\pm0.5)\times T_{C}$   | 64.6 | 72.9              | ms   |
| 26  | Duration of level sensitive $\overline{IRQA}$ assertion to ensure interrupt service (when exiting Stop) <sup>2, 7</sup>   |  |      |                   |      |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and Stop<br/>delay is enabled (OMR Bit 6 = 0)</li> </ul>   | $\begin{array}{c} PLC \times ET_{C} \times PDF + (128K - \\ PLC/2) \ \times T_{C} \end{array}$   | _    | _                 | ms   |
|     | <ul> <li>PLL is not active during Stop (PCTL Bit 17 = 0) and Stop<br/>delay is not enabled (OMR Bit 6 = 1)</li> </ul>   | $\begin{array}{c} \text{PLC} \times \text{ET}_{\text{C}} \times \text{PDF} + (20.5 \pm 0.5) \\ \times \text{T}_{\text{C}} \end{array}$ | _    | _                 | ms   |
|     | <ul> <li>PLL is active during Stop (PCTL Bit 17 = 1) (implies no<br/>Stop delay)</li> </ul>   | $5.5 	imes T_C$  | 45.8 | _                 | ns   |

 Table 3-7 Reset, Stop, Mode Select, and Interrupt Timing<sup>1</sup> (continued)

| No. | Characteristics   | Expression                | Min  | Max   | Unit |
|-----|---|---------------------------|------|-------|------|
| 27  | Interrupt Requests Rate   |                           |      |       |      |
|     | <ul> <li>HDI08, ESAI, ESAI_1, SHI, DAX, Timer</li> </ul>  | 12T <sub>C</sub>          | —    | 100.0 | ns   |
|     | • DMA   | 8T <sub>C</sub>           | —    | 66.7  | ns   |
|     | IRQ, NMI (edge trigger)   | 8T <sub>C</sub>           | —    | 66.7  | ns   |
|     | IRQ (level trigger)   | 12T <sub>C</sub>          | —    | 100.0 | ns   |
| 28  | DMA Requests Rate   |                           |      |       |      |
|     | <ul> <li>Data read from HDI08, ESAI, ESAI_1, SHI, DAX</li> </ul>  | 6Т <sub>С</sub>           | —    | 50.0  | ns   |
|     | <ul> <li>Data write to HDI08, ESAI, ESAI_1, SHI, DAX</li> </ul>   | 7T <sub>C</sub>           | —    | 58.0  | ns   |
|     | • Timer   | 2T <sub>C</sub>           |      | 16.7  |      |
|     | IRQ, NMI (edge trigger)   | ЗТ <sub>С</sub>           | —    | 25.0  | ns   |
| 29  | Delay from IRQA, IRQB, IRQC, IRQD, NMI assertion to external memory (DMA source) access address out valid | $4.25 \times T_{C} + 2.0$ | 37.4 | _     | ns   |

Table 3-7 Reset, Stop, Mode Select, and Interrupt Timing<sup>1</sup> (continued)

<sup>1</sup>  $V_{CC} = 3.3 \text{ V} \pm 0.16 \text{ V}; T_{J} = -40^{\circ}\text{C} \text{ to} + 110^{\circ}\text{C}, C_{L} = 50 \text{ pF}$ 

<sup>2</sup> Periodically sampled and not 100% tested.

<sup>3</sup> RESET duration is measured during the time in which RESET is asserted,  $V_{CC}$  is valid, and the EXTAL input is active and valid. When the  $V_{CC}$  is valid, but the other "required RESET duration" conditions (as specified above) have not been yet met, the device circuitry will be in an uninitialized state that can result in significant power consumption and heat-up. Designs should minimize this state to the shortest possible duration.

<sup>4</sup> If PLL does not lose lock.

<sup>5</sup> When using fast interrupts and IRQA, IRQB, IRQC, and IRQD are defined as level-sensitive, timings 19 through 21 apply to prevent multiple interrupt service. To avoid these timing restrictions, the deasserted Edge-triggered mode is recommended when using fast interrupts. Long interrupts are recommended when using Level-sensitive mode.

<sup>6</sup> WS = number of wait states (measured in clock cycles, number of  $T_C$ ). Use expression to compute maximum value.

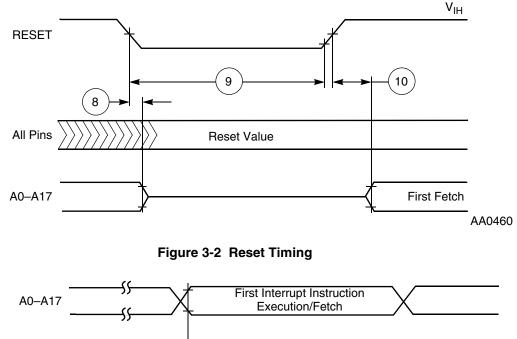
<sup>7</sup> This timing depends on several settings: For PLL disable, using external clock (PCTL Bit 16 = 1), no stabilization delay is required and recovery time will be defined

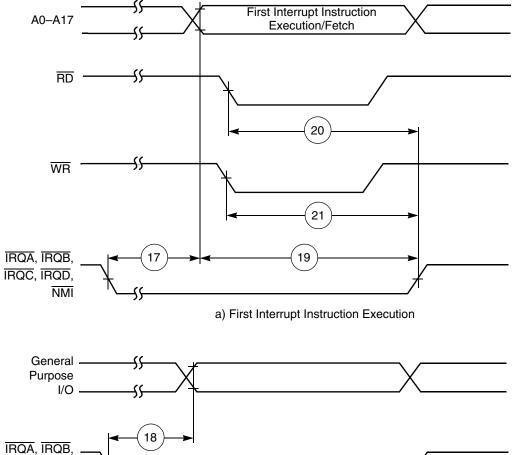
by the PCTL Bit 17 and OMR Bit 6 settings. For PLL enable, if PCTL Bit 17 is 0, the PLL is shutdown during Stop. Recovering from Stop requires the PLL to get locked. The PLL lock procedure duration, PLL Lock Cycles (PLC), may be in the range of 0 to 1000 cycles. This procedure occurs in

parallel with the stop delay counter, and stop recovery will end when the last of these two events occurs: the stop delay counter completes count or PLL lock procedure completion.

PLC value for PLL disable is 0.

The maximum value for  $ET_C$  is 4096 (maximum MF) divided by the desired internal frequency (i.e., for 120 MHz it is 4096/120 MHz = 34.1  $\mu$ s). During the stabilization period,  $T_C$ ,  $T_H$ , and  $T_L$  will not be constant, and their width may vary, so timing may vary as well.





b) General Purpose I/O

Figure 3-3 External Fast Interrupt Timing

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IRQC, IRQD,

NMI

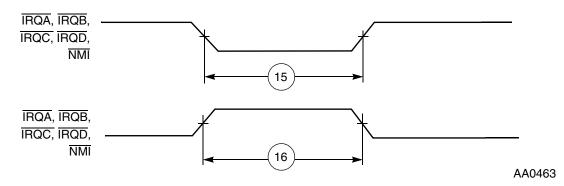


Figure 3-4 External Interrupt Timing (Negative Edge-Triggered)

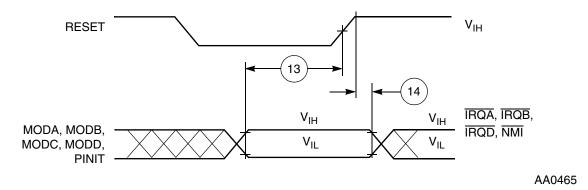


Figure 3-5 Operating Mode Select Timing

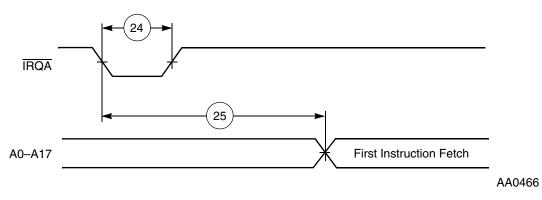
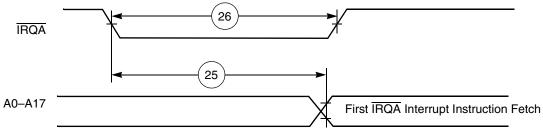


Figure 3-6 Recovery from Stop State Using IRQA



AA0467



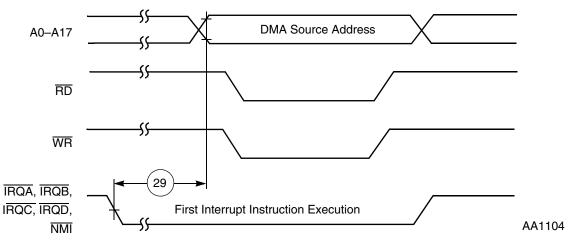
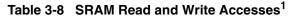


Figure 3-8 External Memory Access (DMA Source) Timing

# 3.10 External Memory Expansion Port (Port A)

## 3.10.1 SRAM Timing



| No. | Characteristics                            | Symbol                            | Expression <sup>2</sup>  | Min  | Max | Unit |
|-----|--|-----------------------------------|--|------|-----|------|
| 100 | Address valid and AA assertion pulse width | t <sub>RC</sub> , t <sub>WC</sub> | $\begin{array}{l} (WS+1)\times T_C-4.0\\ [1\leq WS\leq 3] \end{array}$ | 12.0 |     | ns   |
|     |  |                                   | $\begin{array}{l} (WS+2)\times T_C-4.0\\ [4\leq WS\leq 7] \end{array}$ | 46.0 | _   | ns   |
|     |  |                                   | $\begin{array}{c} (WS+3)\times T_C-4.0\\ [WS\geq 8] \end{array}$       | 87.0 | _   | ns   |

| No. | Characteristics   | Symbol   | Expression <sup>2</sup>  | Min  | Max | Unit |
|-----|---|--|--|------|-----|------|
| 101 | Address and AA valid to $\overline{WR}$ assertion           | t <sub>AS</sub>  | $0.25 \times T_{C} - 2.0$<br>[WS = 1]                                      | 0.1  | —   | ns   |
|     |   |  | $\begin{array}{c} 1.25 \times T_C - 2.0 \\ [WS \geq 4] \end{array}$        | 8.4  | _   | ns   |
| 102 | WR assertion pulse width                                    | n pulse width $t_{WP}$ $1.5 \times T_C - 4.0 [WS = 1]$   |  | 8.5  | —   | ns   |
|     |   |  | All frequencies: $WS \times T_C - 4.0$ $[2 \le WS \le 3]$                  | 12.7 | _   | ns   |
|     |   |  | $\begin{array}{l} (WS-0.5)\times T_C-4.0\\ [WS\geq 4] \end{array}$         | 25.2 | _   | ns   |
| 103 | WR deassertion to address not valid                         | $\overline{t}$ deassertion to address not valid $t_{WR} \qquad \begin{array}{c} 0.25 \times T_C - 2.0 \\ [1 \leq WS \leq 3] \end{array}$ |  | 0.1  | —   | ns   |
|     |   |  | $1.25 \times T_C - 2.0$ $[4 \le WS \le 7]$                                 | 8.4  | —   | ns   |
|     |   |  | $\begin{array}{c} 2.25 \times T_C - 2.0 \\ [WS \geq 8] \end{array}$        | 16.7 | _   | ns   |
|     |   |  | All frequencies: $1.25 \times T_C - 4.0$ [4 $\leq$ WS $\leq$ 7]            | 6.4  | _   | ns   |
|     |   |  | $\begin{array}{c} 2.25 \times T_C - 4.0 \\ [WS \geq 8] \end{array}$        | 14.7 | —   | ns   |
| 104 | Address and AA valid to input data valid                    | t <sub>AA</sub> , t <sub>AC</sub>  | $\begin{array}{l} (WS + 0.75) \times T_C - 7.0 \\ [WS \geq 1] \end{array}$ | _    | 7.6 | ns   |
| 105 | RD assertion to input data valid                            | t <sub>OE</sub>  | $\begin{array}{l} (WS + 0.25) \times T_C - 7.0 \\ [WS \geq 1] \end{array}$ | _    | 3.4 | ns   |
| 106 | RD deassertion to data not valid (data hold time)           | t <sub>OHZ</sub>   |  | 0.0  | _   | ns   |
| 107 | Address valid to $\overline{WR}$ deassertion <sup>3</sup>   | t <sub>AW</sub>  | $\begin{array}{l} (WS + 0.75) \times T_C - 4.0 \\ [WS \geq 1] \end{array}$ | 10.6 | —   | ns   |
| 108 | Data valid to $\overline{WR}$ deassertion (data setup time) | t <sub>DS</sub> (t <sub>DW</sub> )   | $\begin{array}{l} (WS-0.25)\times T_C-3.0\\ [WS\geq 1] \end{array}$        | 3.2  | —   | ns   |

| Table 3-8 | SRAM Read and Write Accesses <sup>1</sup> | (continued) | ) |
|-----------|---|-------------|---|
|           |   |             | , |

| No. | Characteristics  | Symbol          | Expression <sup>2</sup>  | Min  | Мах  | Unit |
|-----|--|-----------------|--|------|------|------|
| 109 | Data hold time from WR deassertion                                 | t <sub>DH</sub> | $\begin{array}{l} 0.25\times T_C-2.0\\ [1\leq WS\leq 3] \end{array}$       | 0.1  | _    | ns   |
|     |  |                 | $\begin{array}{l} 1.25 \times T_C - 2.0 \\ [4 \leq WS \leq 7] \end{array}$ | 8.4  | _    | ns   |
|     |  |                 | $\begin{array}{c} 2.25 \times T_C - 2.0 \\ [WS \geq 8] \end{array}$        | 16.7 | _    | ns   |
| 110 | WR assertion to data active  | _               | $0.75 \times T_{C} - 3.7$<br>[WS = 1]                                      | 2.5  | _    | ns   |
|     |  |                 | $\begin{array}{l} 0.25 \times T_C - 3.7 \\ [2 \leq WS \leq 3] \end{array}$ | 0.0  | _    |      |
|     |  |                 | $\begin{array}{c} -0.25\times T_C-3.7\\ [WS\geq 4] \end{array}$            | 0.0  | _    |      |
| 111 | WR deassertion to data high impedance                              | —               | $\begin{array}{l} 0.25\times T_C+0.2\\ [1\leq WS\leq 3] \end{array}$       | _    | 2.3  | ns   |
|     |  |                 | $\begin{array}{l} 1.25 \times T_C + 0.2 \\ [4 \leq WS \leq 7] \end{array}$ | _    | 10.6 |      |
|     |  |                 | $\begin{array}{c} 2.25 \times T_C + 0.2 \\ [WS \geq 8] \end{array}$        | _    | 18.9 |      |
| 112 | Previous $\overline{\text{RD}}$ deassertion to data active (write) | _               | $\begin{array}{l} 1.25 \times T_C - 4.0 \\ [1 \leq WS \leq 3] \end{array}$ | 6.4  | _    | ns   |
|     |  |                 | $\begin{array}{l} 2.25\times T_C-4.0\\ [4\leq WS\leq 7] \end{array}$       | 14.7 | _    |      |
|     |  |                 | $\begin{array}{c} 3.25 \times T_C - 4.0 \\ [WS \geq 8] \end{array}$        | 23.1 | _    |      |
| 113 | RD deassertion time  |                 | $\begin{array}{c} 0.75 \times T_C - 4.0 \\ [1 \leq WS \leq 3] \end{array}$ | 2.2  | —    | ns   |
|     |  |                 | $\begin{array}{l} 1.75 \times T_C - 4.0 \\ [4 \leq WS \leq 7] \end{array}$ | 10.6 | —    | ns   |
|     |  |                 | $\begin{array}{c} 2.75 \times T_C - 4.0 \\ [WS \geq 8] \end{array}$        | 18.9 | _    | ns   |

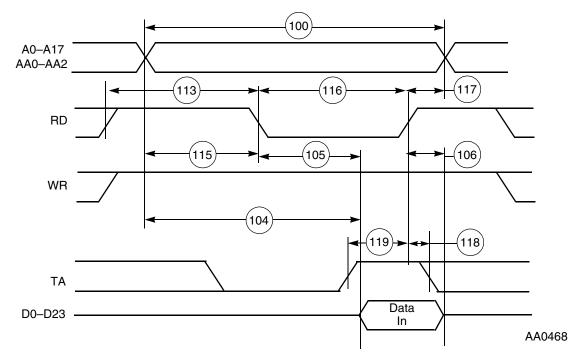
| Table 3-8 | SRAM Read and Write Accesses <sup>1</sup> | (continued) |
|-----------|---|-------------|
|           |   | (           |

| No. | Characteristics  | Symbol | Expression <sup>2</sup>  | Min  | Max | Unit |
|-----|--|--------|--|------|-----|------|
| 114 | WR deassertion time  |        | $0.5 \times T_{C} - 4.0$<br>[WS = 1]                                 | 0.2  | _   | ns   |
|     |  |        | $\begin{array}{c} T_{C}-2.0\\ [2\leqWS\leq3] \end{array}$            | 6.3  | _   | ns   |
|     |  |        | $\begin{array}{l} 2.5\times T_C-4.0\\ [4\leq WS\leq 7] \end{array}$  | 16.8 | _   | ns   |
|     |  |        | $\begin{array}{c} 3.5\times T_C-4.0\\ [WS\geq 8] \end{array}$        | 25.2 | _   | ns   |
| 115 | Address valid to RD assertion  |        | $0.5 	imes T_C - 4.0$  | 0.2  | —   | ns   |
| 116 | RD assertion pulse width   |        | $(WS + 0.25) \times T_C - 4.0$                                       | 6.4  | —   | ns   |
| 117 | RD deassertion to address not valid  |        | $\begin{array}{l} 0.25\times T_C-2.0\\ [1\leq WS\leq 3] \end{array}$ | 0.1  | _   | ns   |
|     |  |        | $\begin{array}{l} 1.25\times T_C-2.0\\ [4\leq WS\leq 7] \end{array}$ | 8.4  | _   | ns   |
|     |  |        | $\begin{array}{c} 2.25 \times T_C - 2.0 \\ [WS \geq 8] \end{array}$  | 16.7 | _   | ns   |
| 118 | $\overline{TA}$ setup before $\overline{RD}$ or $\overline{WR}$ deassertion <sup>4</sup> |        | $0.25 \times T_{C}$ + 2.0  | 4.1  | _   | ns   |
| 119 | $\overline{TA}$ hold after $\overline{RD}$ or $\overline{WR}$ deassertion                |        |  | 0.0  | —   | ns   |

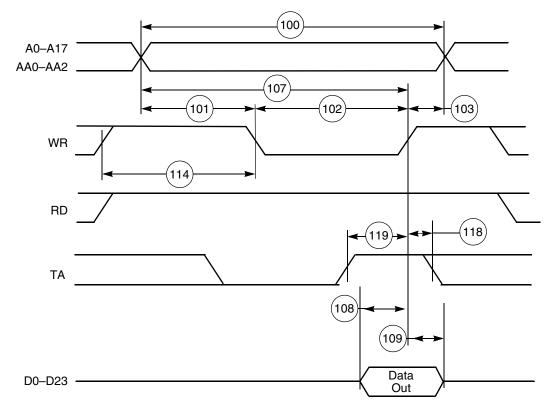
| Table 3-8 | SRAM Read and Write Accesses <sup>1</sup> | (continued) |
|-----------|---|-------------|
|-----------|---|-------------|

<sup>1</sup> All timings for 100 MHz are measured from 0.5 · Vcc to .05 · Vcc

<sup>2</sup> WS is the number of wait states specified in the BCR.
<sup>3</sup> Timings 100, 107 are guaranteed by design, not tested.
<sup>4</sup> In the case of TA negation: timing 118 is relative to the deassertion edge of RD or WR were TA to remain active









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# 3.10.2 DRAM Timing

The selection guides provided in Figure 3-11 and Figure 3-14 should be used for primary selection only. Final selection should be based on the timing provided in the following tables. As an example, the selection guide suggests that 4 wait states must be used for 100 MHz operation when using Page Mode DRAM. However, by using the information in the appropriate table, a designer may choose to evaluate whether fewer wait states might be used by determining which timing prevents operation at 100 MHz, running the chip at a slightly lower frequency (e.g., 95 MHz), using faster DRAM (if it becomes available), and control factors such as capacitive and resistive load to improve overall system performance.

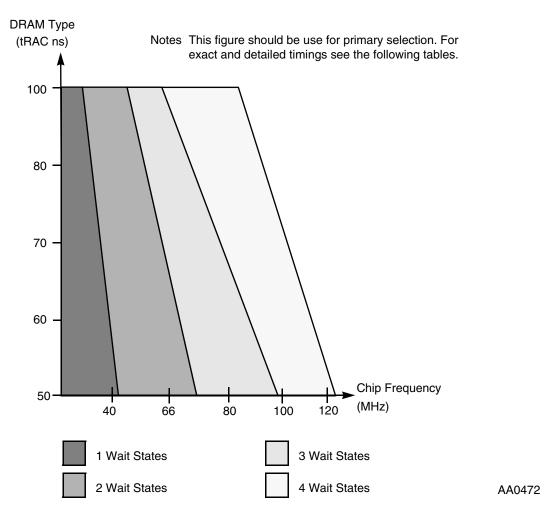


Figure 3-11 DRAM Page Mode Wait States Selection Guide

| N   | Characteristics   | 0h.al             | <b>F</b> orman sin a                                   | 20 N           | lHz <sup>4</sup> | 30 MHz <sup>4</sup> |      | 11   |
|-----|---|-------------------|--|----------------|------------------|---------------------|------|------|
| No. | Characteristics   | Symbol            | Expression   | Min            | Max              | Min                 | Max  | Unit |
| 131 | Page mode cycle time for two consecutive accesses of the same direction | t <sub>PC</sub>   | $2 \times T_{C}$                                       | 100.0          | _                | 66.7                | _    | ns   |
|     | Page mode cycle time for mixed (read and write) accesses                |                   | 1.25 × T <sub>C</sub>                                  | 62.5           | _                | 41.7                | _    |      |
| 132 | CAS assertion to data valid (read)                                      | t <sub>CAC</sub>  | T <sub>C</sub> – 7.5                                   | _              | 42.5             | _                   | 25.8 | ns   |
| 133 | Column address valid to data valid (read)                               | t <sub>AA</sub>   | 1.5 × T <sub>C</sub> – 7.5                             | _              | 67.5             | _                   | 42.5 | ns   |
| 134 | CAS deassertion to data not valid (read hold time)                      | t <sub>OFF</sub>  |  | 0.0            | _                | 0.0                 | _    | ns   |
| 135 | Last CAS assertion to RAS deassertion                                   | t <sub>RSH</sub>  | $0.75 	imes T_C - 4.0$                                 | 33.5           | —                | 21.0                | —    | ns   |
| 136 | Previous CAS deassertion to RAS deassertion                             | t <sub>RHCP</sub> | $2 \times T_C - 4.0$                                   | 96.0           | —                | 62.7                | _    | ns   |
| 137 | CAS assertion pulse width   | t <sub>CAS</sub>  | $0.75 	imes T_C - 4.0$                                 | 33.5           | —                | 21.0                | —    | ns   |
| 138 | Last CAS deassertion to RAS deassertion <sup>5</sup><br>• BRW[1:0] = 00 | t <sub>CRP</sub>  | 1.75 × T <sub>C</sub> – 6.0                            | 81.5           | _                | 52.3                | _    | ns   |
|     | • BRW[1:0] = 01   |                   | $3.25 \times T_{C} - 6.0$                              | 156.5          | —                | 102.2               | —    |      |
|     | <ul> <li>BRW[1:0] = 10</li> <li>BRW[1:0] = 11</li> </ul>                |                   | $4.25 \times T_{C} - 6.0$<br>$6.25 \times T_{C} - 6.0$ | 206.5<br>306.5 | _                | 135.5<br>202.1      | _    |      |
| 139 | CAS deassertion pulse width   | t <sub>CP</sub>   | $0.5 	imes T_C - 4.0$                                  | 21.0           |                  | 12.7                | _    | ns   |
| 140 | Column address valid to CAS assertion                                   | t <sub>ASC</sub>  | $0.5 	imes T_C - 4.0$                                  | 21.0           | _                | 12.7                | _    | ns   |
| 141 | CAS assertion to column address not valid                               | t <sub>CAH</sub>  | $0.75 	imes T_{C} - 4.0$                               | 33.5           | _                | 21.0                |      | ns   |
| 142 | Last column address valid to RAS deassertion                            | t <sub>RAL</sub>  | $2 \times T_C - 4.0$                                   | 96.0           | _                | 62.7                | _    | ns   |
| 143 | WR deassertion to CAS assertion   | t <sub>RCS</sub>  | $0.75 	imes T_C - 3.8$                                 | 33.7           | _                | 21.2                | _    | ns   |
| 144 | CAS deassertion to WR assertion   | t <sub>RCH</sub>  | $0.25 	imes T_C - 3.7$                                 | 8.8            | _                | 4.6                 | _    | ns   |
| 145 | CAS assertion to WR deassertion   | t <sub>WCH</sub>  | $0.5 	imes T_C - 4.2$                                  | 20.8           | —                | 12.5                | _    | ns   |
| 146 | WR assertion pulse width  | t <sub>WP</sub>   | $1.5 	imes T_C - 4.5$                                  | 70.5           | —                | 45.5                | _    | ns   |
| 147 | Last WR assertion to RAS deassertion                                    | t <sub>RWL</sub>  | $1.75 	imes T_{C} - 4.3$                               | 83.2           | —                | 54.0                | —    | ns   |
| 148 | WR assertion to CAS deassertion   | t <sub>CWL</sub>  | $1.75 	imes T_{C} - 4.3$                               | 83.2           | _                | 54.0                | _    | ns   |
| 149 | Data valid to $\overline{CAS}$ assertion (Write)                        | t <sub>DS</sub>   | $0.25\times T_C-4.0$                                   | 8.5            |                  | 4.3                 | _    | ns   |

 Table 3-9
 DRAM Page Mode Timings, One Wait State (Low-Power Applications)<sup>1, 2, 3</sup>

| No. | Characteristics  | Symbol           | bol Expression -        | 20 MHz <sup>4</sup> |      | 30 MHz <sup>4</sup> |      | Unit |
|-----|--|------------------|-------------------------|---------------------|------|---------------------|------|------|
| NO. | Gharacteristics  | Symbol           |                         | Min                 | Max  | Min                 | Max  | Onic |
| 150 | CAS assertion to data not valid (write)                                      | t <sub>DH</sub>  | $0.75 \times T_C - 4.0$ | 33.5                | —    | 21.0                | —    | ns   |
| 151 | $\overline{WR}$ assertion to $\overline{CAS}$ assertion                      | twcs             | T <sub>C</sub> – 4.3    | 45.7                | —    | 29.0                | —    | ns   |
| 152 | Last $\overline{\text{RD}}$ assertion to $\overline{\text{RAS}}$ deassertion | t <sub>ROH</sub> | $1.5 	imes T_C - 4.0$   | 71.0                | _    | 46.0                | _    | ns   |
| 153 | RD assertion to data valid   | t <sub>GA</sub>  | T <sub>C</sub> – 7.5    | _                   | 42.5 | _                   | 25.8 | ns   |
| 154 | RD deassertion to data not valid <sup>6</sup>                                | t <sub>GZ</sub>  |                         | 0.0                 | —    | 0.0                 | —    | ns   |
| 155 | WR assertion to data active  |                  | $0.75 	imes T_C - 0.3$  | 37.2                | _    | 24.7                | _    | ns   |
| 156 | WR deassertion to data high impedance  |                  | $0.25 \times T_{C}$     | _                   | 12.5 | _                   | 8.3  | ns   |

 Table 3-9
 DRAM Page Mode Timings, One Wait State (Low-Power Applications)<sup>1, 2, 3</sup> (continued)

<sup>2</sup> The refresh period is specified in the DCR.

<sup>3</sup> All the timings are calculated for the worst case. Some of the timings are better for specific cases (e.g.,  $t_{PC}$  equals 2 ×  $T_C$  for read-after-read or write-after-write sequences).

<sup>4</sup> Reduced DSP clock speed allows use of Page Mode DRAM with one Wait state (See Figure 3-14.).

<sup>5</sup> BRW[1:0] (DRAM control register bits) defines the number of wait states that should be inserted in each DRAM out-of-page access.

<sup>6</sup>  $\overline{\text{RD}}$  deassertion will always occur after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

| Table 3-10 | DRAM Page Mode Timings, Two Wait States <sup>1, 2, 3, 4</sup> |
|------------|---|
|------------|---|

| No. | Characteristics   | Symbol            | Expression <sup>5</sup>  | 66 I | MHz  | 80 MHz |      | Unit |
|-----|---|-------------------|--------------------------|------|------|--------|------|------|
| NO. | Characteristics   | Symbol            | Expression               | Min  | Max  | Min    | Max  | onin |
| 131 | Page mode cycle time for two consecutive accesses of the same direction | t <sub>PC</sub>   | $2 \times T_C$           | 45.4 |      | 37.5   |      | ns   |
|     | Page mode cycle time for mixed (read and write) accesses                |                   | 1.25 × T <sub>C</sub>    | 41.1 | —    | 34.4   | —    |      |
| 132 | CAS assertion to data valid (read)                                      | t <sub>CAC</sub>  | $1.5 	imes T_{C} - 7.5$  |      | 15.2 | _      | _    | ns   |
|     |   |                   | $1.5 \times T_{C} - 6.5$ | _    | _    | —      | 12.3 | ns   |
| 133 | Column address valid to data valid (read)                               | t <sub>AA</sub>   | $2.5 	imes T_C - 7.5$    |      | 30.4 | _      |      | ns   |
|     |   |                   | $2.5 	imes T_{C} - 6.5$  | —    | —    | —      | 24.8 | ns   |
| 134 | CAS deassertion to data not valid (read hold time)                      | t <sub>OFF</sub>  |                          | 0.0  | _    | 0.0    | _    | ns   |
| 135 | Last CAS assertion to RAS deassertion                                   | t <sub>RSH</sub>  | $1.75 	imes T_{C} - 4.0$ | 22.5 | _    | 17.9   | _    | ns   |
| 136 | Previous $\overline{CAS}$ deassertion to $\overline{RAS}$ deassertion   | t <sub>RHCP</sub> | $3.25\times T_C-4.0$     | 45.2 | _    | 36.6   | _    | ns   |
| 137 | CAS assertion pulse width   | t <sub>CAS</sub>  | $1.5 	imes T_C - 4.0$    | 18.7 | _    | 14.8   |      | ns   |

| No. | Characteristics  | Symbol           | ol Expression <sup>5</sup>  | 66 MHz 80 MHz |      |      |      | Unit |
|-----|--|------------------|-----------------------------|---------------|------|------|------|------|
| NO. | Characteristics  | Symbol           | LAPIESSION                  | Min           | Max  | Min  | Max  | Onit |
| 138 | Last $\overline{CAS}$ deassertion to $\overline{RAS}$ deassertion <sup>6</sup> | t <sub>CRP</sub> |                             |               |      |      |      | ns   |
|     | • BRW[1:0] = 00  |                  | $2.0 	imes T_C - 6.0$       | 24.4          | —    | 19.0 | —    |      |
|     | • BRW[1:0] = 01  |                  | $3.5 	imes T_C - 6.0$       | 47.2          | —    | 37.8 | —    |      |
|     | • BRW[1:0] = 10  |                  | $4.5 	imes T_C - 6.0$       | 62.4          | —    | 50.3 | —    |      |
|     | • BRW[1:0] = 11  |                  | $6.5 	imes T_C - 6.0$       | 92.8          | —    | 75.3 | —    |      |
| 139 | CAS deassertion pulse width  | t <sub>CP</sub>  | $1.25 	imes T_C - 4.0$      | 14.9          | _    | 11.6 | _    | ns   |
| 140 | Column address valid to CAS assertion  | t <sub>ASC</sub> | T <sub>C</sub> – 4.0        | 11.2          | _    | 8.5  | _    | ns   |
| 141 | CAS assertion to column address not valid                                      | t <sub>CAH</sub> | $1.75 	imes T_{C} - 4.0$    | 22.5          | _    | 17.9 | _    | ns   |
| 142 | Last column address valid to $\overline{RAS}$ deassertion                      | t <sub>RAL</sub> | $3 	imes T_C - 4.0$         | 41.5          | _    | 33.5 |      | ns   |
| 143 | $\overline{\rm WR}$ deassertion to $\overline{\rm CAS}$ assertion              | t <sub>RCS</sub> | $1.25 	imes T_C - 3.8$      | 15.1          | —    | 11.8 | _    | ns   |
| 144 | CAS deassertion to WR assertion  | t <sub>RCH</sub> | $0.5 	imes T_C - 3.7$       | 3.9           | —    | 2.6  |      | ns   |
| 145 | $\overline{CAS}$ assertion to $\overline{WR}$ deassertion                      | t <sub>WCH</sub> | $1.5 	imes T_C - 4.2$       | 18.5          | _    | 14.6 |      | ns   |
| 146 | WR assertion pulse width   | t <sub>WP</sub>  | $2.5 	imes T_C - 4.5$       | 33.5          | _    | 26.8 | _    | ns   |
| 147 | Last $\overline{\text{WR}}$ assertion to $\overline{\text{RAS}}$ deassertion   | t <sub>RWL</sub> | $2.75 	imes T_C - 4.3$      | 33.4          | _    | 26.8 | _    | ns   |
| 148 | $\overline{\text{WR}}$ assertion to $\overline{\text{CAS}}$ deassertion        | t <sub>CWL</sub> | $2.5 	imes T_C - 4.3$       | 33.6          | _    | 27.0 |      | ns   |
| 149 | Data valid to CAS assertion (write)  | t <sub>DS</sub>  | $0.25 \times T_{C} - 3.7$   | 0.1           | _    |      | _    | ns   |
|     |  |                  | $0.25 	imes T_C - 3.0$      | —             | —    | 0.1  | —    |      |
| 150 | CAS assertion to data not valid (write)  | t <sub>DH</sub>  | $1.75 	imes T_{C} - 4.0$    | 22.5          | _    | 17.9 | _    | ns   |
| 151 | WR assertion to CAS assertion  | t <sub>WCS</sub> | T <sub>C</sub> – 4.3        | 10.9          | _    | 8.2  | _    | ns   |
| 152 | Last $\overline{\text{RD}}$ assertion to $\overline{\text{RAS}}$ deassertion   | t <sub>ROH</sub> | $2.5 	imes T_C - 4.0$       | 33.9          |      | 27.3 |      | ns   |
| 153 | RD assertion to data valid   | t <sub>GA</sub>  | 1.75 × T <sub>C</sub> – 7.5 | _             | 19.0 | _    | _    | ns   |
|     |  |                  | $1.75 \times T_{C} - 6.5$   | _             | _    | _    | 15.4 |      |
| 154 | RD deassertion to data not valid <sup>7</sup>                                  | t <sub>GZ</sub>  |                             | 0.0           | —    | 0.0  | _    | ns   |
| 155 | WR assertion to data active  |                  | $0.75 	imes T_C - 0.3$      | 11.1          | _    | 9.1  | _    | ns   |
| 156 | WR deassertion to data high impedance  |                  | $0.25 \times T_{C}$         | _             | 3.8  | _    | 3.1  | ns   |

 Table 3-10
 DRAM Page Mode Timings, Two Wait States<sup>1, 2, 3, 4</sup> (continued)

 $^2$  The refresh period is specified in the DCR.

<sup>3</sup> The asynchronous delays specified in the expressions are valid for DSP56366.

<sup>4</sup> There are no DRAMs fast enough to fit to two wait states Page mode @ 100MHz (See Figure 3-11)

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- <sup>5</sup> All the timings are calculated for the worst case. Some of the timings are better for specific cases (e.g.,  $t_{PC}$  equals  $3 \times T_C$  for read-after-read or write-after-write sequences).
- <sup>6</sup> BRW[1:0] (DRAM Control Register bits) defines the number of wait states that should be inserted in each DRAM out-of-page access.
- <sup>7</sup> RD deassertion will always occur after CAS deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

| No. | Characteristics  | Symbol            | Expression <sup>4</sup>  | Min                    | Max  | Unit |
|-----|--|-------------------|--|------------------------|------|------|
| 131 | Page mode cycle time for two consecutive accesses of the same direction  | t <sub>PC</sub>   | 2 × T <sub>C</sub>   | 40.0                   |      | ns   |
|     | Page mode cycle time for mixed (read and write) accesses   |                   | $1.25 \times T_{C}$  | 35.0                   | _    |      |
| 132 | CAS assertion to data valid (read)   | t <sub>CAC</sub>  | $2 \times T_C - 7.0$   | —                      | 13.0 | ns   |
| 133 | Column address valid to data valid (read)  | t <sub>AA</sub>   | $3 	imes T_C - 7.0$  | —                      | 23.0 | ns   |
| 134 | CAS deassertion to data not valid (read hold time)   | t <sub>OFF</sub>  |  | 0.0                    | _    | ns   |
| 135 | Last CAS assertion to RAS deassertion  | t <sub>RSH</sub>  | $2.5 	imes T_C - 4.0$  | 21.0                   | _    | ns   |
| 136 | Previous CAS deassertion to RAS deassertion  | t <sub>RHCP</sub> | $4.5 	imes T_C - 4.0$  | 41.0                   | _    | ns   |
| 137 | CAS assertion pulse width  | t <sub>CAS</sub>  | $2 	imes T_C - 4.0$  | 16.0                   | _    | ns   |
| 138 | Last CAS deassertion to RAS assertion <sup>5</sup><br>• BRW[1:0] = 00<br>• BRW[1:0] = 01<br>• BRW[1:0] = 10<br>• BRW[1:0] = 11 | t <sub>CRP</sub>  | $2.25 \times T_{C} - 6.0$<br>$3.75 \times T_{C} - 6.0$<br>$4.75 \times T_{C} - 6.0$<br>$6.75 \times T_{C} - 6.0$ | —<br>—<br>41.5<br>61.5 |      | ns   |
| 139 | CAS deassertion pulse width  | t <sub>CP</sub>   | $1.5 \times T_{C} - 4.0$   | 11.0                   | _    | ns   |
| 140 | Column address valid to CAS assertion  | t <sub>ASC</sub>  | T <sub>C</sub> – 4.0   | 6.0                    |      | ns   |
| 141 | CAS assertion to column address not valid  | t <sub>CAH</sub>  | $2.5 	imes T_C - 4.0$  | 21.0                   | _    | ns   |
| 142 | Last column address valid to RAS deassertion   | t <sub>RAL</sub>  | $4 	imes T_C - 4.0$  | 36.0                   | _    | ns   |
| 143 | WR deassertion to CAS assertion  | t <sub>RCS</sub>  | $1.25 	imes T_C - 4.0$   | 8.5                    | _    | ns   |
| 144 | CAS deassertion to WR assertion  | t <sub>RCH</sub>  | $0.75 	imes T_{C} - 4.0$   | 3.5                    | _    | ns   |
| 145 | CAS assertion to WR deassertion  | t <sub>WCH</sub>  | $2.25 	imes T_C - 4.2$   | 18.3                   | _    | ns   |
| 146 | WR assertion pulse width   | t <sub>WP</sub>   | $3.5 	imes T_C - 4.5$  | 30.5                   | _    | ns   |
| 147 | Last $\overline{WR}$ assertion to $\overline{RAS}$ deassertion   | t <sub>RWL</sub>  | $3.75 	imes T_C - 4.3$   | 33.2                   | _    | ns   |
| 148 | WR assertion to CAS deassertion  | t <sub>CWL</sub>  | $3.25 	imes T_C - 4.3$   | 28.2                   | _    | ns   |
| 149 | Data valid to $\overline{CAS}$ assertion (write)   | t <sub>DS</sub>   | $0.5 	imes T_C - 4.0$  | 1.0                    | _    | ns   |
|     |  |                   | 1  |                        |      |      |

| Table 0-11 DIAM Tage Mode Thinings, Thee Wall Olaces | Table 3-11 | DRAM Page Mode Timin | gs, Three Wait States <sup>1, 2,</sup> |
|--|------------|----------------------|--|
|--|------------|----------------------|--|

| No. | Characteristics  | Symbol           | Expression <sup>4</sup> | Min  | Max  | Unit |
|-----|--|------------------|-------------------------|------|------|------|
| 150 | CAS assertion to data not valid (write)                                      | t <sub>DH</sub>  | $2.5 	imes T_C - 4.0$   | 21.0 |      | ns   |
| 151 | $\overline{WR}$ assertion to $\overline{CAS}$ assertion                      | twcs             | $1.25 	imes T_C - 4.3$  | 8.2  |      | ns   |
| 152 | Last $\overline{\text{RD}}$ assertion to $\overline{\text{RAS}}$ deassertion | t <sub>ROH</sub> | $3.5\times T_C-4.0$     | 31.0 | _    | ns   |
| 153 | RD assertion to data valid   | t <sub>GA</sub>  | $2.5 	imes T_C - 7.0$   | _    | 18.0 | ns   |
| 154 | RD deassertion to data not valid <sup>6</sup>                                | t <sub>GZ</sub>  |                         | 0.0  |      | ns   |
| 155 | WR assertion to data active  |                  | $0.75 	imes T_C - 0.3$  | 7.2  |      | ns   |
| 156 | WR deassertion to data high impedance  |                  | $0.25 \times T_{C}$     | —    | 2.5  | ns   |

 Table 3-11
 DRAM Page Mode Timings, Three Wait States<sup>1, 2, 3</sup> (continued)

<sup>2</sup> The refresh period is specified in the DCR.

<sup>3</sup> The asynchronous delays specified in the expressions are valid for DSP56366.

<sup>4</sup> All the timings are calculated for the worst case. Some of the timings are better for specific cases (e.g.,  $t_{PC}$  equals  $4 \times T_C$  for read-after-read or write-after-write sequences).

<sup>5</sup> BRW[1:0] (DRAM control register bits) defines the number of wait states that should be inserted in each DRAM out-of page-access.

<sup>6</sup>  $\overline{\text{RD}}$  deassertion will always occur after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

| No. | Characteristics  | Symbol            | Expression <sup>4</sup> | Min  | Max  | Unit |
|-----|--|-------------------|-------------------------|------|------|------|
| 131 | Page mode cycle time for two consecutive accesses of the same direction.     | t <sub>PC</sub>   | $5 \times T_{C}$        | 41.7 | _    | ns   |
|     | Page mode cycle time for mixed (read and write) accesses                     |                   | $4.5 	imes T_C$         | 37.5 | —    |      |
| 132 | CAS assertion to data valid (read)   | t <sub>CAC</sub>  | $2.75 	imes T_C - 7.0$  | _    | 15.9 | ns   |
| 133 | Column address valid to data valid (read)                                    | t <sub>AA</sub>   | $3.75 	imes T_C - 7.0$  | _    | 24.2 | ns   |
| 134 | CAS deassertion to data not valid (read hold time)                           | t <sub>OFF</sub>  |                         | 0.0  | _    | ns   |
| 135 | Last $\overline{CAS}$ assertion to $\overline{RAS}$ deassertion              | t <sub>RSH</sub>  | $3.5 	imes T_C - 4.0$   | 25.2 | _    | ns   |
| 136 | Previous $\overline{CAS}$ deassertion to $\overline{RAS}$ deassertion        | t <sub>RHCP</sub> | $6 	imes T_C - 4.0$     | 46.0 | _    | ns   |
| 137 | CAS assertion pulse width  | t <sub>CAS</sub>  | $2.5 	imes T_C - 4.0$   | 16.8 |      | ns   |
| 138 | Last $\overline{CAS}$ deassertion to $\overline{RAS}$ assertion <sup>5</sup> | t <sub>CRP</sub>  |                         |      |      | ns   |
|     | • BRW[1:0] = 00  |                   | $2.75 	imes T_C - 6.0$  | —    |      |      |
|     | • BRW[1:0] = 01  |                   | $4.25 	imes T_C - 6.0$  | —    | _    |      |
|     | • BRW[1:0] = 10  |                   | $5.25 	imes T_C - 6.0$  | 37.7 | _    |      |
|     | • BRW[1:0] = 11  |                   | $7.25\times T_C-6.0$    | 54.4 | —    |      |
| 139 | CAS deassertion pulse width  | t <sub>CP</sub>   | $2 \times T_C - 4.0$    | 12.7 | —    | ns   |

Table 3-12 DRAM Page Mode Timings, Four Wait States<sup>1, 2, 3</sup>

| No. | Characteristics  | Symbol           | Expression <sup>4</sup>  | Min  | Max  | Unit |
|-----|--|------------------|--------------------------|------|------|------|
| 140 | Column address valid to CAS assertion  | t <sub>ASC</sub> | T <sub>C</sub> – 4.0     | 4.3  |      | ns   |
| 141 | CAS assertion to column address not valid                                    | t <sub>CAH</sub> | $3.5 	imes T_C - 4.0$    | 25.2 | _    | ns   |
| 142 | Last column address valid to RAS deassertion                                 | t <sub>RAL</sub> | $5 	imes T_C - 4.0$      | 37.7 | _    | ns   |
| 143 | WR deassertion to CAS assertion  | t <sub>RCS</sub> | $1.25 	imes T_C - 4.0$   | 6.4  | _    | ns   |
| 144 | CAS deassertion to WR assertion  | t <sub>RCH</sub> | $1.25 	imes T_{C} - 4.0$ | 6.4  | —    | ns   |
| 145 | CAS assertion to WR deassertion  | t <sub>WCH</sub> | $3.25 	imes T_C - 4.2$   | 22.9 | _    | ns   |
| 146 | WR assertion pulse width   | t <sub>WP</sub>  | $4.5 	imes T_C - 4.5$    | 33.0 | _    | ns   |
| 147 | Last $\overline{WR}$ assertion to $\overline{RAS}$ deassertion               | t <sub>RWL</sub> | $4.75 	imes T_C - 4.3$   | 35.3 | _    | ns   |
| 148 | WR assertion to CAS deassertion  | t <sub>CWL</sub> | $3.75 	imes T_C - 4.3$   | 26.9 | _    | ns   |
| 149 | Data valid to CAS assertion (write)  | t <sub>DS</sub>  | $0.5 	imes T_C - 4.0$    | 0.2  | _    | ns   |
| 150 | CAS assertion to data not valid (write)                                      | t <sub>DH</sub>  | $3.5 	imes T_C - 4.0$    | 25.2 | _    | ns   |
| 151 | WR assertion to CAS assertion  | twcs             | $1.25 	imes T_C - 4.3$   | 6.1  | _    | ns   |
| 152 | Last $\overline{\text{RD}}$ assertion to $\overline{\text{RAS}}$ deassertion | t <sub>ROH</sub> | $4.5 	imes T_C - 4.0$    | 33.5 | _    | ns   |
| 153 | RD assertion to data valid   | t <sub>GA</sub>  | $3.25 	imes T_C - 7.0$   | -    | 20.1 | ns   |
| 154 | RD deassertion to data not valid <sup>6</sup>                                | t <sub>GZ</sub>  |                          | 0.0  | —    | ns   |
| 155 | WR assertion to data active  |                  | $0.75 	imes T_C - 0.3$   | 5.9  | —    | ns   |
| 156 | WR deassertion to data high impedance  |                  | $0.25 \times T_{C}$      | -    | 2.1  | ns   |

 Table 3-12
 DRAM Page Mode Timings, Four Wait States<sup>1, 2, 3</sup> (continued)

<sup>2</sup> The refresh period is specified in the DCR.

 $^3\,$  The asynchronous delays specified in the expressions are valid for DSP56366.

<sup>4</sup> All the timings are calculated for the worst case. Some of the timings are better for specific cases (e.g.,  $t_{PC}$  equals 3 × T<sub>C</sub> for read-after-read or write-after-write sequences).

<sup>5</sup> BRW[1:0] (DRAM control register bits) defines the number of wait states that should be inserted in each DRAM out-of-page access.

<sup>6</sup>  $\overline{\text{RD}}$  deassertion will always occur after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

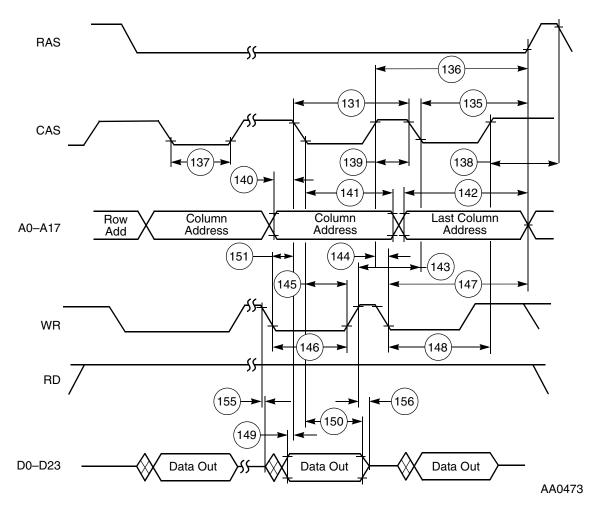


Figure 3-12 DRAM Page Mode Write Accesses

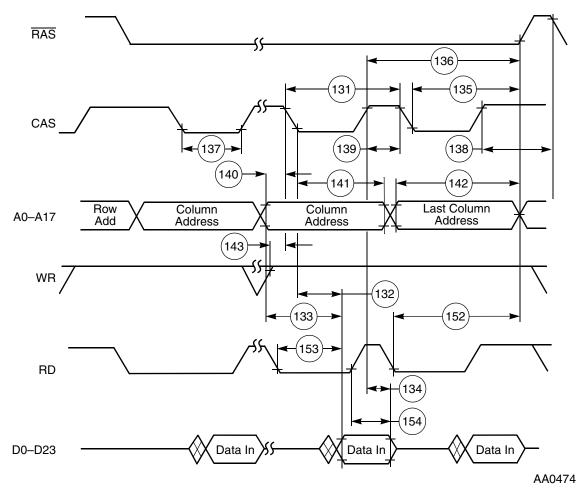


Figure 3-13 DRAM Page Mode Read Accesses

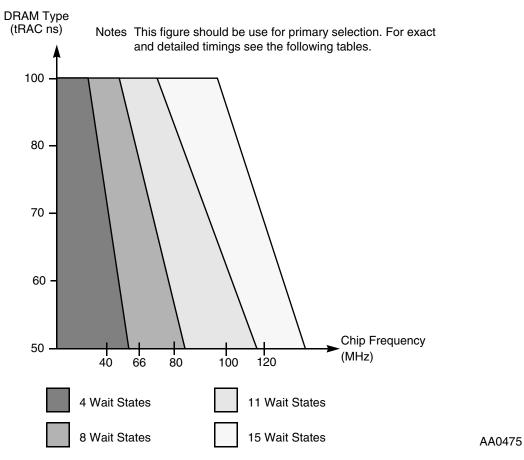


Figure 3-14 DRAM Out-of-Page Wait States Selection Guide

| No. | Characteristics <sup>3</sup>                       | Symbol           | Expression               | 20 MHz <sup>4</sup> |       | 30 MHz <sup>4</sup> |      | Unit |
|-----|--|------------------|--------------------------|---------------------|-------|---------------------|------|------|
| NO. | Characteristics                                    | Symbol           | LAPIESSION               | Min                 | Max   | Min                 | Max  | Onic |
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | $5 \times T_{C}$         | 250.0               |       | 166.7               |      | ns   |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> | $2.75\times T_C-7.5$     | _                   | 130.0 | _                   | 84.2 | ns   |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | $1.25 	imes T_{C} - 7.5$ | _                   | 55.0  | _                   | 34.2 | ns   |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | $1.5 	imes T_C - 7.5$    | _                   | 67.5  | _                   | 42.5 | ns   |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> |                          | 0.0                 | _     | 0.0                 | _    | ns   |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $1.75\times T_C^{}-4.0$  | 83.5                |       | 54.3                |      | ns   |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $3.25\times T_C-4.0$     | 158.5               | _     | 104.3               | _    | ns   |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | $1.75\times T_C-4.0$     | 83.5                |       | 54.3                | _    | ns   |

| Table 3-13 | DRAM Out-of-Page and Refresh Tin | nings, Four Wait States <sup>1, 2</sup> |
|------------|----------------------------------|---|
|------------|----------------------------------|---|

|     |  |                  |                         |       | 4    |       | 4    |      |
|-----|--|------------------|-------------------------|-------|------|-------|------|------|
| No. | Characteristics <sup>3</sup>   | Symbol           | Expression              | 20 N  | lHz⁴ | 30 N  | lHz⁴ | Unit |
|     |  | -                | •                       | Min   | Мах  | Min   | Мах  |      |
| 165 | $\overline{\text{RAS}}$ assertion to $\overline{\text{CAS}}$ deassertion | t <sub>CSH</sub> | $2.75\times T_C-4.0$    | 133.5 |      | 87.7  |      | ns   |
| 166 | CAS assertion pulse width  | t <sub>CAS</sub> | $1.25\times T_C-4.0$    | 58.5  | _    | 37.7  |      | ns   |
| 167 | $\overline{RAS}$ assertion to $\overline{CAS}$ assertion                 | t <sub>RCD</sub> | $1.5 	imes T_C \pm 2$   | 73.0  | 77.0 | 48.0  | 52.0 | ns   |
| 168 | RAS assertion to column address valid                                    | t <sub>RAD</sub> | $1.25 	imes T_C \pm 2$  | 60.5  | 64.5 | 39.7  | 43.7 | ns   |
| 169 | $\overline{CAS}$ deassertion to $\overline{RAS}$ assertion               | t <sub>CRP</sub> | $2.25\times T_C-4.0$    | 108.5 | _    | 71.0  |      | ns   |
| 170 | CAS deassertion pulse width  | t <sub>CP</sub>  | $1.75\times T_C-4.0$    | 83.5  | _    | 54.3  | _    | ns   |
| 171 | Row address valid to RAS assertion                                       | t <sub>ASR</sub> | $1.75 	imes T_C - 4.0$  | 83.5  | _    | 54.3  | _    | ns   |
| 172 | RAS assertion to row address not valid                                   | t <sub>RAH</sub> | $1.25\times T_C-4.0$    | 58.5  | _    | 37.7  | _    | ns   |
| 173 | Column address valid to $\overline{CAS}$ assertion                       | t <sub>ASC</sub> | $0.25\times T_C-4.0$    | 8.5   | _    | 4.3   | _    | ns   |
| 174 | CAS assertion to column address not valid                                | t <sub>CAH</sub> | $1.75\times T_C-4.0$    | 83.5  | _    | 54.3  |      | ns   |
| 175 | RAS assertion to column address not valid                                | t <sub>AR</sub>  | $3.25\times T_C-4.0$    | 158.5 | _    | 104.3 |      | ns   |
| 176 | Column address valid to RAS deassertion                                  | t <sub>RAL</sub> | $2 \times T_C - 4.0$    | 96.0  |      | 62.7  |      | ns   |
| 177 | $\overline{\text{WR}}$ deassertion to $\overline{\text{CAS}}$ assertion  | t <sub>RCS</sub> | $1.5 	imes T_C - 3.8$   | 71.2  |      | 46.2  |      | ns   |
| 178 | $\overline{CAS}$ deassertion to $\overline{WR}$ assertion                | t <sub>RCH</sub> | $0.75\times T_C^{}-3.7$ | 33.8  | _    | 21.3  |      | ns   |
| 179 | $\overline{RAS}$ deassertion to $\overline{WR}$ assertion                | t <sub>RRH</sub> | $0.25\times T_C^{}-3.7$ | 8.8   | _    | 4.6   |      | ns   |
| 180 | CAS assertion to WR deassertion  | t <sub>WCH</sub> | $1.5 	imes T_C - 4.2$   | 70.8  | _    | 45.8  |      | ns   |
| 181 | $\overline{RAS}$ assertion to $\overline{WR}$ deassertion                | t <sub>WCR</sub> | $3 	imes T_C - 4.2$     | 145.8 | _    | 95.8  |      | ns   |
| 182 | WR assertion pulse width   | t <sub>WP</sub>  | $4.5\times T_C-4.5$     | 220.5 |      | 145.5 |      | ns   |
| 183 | $\overline{\text{WR}}$ assertion to $\overline{\text{RAS}}$ deassertion  | t <sub>RWL</sub> | $4.75\times T_C-4.3$    | 233.2 |      | 154.0 |      | ns   |
| 184 | $\overline{\rm WR}$ assertion to $\overline{\rm CAS}$ deassertion        | t <sub>CWL</sub> | $4.25\times T_C-4.3$    | 208.2 |      | 137.4 |      | ns   |
| 185 | Data valid to CAS assertion (write)                                      | t <sub>DS</sub>  | $2.25\times T_C-4.0$    | 108.5 | _    | 71.0  |      | ns   |
| 186 | CAS assertion to data not valid (write)                                  | t <sub>DH</sub>  | $1.75\times T_C-4.0$    | 83.5  | _    | 54.3  |      | ns   |
| 187 | RAS assertion to data not valid (write)                                  | t <sub>DHR</sub> | $3.25\times T_C-4.0$    | 158.5 | _    | 104.3 |      | ns   |
| 188 | $\overline{\rm WR}$ assertion to $\overline{\rm CAS}$ assertion          | t <sub>WCS</sub> | $3 	imes T_C - 4.3$     | 145.7 |      | 95.7  |      | ns   |
| 189 | CAS assertion to RAS assertion (refresh)                                 | t <sub>CSR</sub> | $0.5 	imes T_C - 4.0$   | 21.0  |      | 12.7  |      | ns   |
| 190 | RAS deassertion to CAS assertion (refresh)                               | t <sub>RPC</sub> | $1.25\times T_C-4.0$    | 58.5  |      | 37.7  |      | ns   |

### Table 3-13 DRAM Out-of-Page and Refresh Timings, Four Wait States<sup>1, 2</sup> (continued)

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| No. | Characteristics <sup>3</sup>                  | Symbol           | Expression -            | 20 MHz <sup>4</sup> |       | 30 MHz <sup>4</sup> |       | Unit |
|-----|---|------------------|-------------------------|---------------------|-------|---------------------|-------|------|
| NO. | Characteristics                               | Symbol           | Expression              | Min                 | Max   | Min                 | Мах   | Unit |
| 191 | RD assertion to RAS deassertion               | t <sub>ROH</sub> | $4.5 	imes T_C - 4.0$   | 221.0               | _     | 146.0               | _     | ns   |
| 192 | RD assertion to data valid                    | t <sub>GA</sub>  | $4 	imes T_C - 7.5$     |                     | 192.5 | _                   | 125.8 | ns   |
| 193 | RD deassertion to data not valid <sup>3</sup> | t <sub>GZ</sub>  |                         | 0.0                 |       | 0.0                 | _     | ns   |
| 194 | WR assertion to data active                   |                  | $0.75\times T_C^{}-0.3$ | 37.2                | _     | 24.7                | _     | ns   |
| 195 | WR deassertion to data high impedance         |                  | $0.25 \times T_{C}$     | _                   | 12.5  |                     | 8.3   | ns   |

 Table 3-13
 DRAM Out-of-Page and Refresh Timings, Four Wait States<sup>1, 2</sup> (continued)

 $^2$  The refresh period is specified in the DCR.

<sup>3</sup>  $\overline{\text{RD}}$  deassertion will always occur after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

<sup>4</sup> Reduced DSP clock speed allows use of DRAM out-of-page access with four Wait states (See Figure 3-17.).

| No. | Characteristics <sup>3</sup>                       | Symbol           | Expression <sup>4</sup>   | 66 I  | ИНz       | 80 1  | MHz       | Unit |
|-----|--|------------------|---|-------|-----------|-------|-----------|------|
| NO. | Characteristics                                    | Symbol           | Expression  | Min   | Max       | Min   | Max       |      |
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | $9 \times T_{C}$  | 136.4 | _         | 112.5 | _         | ns   |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> | $\begin{array}{c} 4.75 \times T_{C} - 7.5 \\ 4.75 \times T_{C} - 6.5 \end{array}$ | _     | 64.5<br>— | _     | —<br>52.9 | ns   |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | $\begin{array}{c} 2.25 \times T_{C} - 7.5 \\ 2.25 \times T_{C} - 6.5 \end{array}$ | _     | 26.6<br>— | _     | <br>21.6  | ns   |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | $\begin{array}{c} 3\times T_C-7.5\\ 3\times T_C-6.5\end{array}$                   | _     | 40.0<br>— | _     | —<br>31.0 | ns   |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> |   | 0.0   | _         | 0.0   | _         | ns   |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $3.25\times T_C-4.0$  | 45.2  | _         | 36.6  | —         | ns   |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $5.75\times T_C-4.0$  | 83.1  |           | 67.9  | —         | ns   |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | $3.25\times T_C-4.0$  | 45.2  | _         | 36.6  | _         | ns   |
| 165 | RAS assertion to CAS deassertion                   | t <sub>CSH</sub> | $4.75\times T_C-4.0$  | 68.0  |           | 55.5  | _         | ns   |
| 166 | CAS assertion pulse width                          | t <sub>CAS</sub> | $2.25\times T_C-4.0$  | 30.1  |           | 24.1  | —         | ns   |
| 167 | RAS assertion to CAS assertion                     | t <sub>RCD</sub> | $2.5 	imes T_C \pm 2$   | 35.9  | 39.9      | 29.3  | 33.3      | ns   |
| 168 | RAS assertion to column address valid              | t <sub>RAD</sub> | $1.75 	imes T_C \pm 2$  | 24.5  | 28.5      | 19.9  | 23.9      | ns   |

Table 3-14 DRAM Out-of-Page and Refresh Timings, Eight Wait States<sup>1, 2</sup>

| 1   |   |                  |  |       |       | ,<br>[ | []        |      |
|-----|---|------------------|--|-------|-------|--------|-----------|------|
| No. | Characteristics <sup>3</sup>  | Symbol           | Expression <sup>4</sup>                              | 66 I  | MHz   | 80     | MHz       | Unit |
|     |   | Cymber           |  | Min   | Max   | Min    | Max       | onic |
| 169 | CAS deassertion to RAS assertion  | t <sub>CRP</sub> | $4.25\times T_C-4.0$                                 | 59.8  |       | 49.1   | —         | ns   |
| 170 | CAS deassertion pulse width   | t <sub>CP</sub>  | $2.75\times T_C-4.0$                                 | 37.7  | _     | 30.4   | _         | ns   |
| 171 | Row address valid to $\overline{RAS}$ assertion                         | t <sub>ASR</sub> | $3.25\times T_C-4.0$                                 | 45.2  | _     | 36.6   | _         | ns   |
| 172 | RAS assertion to row address not valid                                  | t <sub>RAH</sub> | $1.75 	imes T_C - 4.0$                               | 22.5  | _     | 17.9   | _         | ns   |
| 173 | Column address valid to CAS assertion                                   | t <sub>ASC</sub> | $0.75 	imes T_C - 4.0$                               | 7.4   |       | 5.4    | _         | ns   |
| 174 | CAS assertion to column address not valid                               | t <sub>CAH</sub> | $3.25 	imes T_C - 4.0$                               | 45.2  |       | 36.6   | _         | ns   |
| 175 | RAS assertion to column address not valid                               | t <sub>AR</sub>  | $5.75 	imes T_C - 4.0$                               | 83.1  |       | 67.9   | _         | ns   |
| 176 | Column address valid to RAS deassertion                                 | t <sub>RAL</sub> | $4 \times T_C - 4.0$                                 | 56.6  |       | 46.0   | _         | ns   |
| 177 | $\overline{\rm WR}$ deassertion to $\overline{\rm CAS}$ assertion       | t <sub>RCS</sub> | $2 \times T_C - 3.8$                                 | 26.5  | _     | 21.2   | _         | ns   |
| 178 | $\overline{CAS}$ deassertion to $\overline{WR}^5$ assertion             | t <sub>RCH</sub> | $1.25\times T_C^{}-3.7$                              | 15.2  | _     | 11.9   | _         | ns   |
| 179 | $\overline{RAS}$ deassertion to $\overline{WR}^5$ assertion             | t <sub>RRH</sub> | $0.25\times T_C^{}-3.7$                              | 0.1   |       | _      | _         | ns   |
|     |   |                  | $0.25\times T_C^{}-3.0$                              | —     | —     | 0.1    | —         |      |
| 180 | $\overline{CAS}$ assertion to $\overline{WR}$ deassertion               | t <sub>WCH</sub> | $3 	imes T_C - 4.2$                                  | 41.3  | —     | 33.3   | —         | ns   |
| 181 | $\overline{RAS}$ assertion to $\overline{WR}$ deassertion               | t <sub>WCR</sub> | $5.5 	imes T_C - 4.2$                                | 79.1  |       | 64.6   | _         | ns   |
| 182 | WR assertion pulse width  | t <sub>WP</sub>  | $8.5 	imes T_C - 4.5$                                | 124.3 |       | 101.8  | —         | ns   |
| 183 | $\overline{WR}$ assertion to $\overline{RAS}$ deassertion               | t <sub>RWL</sub> | $8.75\times T_C-4.3$                                 | 128.3 |       | 105.1  | _         | ns   |
| 184 | $\overline{WR}$ assertion to $\overline{CAS}$ deassertion               | t <sub>CWL</sub> | $7.75\times T_C-4.3$                                 | 113.1 |       | 92.6   | _         | ns   |
| 185 | Data valid to CAS assertion (write)                                     | t <sub>DS</sub>  | $4.75\times T_C-4.0$                                 | 68.0  |       | 55.4   | _         | ns   |
| 186 | CAS assertion to data not valid (write)                                 | t <sub>DH</sub>  | $3.25\times T_C-4.0$                                 | 45.2  |       | 36.6   | —         | ns   |
| 187 | RAS assertion to data not valid (write)                                 | t <sub>DHR</sub> | $5.75\times T_C-4.0$                                 | 83.1  | _     | 67.9   | _         | ns   |
| 188 | $\overline{WR}$ assertion to $\overline{CAS}$ assertion                 | t <sub>wcs</sub> | $5.5 	imes T_C - 4.3$                                | 79.0  | _     | 64.5   | _         | ns   |
| 189 | CAS assertion to RAS assertion (refresh)                                | t <sub>CSR</sub> | $1.5 	imes T_C - 4.0$                                | 18.7  | _     | 14.8   | _         | ns   |
| 190 | RAS deassertion to CAS assertion (refresh)                              | t <sub>RPC</sub> | $1.75 	imes T_C - 4.0$                               | 22.5  |       | 17.9   |           | ns   |
| 191 | $\overline{\text{RD}}$ assertion to $\overline{\text{RAS}}$ deassertion | t <sub>ROH</sub> | $8.5 	imes T_C - 4.0$                                | 124.8 | _     | 102.3  | —         | ns   |
| 192 | RD assertion to data valid  | t <sub>GA</sub>  | $7.5 \times T_{C} - 7.5$<br>$7.5 \times T_{C} - 6.5$ | _     | 106.1 | _      | —<br>87.3 | ns   |
|     |   |                  |  |       |       |        | 0.10      |      |

| Table 3-14 | DRAM Out-of-Page and Refresh | n Timings, Eight Wait States <sup>1, 2</sup> | (continued) |
|------------|------------------------------|--|-------------|
|            |                              |  | (           |

 Table 3-14
 DRAM Out-of-Page and Refresh Timings, Eight Wait States<sup>1, 2</sup> (continued)

| No. | Characteristics <sup>3</sup>                  | Symbol          | Expression <sup>4</sup> | 66 MHz |     | 80 MHz |     | Unit |
|-----|---|-----------------|-------------------------|--------|-----|--------|-----|------|
| NO. | ondraotensitos                                | Symbol          | Expression              | Min    | Max | Min    | Max | onic |
| 193 | RD deassertion to data not valid <sup>4</sup> | t <sub>GZ</sub> | 0.0                     | 0.0    |     | 0.0    |     | ns   |
| 194 | WR assertion to data active                   |                 | $0.75\times T_C^{}-0.3$ | 11.1   | _   | 9.1    | _   | ns   |
| 195 | WR deassertion to data high impedance         |                 | $0.25 \times T_{C}$     | _      | 3.8 | _      | 3.1 | ns   |

 $^2$  The refresh period is specified in the DCR.

 $^{3}$  RD deassertion will always occur after CAS deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

<sup>4</sup> The asynchronous delays specified in the expressions are valid for DSP56366.

<sup>5</sup> Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for read cycles.

| Table 3-15 | DRAM Out-of-Page and F | Refresh Timings, Eleven Wa | ait States <sup>1, 2</sup> |
|------------|------------------------|----------------------------|----------------------------|
|------------|------------------------|----------------------------|----------------------------|

| No. | Characteristics <sup>3</sup>                       | Symbol           | Expression <sup>4</sup>  | Min   | Max  | Unit |
|-----|--|------------------|--------------------------|-------|------|------|
| 157 | Random read or write cycle time                    | t <sub>RC</sub>  | $12 \times T_{C}$        | 120.0 |      | ns   |
| 158 | RAS assertion to data valid (read)                 | t <sub>RAC</sub> | $6.25 	imes T_{C} - 7.0$ | —     | 55.5 | ns   |
| 159 | CAS assertion to data valid (read)                 | t <sub>CAC</sub> | $3.75 	imes T_{C} - 7.0$ | —     | 30.5 | ns   |
| 160 | Column address valid to data valid (read)          | t <sub>AA</sub>  | $4.5 	imes T_C - 7.0$    | —     | 38.0 | ns   |
| 161 | CAS deassertion to data not valid (read hold time) | t <sub>OFF</sub> |                          | 0.0   | _    | ns   |
| 162 | RAS deassertion to RAS assertion                   | t <sub>RP</sub>  | $4.25 	imes T_C - 4.0$   | 38.5  |      | ns   |
| 163 | RAS assertion pulse width                          | t <sub>RAS</sub> | $7.75 	imes T_{C} - 4.0$ | 73.5  | _    | ns   |
| 164 | CAS assertion to RAS deassertion                   | t <sub>RSH</sub> | $5.25 	imes T_C - 4.0$   | 48.5  | _    | ns   |
| 165 | RAS assertion to CAS deassertion                   | t <sub>CSH</sub> | $6.25 	imes T_C - 4.0$   | 58.5  | _    | ns   |
| 166 | CAS assertion pulse width                          | t <sub>CAS</sub> | $3.75 	imes T_C - 4.0$   | 33.5  | _    | ns   |
| 167 | RAS assertion to CAS assertion                     | t <sub>RCD</sub> | $2.5 	imes T_C \pm 4.0$  | 21.0  | 29.0 | ns   |
| 168 | RAS assertion to column address valid              | t <sub>RAD</sub> | $1.75 	imes T_C \pm 4.0$ | 13.5  | 21.5 | ns   |
| 169 | CAS deassertion to RAS assertion                   | t <sub>CRP</sub> | $5.75 	imes T_C - 4.0$   | 53.5  | _    | ns   |
| 170 | CAS deassertion pulse width                        | t <sub>CP</sub>  | $4.25 	imes T_C - 4.0$   | 38.5  | _    | ns   |
| 171 | Row address valid to RAS assertion                 | t <sub>ASR</sub> | $4.25 	imes T_C - 4.0$   | 38.5  | _    | ns   |
| 172 | RAS assertion to row address not valid             | t <sub>RAH</sub> | $1.75 	imes T_C - 4.0$   | 13.5  | _    | ns   |
| 173 | Column address valid to CAS assertion              | t <sub>ASC</sub> | $0.75 	imes T_C - 4.0$   | 3.5   | _    | ns   |

|     |   | <b>3</b> -, <u>-</u> |                             | (     | ,       |      |
|-----|---|----------------------|-----------------------------|-------|---------|------|
| No. | Characteristics <sup>3</sup>  | Symbol               | Expression <sup>4</sup>     | Min   | Max     | Unit |
| 174 | CAS assertion to column address not valid                               | t <sub>CAH</sub>     | $5.25 	imes T_C - 4.0$      | 48.5  | _       | ns   |
| 175 | RAS assertion to column address not valid                               | t <sub>AR</sub>      | $7.75 	imes T_C - 4.0$      | 73.5  |         | ns   |
| 176 | Column address valid to RAS deassertion                                 | t <sub>RAL</sub>     | $6 	imes T_C - 4.0$         | 56.0  |         | ns   |
| 177 | $\overline{\text{WR}}$ deassertion to $\overline{\text{CAS}}$ assertion | t <sub>RCS</sub>     | $3.0 	imes T_C - 4.0$       | 26.0  |         | ns   |
| 178 | CAS deassertion to WR <sup>5</sup> assertion                            | t <sub>RCH</sub>     | $1.75 	imes T_C - 4.0$      | 13.5  |         | ns   |
| 179 | RAS deassertion to WR <sup>5</sup> assertion                            | t <sub>RRH</sub>     | $0.25 	imes T_C - 2.0$      | 0.5   | _       | ns   |
| 180 | CAS assertion to WR deassertion   | t <sub>WCH</sub>     | $5 	imes T_C - 4.2$         | 45.8  |         | ns   |
| 181 | RAS assertion to WR deassertion   | t <sub>WCR</sub>     | 7.5 × T <sub>C</sub> – 4.2  | 70.8  |         | ns   |
| 182 | WR assertion pulse width  | t <sub>WP</sub>      | 11.5 × T <sub>C</sub> – 4.5 | 110.5 | _       | ns   |
| 183 | WR assertion to RAS deassertion   | t <sub>RWL</sub>     | $11.75 	imes T_{C} - 4.3$   | 113.2 |         | ns   |
| 184 | WR assertion to CAS deassertion   | t <sub>CWL</sub>     | $10.25 	imes T_{C} - 4.3$   | 103.2 |         | ns   |
| 185 | Data valid to CAS assertion (write)                                     | t <sub>DS</sub>      | $5.75 	imes T_{C} - 4.0$    | 53.5  | _       | ns   |
| 186 | CAS assertion to data not valid (write)                                 | t <sub>DH</sub>      | $5.25 	imes T_C - 4.0$      | 48.5  | _       | ns   |
| 187 | RAS assertion to data not valid (write)                                 | t <sub>DHR</sub>     | $7.75 	imes T_C - 4.0$      | 73.5  |         | ns   |
| 188 | WR assertion to CAS assertion   | t <sub>WCS</sub>     | $6.5 	imes T_{C} - 4.3$     | 60.7  |         | ns   |
| 189 | $\overline{CAS}$ assertion to $\overline{RAS}$ assertion (refresh)      | t <sub>CSR</sub>     | $1.5 	imes T_{C} - 4.0$     | 11.0  | _       | ns   |
| 190 | RAS deassertion to CAS assertion (refresh)                              | t <sub>RPC</sub>     | $2.75 	imes T_C - 4.0$      | 23.5  | _       | ns   |
| 191 | RD assertion to RAS deassertion   | t <sub>ROH</sub>     | $11.5 \times T_{C} - 4.0$   | 111.0 |         | ns   |
| 192 | RD assertion to data valid  | t <sub>GA</sub>      | $10 	imes T_C - 7.0$        | _     | 93.0    | ns   |
| 193 | RD deassertion to data not valid <sup>3</sup>                           | t <sub>GZ</sub>      |                             | 0.0   |         | ns   |
| 194 | WR assertion to data active   |                      | $0.75 	imes T_C - 0.3$      | 7.2   |         | ns   |
| 195 | WR deassertion to data high impedance                                   |                      | 0.25 × T <sub>C</sub>       |       | 2.5     | ns   |
|     |   |                      |                             | 7.2   | <br>2.5 |      |

 Table 3-15
 DRAM Out-of-Page and Refresh Timings, Eleven Wait States<sup>1, 2</sup> (continued)

 $^{2}$  The refresh period is specified in the DCR.

<sup>3</sup>  $\overline{\text{RD}}$  deassertion will always occur after  $\overline{\text{CAS}}$  deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

<sup>4</sup> The asynchronous delays specified in the expressions are valid for DSP56366.

 $^5\,$  Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for read cycles.

| No. | Characteristics <sup>3</sup>                                      | Symbol           | Expression                | Min   | Max  | Unit |
|-----|---|------------------|---------------------------|-------|------|------|
| 157 | Random read or write cycle time                                   | t <sub>RC</sub>  | $16 \times T_C$           | 133.3 |      | ns   |
| 158 | RAS assertion to data valid (read)                                | t <sub>RAC</sub> | $8.25 	imes T_{C} - 5.7$  | _     | 63.0 | ns   |
| 159 | CAS assertion to data valid (read)                                | t <sub>CAC</sub> | $4.75 	imes T_{C} - 5.7$  | _     | 33.9 | ns   |
| 160 | Column address valid to data valid (read)                         | t <sub>AA</sub>  | $5.5 	imes T_{C} - 5.7$   | _     | 40.1 | ns   |
| 161 | CAS deassertion to data not valid (read hold time)                | t <sub>OFF</sub> | 0.0                       | 0.0   | _    | ns   |
| 162 | RAS deassertion to RAS assertion                                  | t <sub>RP</sub>  | $6.25 	imes T_C - 4.0$    | 48.1  | _    | ns   |
| 163 | RAS assertion pulse width   | t <sub>RAS</sub> | $9.75 	imes T_{C} - 4.0$  | 77.2  | _    | ns   |
| 164 | CAS assertion to RAS deassertion                                  | t <sub>RSH</sub> | $6.25 	imes T_C - 4.0$    | 48.1  | _    | ns   |
| 165 | RAS assertion to CAS deassertion                                  | t <sub>CSH</sub> | $8.25 	imes T_C - 4.0$    | 64.7  | _    | ns   |
| 166 | CAS assertion pulse width   | t <sub>CAS</sub> | $4.75 	imes T_C - 4.0$    | 35.6  | _    | ns   |
| 167 | RAS assertion to CAS assertion                                    | t <sub>RCD</sub> | $3.5 	imes T_C \pm 2$     | 27.2  | 31.2 | ns   |
| 168 | RAS assertion to column address valid                             | t <sub>RAD</sub> | $2.75 	imes T_C \pm 2$    | 20.9  | 24.9 | ns   |
| 169 | CAS deassertion to RAS assertion                                  | t <sub>CRP</sub> | $7.75 	imes T_{C} - 4.0$  | 60.6  | _    | ns   |
| 170 | CAS deassertion pulse width                                       | t <sub>CP</sub>  | $6.25 	imes T_C - 4.0$    | 48.1  | _    | ns   |
| 171 | Row address valid to RAS assertion                                | t <sub>ASR</sub> | $6.25 \times T_{C} - 4.0$ | 48.1  | _    | ns   |
| 172 | RAS assertion to row address not valid                            | t <sub>RAH</sub> | $2.75 	imes T_{C} - 4.0$  | 18.9  | _    | ns   |
| 173 | Column address valid to CAS assertion                             | t <sub>ASC</sub> | $0.75 	imes T_C - 4.0$    | 2.2   | _    | ns   |
| 174 | CAS assertion to column address not valid                         | t <sub>CAH</sub> | $6.25 	imes T_C - 4.0$    | 48.1  | _    | ns   |
| 175 | RAS assertion to column address not valid                         | t <sub>AR</sub>  | $9.75 	imes T_{C} - 4.0$  | 77.2  | _    | ns   |
| 176 | Column address valid to RAS deassertion                           | t <sub>RAL</sub> | $7 	imes T_C - 4.0$       | 54.3  | _    | ns   |
| 177 | $\overline{\rm WR}$ deassertion to $\overline{\rm CAS}$ assertion | t <sub>RCS</sub> | $5 	imes T_C - 3.8$       | 37.9  | —    | ns   |
| 178 | $\overline{CAS}$ deassertion to $\overline{WR}^4$ assertion       | t <sub>RCH</sub> | $1.75 	imes T_{C} - 3.7$  | 10.9  | _    | ns   |
| 179 | $\overline{RAS}$ deassertion to $\overline{WR}^5$ assertion       | t <sub>RRH</sub> | $0.25 	imes T_C - 2.0$    | 0.1   | —    | ns   |
| 180 | CAS assertion to WR deassertion                                   | t <sub>WCH</sub> | $6 	imes T_C - 4.2$       | 45.8  | —    | ns   |
| 181 | RAS assertion to WR deassertion                                   | twcR             | $9.5 	imes T_C - 4.2$     | 75.0  | —    | ns   |
| 182 | WR assertion pulse width  | t <sub>WP</sub>  | $15.5 	imes T_{C} - 4.5$  | 124.7 | —    | ns   |
| 183 | WR assertion to RAS deassertion                                   | t <sub>RWL</sub> | $15.75 	imes T_{C} - 4.3$ | 126.9 | —    | ns   |

# Table 3-16 DRAM Out-of-Page and Refresh Timings, Fifteen Wait States<sup>1, 2</sup>

|     | _   | -                |                          | -     | -     |      |
|-----|---|------------------|--------------------------|-------|-------|------|
| No. | Characteristics <sup>3</sup>                  | Symbol           | Expression               | Min   | Max   | Unit |
| 184 | WR assertion to CAS deassertion               | t <sub>CWL</sub> | $14.25\times T_C-4.3$    | 114.4 | _     | ns   |
| 185 | Data valid to CAS assertion (write)           | t <sub>DS</sub>  | $8.75 	imes T_{C} - 4.0$ | 68.9  | _     | ns   |
| 186 | CAS assertion to data not valid (write)       | t <sub>DH</sub>  | $6.25 	imes T_{C} - 4.0$ | 48.1  | _     | ns   |
| 187 | RAS assertion to data not valid (write)       | t <sub>DHR</sub> | $9.75 	imes T_{C} - 4.0$ | 77.2  | _     | ns   |
| 188 | WR assertion to CAS assertion                 | twcs             | $9.5 	imes T_C - 4.3$    | 74.9  | _     | ns   |
| 189 | CAS assertion to RAS assertion (refresh)      | t <sub>CSR</sub> | $1.5 	imes T_C - 4.0$    | 8.5   | _     | ns   |
| 190 | RAS deassertion to CAS assertion (refresh)    | t <sub>RPC</sub> | $4.75 	imes T_C - 4.0$   | 35.6  | _     | ns   |
| 191 | RD assertion to RAS deassertion               | t <sub>ROH</sub> | $15.5 	imes T_{C} - 4.0$ | 125.2 | _     | ns   |
| 192 | RD assertion to data valid                    | t <sub>GA</sub>  | $14 	imes T_C - 5.7$     | _     | 111.0 | ns   |
| 193 | RD deassertion to data not valid <sup>3</sup> | t <sub>GZ</sub>  |                          | 0.0   | _     | ns   |
| 194 | WR assertion to data active                   |                  | $0.75 	imes T_C - 0.3$   | 5.9   | _     | ns   |
| 195 | WR deassertion to data high impedance         |                  | $0.25 	imes T_{C}$       | _     | 2.1   | ns   |

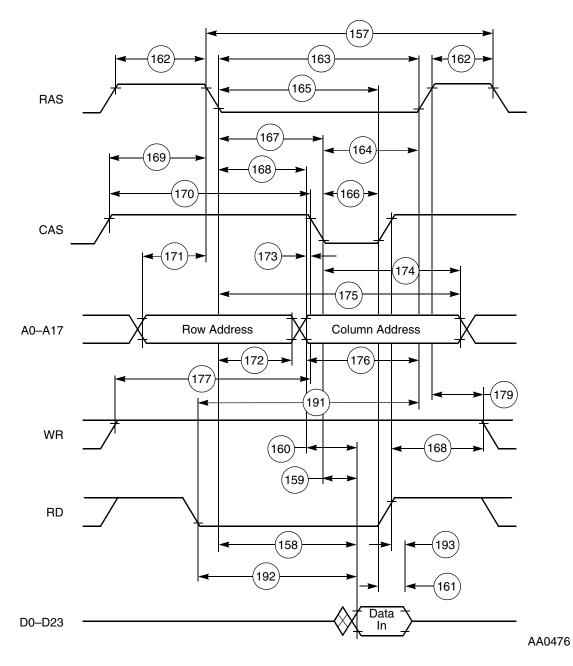
#### Table 3-16 DRAM Out-of-Page and Refresh Timings, Fifteen Wait States<sup>1, 2</sup> (continued)

<sup>1</sup> The number of wait states for out-of-page access is specified in the DCR.

 $^2$  The refresh period is specified in the DCR.

<sup>3</sup> RD deassertion will always occur after CAS deassertion; therefore, the restricted timing is t<sub>OFF</sub> and not t<sub>GZ</sub>.

<sup>4</sup> Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for read cycles.





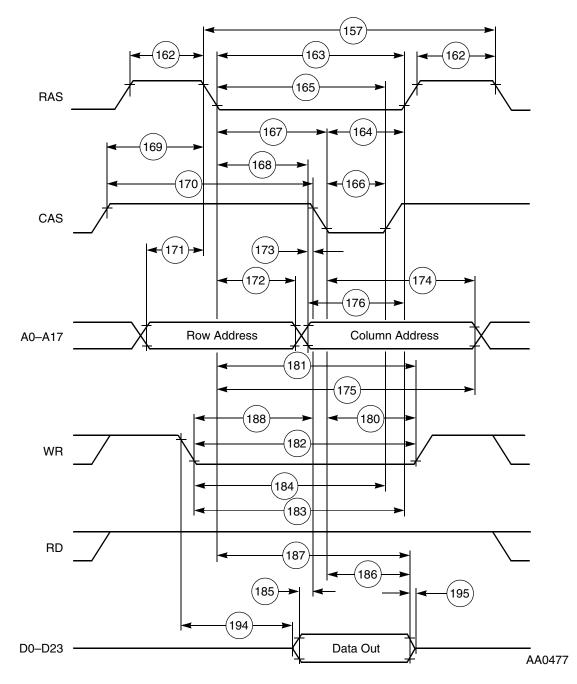
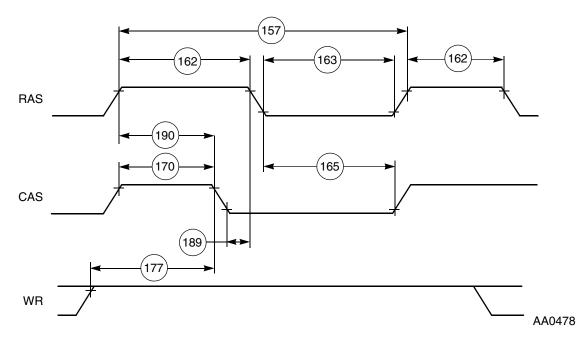


Figure 3-16 DRAM Out-of-Page Write Access





## 3.10.3 Arbitration Timings

| Table 3-17 | Asynchronous | <b>Bus Arbitration timing</b> |
|------------|--------------|-------------------------------|
|------------|--------------|-------------------------------|

| No.  | Characteristics   | Expression   | 120  | Unit |      |
|--|---|--------------|------|------|------|
| NO.  | Characteristics   | Expression   | Min  | Max  | Onit |
| 250  | $\overline{BB}$ assertion window from $\overline{BG}$ input negation. | 2 .5* Tc + 5 | _    | 25.8 | ns   |
| 251  | Delay from $\overline{BB}$ assertion to $\overline{BG}$ assertion     | 2 * Tc + 5   | 21.7 | _    | ns   |
| Notes:<br>1. Bit 13 in the OMR register must be set to enter Asynchronous Arbitration mode |   |              |      |      |      |

2. If Asynchronous Arbitration mode is active, none of the timings in Table 3-17 is required.

3. In order to guarantee timings 250, and 251, it is recommended to assert  $\overline{BG}$  inputs to different 56300 devices (on the same bus) in a non overlap manner as shown in Figure 3-18.

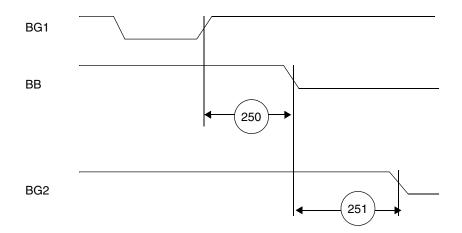


Figure 3-18 Asynchronous Bus Arbitration Timing

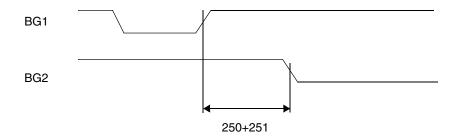


Figure 3-19 Asynchronous Bus Arbitration Timing

Background explanation for Asynchronous Bus Arbitration:

The asynchronous bus arbitration is enabled by internal synchronization circuits on  $\overline{BG}$  and  $\overline{BB}$  inputs. These synchronization circuits add delay from the external signal until it is exposed to internal logic. As a result of this delay, a 56300 part may assume mastership and assert  $\overline{BB}$  for some time after  $\overline{BG}$  is negated. This is the reason for timing 250.

Once  $\overline{BB}$  is asserted, there is a synchronization delay from  $\overline{BB}$  assertion to the time this assertion is exposed to other 56300 components which are potential masters on the same bus. If  $\overline{BG}$  input is asserted before that time, a situation of  $\overline{BG}$  asserted, and  $\overline{BB}$  negated, may cause another 56300 component to assume mastership at the same time. Therefore some non-overlap period between one  $\overline{BG}$  input active to another  $\overline{BG}$  input active is required. Timing 251 ensures that such a situation is avoided.

# 3.11 Parallel Host Interface (HDI08) Timing

| No. | Characteristics <sup>3</sup>   | Expression                 | 120  | MHz  | Unit |
|-----|--|----------------------------|------|------|------|
| NO. | Characteristics  | Expression                 | Min  | Max  | Unit |
| 317 | Read data strobe assertion width <sup>4</sup><br>HACK read assertion width   | T <sub>C</sub> + 9.9       | 18.3 | _    | ns   |
| 318 | Read data strobe deassertion width <sup>4</sup><br>HACK read deassertion width   | _                          | 9.9  |      | ns   |
| 319 | Read data strobe deassertion width <sup>4</sup> after "Last Data Register" reads <sup>5,6</sup> , or between two consecutive CVR, ICR, or ISR reads <sup>7</sup><br>HACK deassertion width after "Last Data Register" reads <sup>5,6</sup> | 2.5 × T <sub>C</sub> + 6.6 | 27.4 | _    | ns   |
| 320 | Write data strobe assertion width <sup>8</sup><br>HACK write assertion width   |                            | 13.2 | _    | ns   |
| 321 | Write data strobe deassertion width <sup>8</sup><br>HACK write deassertion width<br>• after ICR, CVR and "Last Data Register" writes <sup>5</sup>  | 2.5 × T <sub>C</sub> + 6.6 | 27.4 |      | ns   |
|     | <ul> <li>after IVR writes, or</li> <li>after TXH:TXM writes (with HBE=0), or</li> <li>after TXL:TXM writes (with HBE=1)</li> </ul>   |                            | 16.5 | _    |      |
| 322 | HAS assertion width  | —                          | 9.9  | —    | ns   |
| 323 | HAS deassertion to data strobe assertion <sup>9</sup>  | _                          | 0.0  | _    | ns   |
| 324 | Host data input setup time before write data strobe deassertion <sup>8</sup><br>Host data input setup time before HACK write deassertion   | _                          | 9.9  | _    | ns   |
| 325 | Host data input hold time after write data strobe deassertion <sup>8</sup><br>Host data input hold time after $\overline{\text{HACK}}$ write deassertion   | _                          | 3.3  | _    | ns   |
| 326 | Read data strobe assertion to output data active from high impedance <sup>4</sup> $\overline{\text{HACK}}$ read assertion to output data active from high impedance  | _                          | 3.3  | _    | ns   |
| 327 | Read data strobe assertion to output data valid <sup>4</sup><br>HACK read assertion to output data valid   | _                          | _    | 24.2 | ns   |
| 328 | Read data strobe deassertion to output data high impedance <sup>4</sup><br>HACK read deassertion to output data high impedance   | _                          | —    | 9.9  | ns   |
| 329 | Output data hold time after read data strobe deassertion <sup>4</sup><br>Output data hold time after HACK read deassertion   | —                          | 3.3  | —    | ns   |
| 330 | HCS assertion to read data strobe deassertion <sup>4</sup>   | T <sub>C</sub> +9.9        | 18.2 | —    | ns   |
| 331 | HCS assertion to write data strobe deassertion <sup>8</sup>  | —                          | 9.9  | —    | ns   |
| 332 | HCS assertion to output data valid   | _                          |      | 19.1 | ns   |

Table 3-18 Host Interface (HDI08) Timing<sup>1, 2</sup>

| Characteristics <sup>3</sup>  | Everagian   | 120  | MHz   | Unit  |
|---|---|--|---|---|
| Characteristics   | Expression  | Min  | Max   | Unit  |
| HCS hold time after data strobe deassertion <sup>9</sup>  | —   | 0.0  | _   | ns  |
| Address (AD7–AD0) setup time before HAS deassertion (HMUX=1)  | —   | 4.7  | _   | ns  |
| Address (AD7–AD0) hold time after HAS deassertion (HMUX=1)  | _   | 3.3  |   | ns  |
| A10–A8 (HMUX=1), A2–A0 (HMUX=0), HR/W setup time before data strobe assertion <sup>9</sup>  | _   | 0  | _   | ns  |
| • Read  |   |  |   |   |
| • Write   |   | 4.7  | —   |   |
| A10–A8 (HMUX=1), A2–A0 (HMUX=0), HR/ $\overline{W}$ hold time after data strobe deassertion <sup>9</sup>  |   | 3.3  | —   | ns  |
| Delay from read data strobe deassertion to host request assertion for "Last Data Register" read <sup>4, 5, 10</sup>   | т <sub>с</sub>  | 8.3  | _   | ns  |
| Delay from write data strobe deassertion to host request assertion for "Last Data Register" write <sup>5, 8, 10</sup>   | $2 \times T_{C}$  | 16.7                                       | _   | ns  |
| Delay from data strobe assertion to host request deassertion for "Last Data Register" read or write $(HROD = 0)^{5, 9, 10}$                                     | _   | _  | 19.1  | ns  |
| Delay from data strobe assertion to host request deassertion for "Last Data Register" read or write (HROD = 1, open drain Host Request) <sup>5, 9, 10, 11</sup> | _   | —  | 300.0   | ns  |
| Delay from DMA HACK deassertion to HOREQ assertion  |   |  |   | ns  |
| <ul> <li>For "Last Data Register" read<sup>5</sup></li> </ul>   | 2 × T <sub>C</sub> + 19.1   | 35.8                                       | _   |   |
| <ul> <li>For "Last Data Register" write<sup>5</sup></li> </ul>  | 1.5 × T <sub>C</sub> + 19.1   | 31.6                                       | —   |   |
| For other cases   |   | 0.0  | —   |   |
| Delay from DMA $\overline{\text{HACK}}$ assertion to HOREQ deassertion<br>• HROD = 0 <sup>5</sup>   | _   | —  | 20.2  | ns  |
| Delay from DMA HACK assertion to HOREQ deassertion for "Last Data<br>Register" read or write  | _   | _  | 300.0   | ns  |
|   | Address (AD7–AD0) setup time before $\overline{HAS}$ deassertion (HMUX=1)<br>Address (AD7–AD0) hold time after $\overline{HAS}$ deassertion (HMUX=1)<br>A10–A8 (HMUX=1), A2–A0 (HMUX=0), HR/ $\overline{W}$ setup time before data<br>strobe assertion <sup>9</sup><br>• Read<br>• Write<br>A10–A8 (HMUX=1), A2–A0 (HMUX=0), HR/ $\overline{W}$ hold time after data strobe<br>deassertion <sup>9</sup><br>Delay from read data strobe deassertion to host request assertion for "Last<br>Data Register" read <sup>4, 5, 10</sup><br>Delay from write data strobe deassertion to host request assertion for "Last<br>Data Register" write <sup>5, 8, 10</sup><br>Delay from data strobe assertion to host request deassertion for "Last Data<br>Register" read or write (HROD = 0) <sup>5, 9, 10</sup><br>Delay from data strobe assertion to host request deassertion for "Last Data<br>Register" read or write (HROD = 1, open drain Host Request) <sup>5, 9, 10, 11</sup><br>Delay from DMA HACK deassertion to HOREQ assertion<br>• For "Last Data Register" read <sup>5</sup><br>• For other cases<br>Delay from DMA HACK assertion to HOREQ deassertion<br>• HROD = 0 <sup>5</sup><br>Delay from DMA HACK assertion to HOREQ deassertion for "Last Data | HCShold time after data strobe deassertion | $\begin{tabular}{ c c c c c } \hline Characteristics^3 & Expression $$ \hline Min$ $$ \hline HCS$ hold time after data strobe deassertion $$ $$ $$ $$ $$ $$ $$ \hline MUX=1$$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $ | MinMaxHCShold time after data strobe deassertion $\Theta$ 0.0 $-$ Address (AD7-AD0) setup time before HAS deassertion (HMUX=1) $-$ 4.7 $-$ Address (AD7-AD0) hold time after HAS deassertion (HMUX=1) $-$ 3.3 $-$ A10-A8 (HMUX=1), A2-A0 (HMUX=0), HR/ $\overline{W}$ setup time before data $ 0$ $-$ strobe assertion <sup>9</sup> $\cdot$ Read $ 0$ $-$ Write $4.7$ $   10^{-}$ A10-A8 (HMUX=1), A2-A0 (HMUX=0), HR/ $\overline{W}$ hold time after data strobe $ 3.3$ $ \bullet$ Write $4.7$ $  3.3$ $ A10-A8$ (HMUX=1), A2-A0 (HMUX=0), HR/ $\overline{W}$ hold time after data strobe $ 3.3$ $ \bullet$ Write $4.7$ $  3.3$ $ \bullet$ Nead $ 5.10^{-}$ $5.3^{-}$ $ 3.3^{-}$ Delay from read data strobe deassertion to host request assertion for "Last Data $  16.7$ Delay from write data strobe deassertion to host request deassertion for "Last Data $  19.1$ Delay from data strobe assertion to host request deassertion for "Last Data $  300.0$ Register" read or write (HROD = 1, open drain Host Request) <sup>5, 9, 10, 11</sup> $  30.0$ Delay from DMA HACK deassertion to HOREQ assertion $  2.\times T_{C} + 19.1$ $31.6$ $   0.0$ $  20.2$ HROD = $0^{5}$ $ -$ <t< td=""></t<> |

| Table 3-18 | Host Interface | (HDI08) | Timing <sup>1, 2</sup> | (continued) |
|------------|----------------|---------|------------------------|-------------|
|------------|----------------|---------|------------------------|-------------|

<sup>1</sup> See Host Port Usage Considerations in the DSP56366 User's Manual.

<sup>2</sup> In the timing diagrams below, the controls pins are drawn as active low. The pin polarity is programmable.

<sup>3</sup> V<sub>CC</sub> = 3.3 V  $\pm$  0.16 V; T<sub>J</sub> = -40°C to +110°C, C<sub>L</sub> = 50 pF

<sup>4</sup> The read data strobe is HRD in the dual data strobe mode and HDS in the single data strobe mode.

<sup>5</sup> The "last data register" is the register at address \$7, which is the last location to be read or written in data transfers.

<sup>6</sup> This timing is applicable only if a read from the "last data register" is followed by a read from the RXL, RXM, or RXH registers without first polling RXDF or HREQ bits, or waiting for the assertion of the HOREQ signal.

<sup>7</sup> This timing is applicable only if two consecutive reads from one of these registers are executed.

<sup>8</sup> The write data strobe is HWR in the dual data strobe mode and HDS in the single data strobe mode.

<sup>9</sup> The data strobe is host read (HRD) or host write (HWR) in the dual data strobe mode and host data strobe (HDS) in the single data strobe mode.

<sup>10</sup> The host request is HOREQ in the single host request mode and HRRQ and HTRQ in the double host request mode.

<sup>11</sup> In this calculation, the host request signal is pulled up by a 4.7 k $\Omega$  resistor in the open-drain mode.

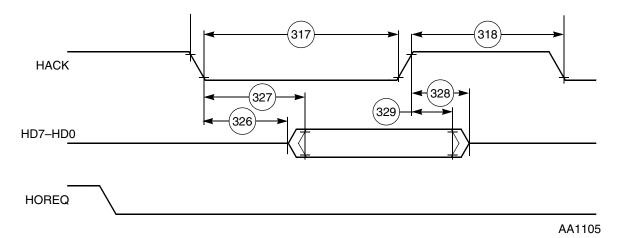


Figure 3-20 Host Interrupt Vector Register (IVR) Read Timing Diagram

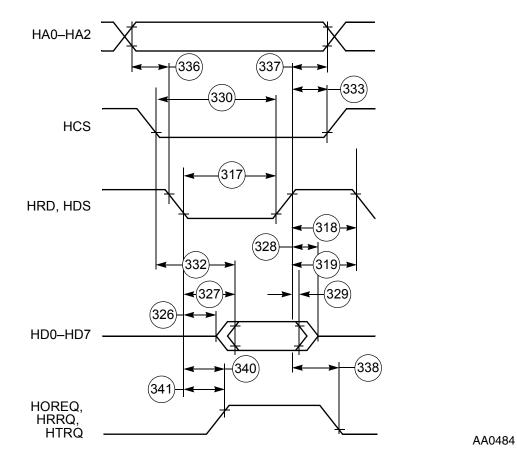


Figure 3-21 Read Timing Diagram, Non-Multiplexed Bus

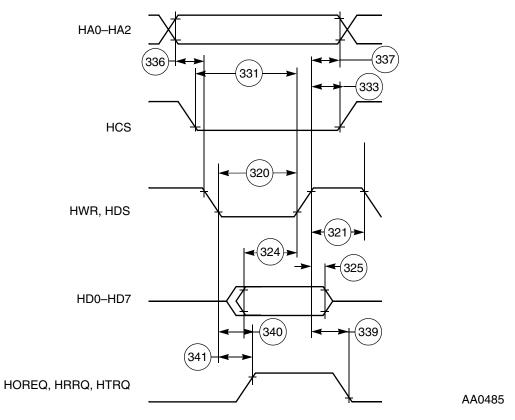


Figure 3-22 Write Timing Diagram, Non-Multiplexed Bus

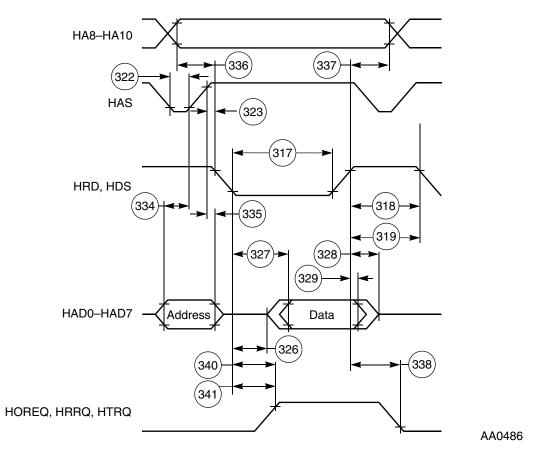


Figure 3-23 Read Timing Diagram, Multiplexed Bus

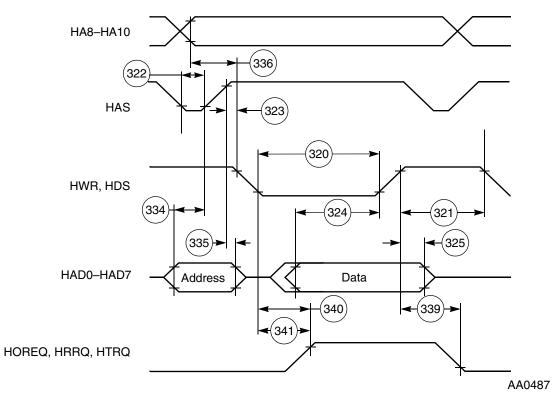


Figure 3-24 Write Timing Diagram, Multiplexed Bus

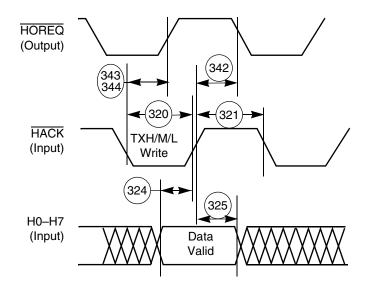


Figure 3-25 Host DMA Write Timing Diagram

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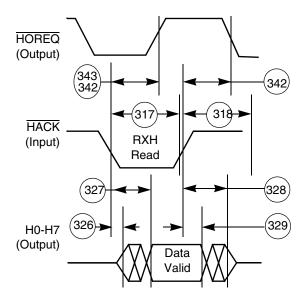


Figure 3-26 Host DMA Read Timing Diagram

# 3.12 Serial Host Interface SPI Protocol Timing

| Table 3-19 | Serial Host Interface SPI Protocol Timing |
|------------|---|
|------------|---|

| No. | Characteristics <sup>1</sup>                          | Mode   | Filter<br>Mode | Expression                 | Min   | Max | Unit |
|-----|---|--------|----------------|----------------------------|-------|-----|------|
| 140 | Tolerable spike width on clock or data in             | _      | Bypassed       | —                          | _     | 0   | ns   |
|     |   |        | Narrow         | —                          | —     | 50  | ns   |
|     |   |        | Wide           | —                          | —     | 100 | ns   |
| 141 | Minimum serial clock cycle = t <sub>SPICC</sub> (min) | Master | Bypassed       | 6×T <sub>C</sub> +46       | 96    |     | ns   |
|     |   |        | Narrow         | 6×T <sub>C</sub> +152      | 202   | —   | ns   |
|     |   |        | Wide           | 6×T <sub>C</sub> +223      | 273   | —   | ns   |
| 142 | Serial clock high period                              | Master | Bypassed       | 0.5×t <sub>SPICC</sub> –10 | 38    | _   | ns   |
|     |   |        | Narrow         | 0.5×t <sub>SPICC</sub> –10 | 91    | —   | ns   |
|     |   |        | Wide           | 0.5×t <sub>SPICC</sub> −10 | 126.5 | _   | ns   |
|     |   | Slave  | Bypassed       | 2.5×T <sub>C</sub> +12     | 32.8  | _   | ns   |
|     |   |        | Narrow         | 2.5×T <sub>C</sub> +102    | 122.8 | —   | ns   |
|     |   |        | Wide           | 2.5×T <sub>C</sub> +189    | 209.8 |     | ns   |

|     | _   |              | Filter   |                              |       |      |      |
|-----|---|--------------|----------|------------------------------|-------|------|------|
| No. | Characteristics <sup>1</sup>                          | Mode         | Mode     | Expression                   | Min   | Мах  | Unit |
| 143 | Serial clock low period                               | Master       | Bypassed | 0.5×t <sub>SPICC</sub> –10   | 38    | —    | ns   |
|     |   |              | Narrow   | 0.5×t <sub>SPICC</sub> –10   | 91    | —    | ns   |
|     |   |              | Wide     | 0.5×t <sub>SPICC</sub> –10   | 126.5 | —    | ns   |
|     |   | Slave        | Bypassed | 2.5×T <sub>C</sub> +12       | 32.8  | _    | ns   |
|     |   |              | Narrow   | 2.5×T <sub>C</sub> +102      | 122.8 | —    | ns   |
|     |   |              | Wide     | 2.5×T <sub>C</sub> +189      | 209.8 | —    | ns   |
| 144 | Serial clock rise/fall time                           | Master       | —        | _                            | _     | 10   | ns   |
|     |   | Slave        | —        | —                            | —     | 2000 | ns   |
| 146 | SS assertion to first SCK edge<br>CPHA = 0            | Slave        | Bypassed | 3.5×T <sub>C</sub> +15       | 44.2  | _    | ns   |
|     |   |              | Narrow   | 0                            | 0     | —    | ns   |
|     |   |              | Wide     | 0                            | 0     | —    | ns   |
|     |   |              |          |                              |       |      |      |
|     | CPHA = 1  | Slave        | Bypassed | 10                           | 10    | _    | ns   |
|     |   |              | Narrow   | 0                            | 0     | —    | ns   |
|     |   |              | Wide     | 0                            | 0     | —    | ns   |
| 147 | Last SCK edge to SS not asserted                      | Slave        | Bypassed | 12                           | 12    | _    | ns   |
|     |   |              | Narrow   | 102                          | 102   | —    | ns   |
|     |   |              | Wide     | 189                          | 189   | —    | ns   |
| 148 | Data input valid to SCK edge (data input set-up time) | Master/Slave | Bypassed | 0                            | 0     | _    | ns   |
|     |   |              | Narrow   | MAX{(20-T <sub>C</sub> ), 0} | 11.7  | —    | ns   |
|     |   |              | Wide     | MAX{(40-T <sub>C</sub> ), 0} | 31.7  | —    | ns   |
| 149 | SCK last sampling edge to data input not valid        | Master/Slave | Bypassed | 2.5×T <sub>C</sub> +10       | 30.8  | _    | ns   |
|     |   |              | Narrow   | 2.5×T <sub>C</sub> +30       | 50.8  | —    | ns   |
|     |   |              | Wide     | 2.5×T <sub>C</sub> +50       | 70.8  | _    | ns   |
| 150 | SS assertion to data out active                       | Slave        | _        | 2                            | 2     | _    | ns   |
| 151 | SS deassertion to data high impedance <sup>2</sup>    | Slave        | _        | 9                            | _     | 9    | ns   |

#### Table 3-19 Serial Host Interface SPI Protocol Timing (continued)

| No. | Characteristics <sup>1</sup>   | Mode         | Filter<br>Mode | Expression  | Min   | Max   | Unit |
|-----|--|--------------|----------------|---|-------|-------|------|
| 152 | SCK edge to data out valid<br>(data out delay time)                                  | Master/Slave | Bypassed       | 2×T <sub>C</sub> +33                                | _     | 49.7  | ns   |
|     |  |              | Narrow         | 2×T <sub>C</sub> +123                               | —     | 139.7 | ns   |
|     |  |              | Wide           | 2×T <sub>C</sub> +210                               | —     | 226.7 | ns   |
| 153 | SCK edge to data out not valid<br>(data out hold time)                               | Master/Slave | Bypassed       | T <sub>C</sub> +5                                   | 13.3  | —     | ns   |
|     |  |              | Narrow         | T <sub>C</sub> +55                                  | 63.3  | —     | ns   |
|     |  |              | Wide           | T <sub>C</sub> +106                                 | 114.3 | —     | ns   |
| 154 | $\overline{SS}$ assertion to data out valid<br>(CPHA = 0)                            | Slave        | —              | T <sub>C</sub> +33                                  |       | 41.3  | ns   |
| 157 | First SCK sampling edge to HREQ output deassertion                                   | Slave        | Bypassed       | 2.5×T <sub>C</sub> +30                              | _     | 50.8  | ns   |
|     |  |              | Narrow         | 2.5×T <sub>C</sub> +120                             | —     | 140.8 | ns   |
|     |  |              | Wide           | 2.5×T <sub>C</sub> +217                             | —     | 237.8 | ns   |
| 158 | Last SCK sampling edge to HREQ output<br>not deasserted (CPHA = 1)                   | Slave        | Bypassed       | 2.5×T <sub>C</sub> +30                              | 50.8  |       | ns   |
|     |  |              | Narrow         | 2.5×T <sub>C</sub> +80                              | 100.8 | —     | ns   |
|     |  |              | Wide           | 2.5×T <sub>C</sub> +136                             | 156.8 | —     | ns   |
| 159 | $\overline{SS}$ deassertion to $\overline{HREQ}$ output not deasserted (CPHA = 0)    | Slave        | _              | 2.5×T <sub>C</sub> +30                              | 50.8  | _     | ns   |
| 160 | $\overline{SS}$ deassertion pulse width (CPHA = 0)                                   | Slave        | —              | T <sub>C</sub> +6                                   | 14.3  | _     | ns   |
| 161 | HREQ in assertion to first SCK edge  | Master       | Bypassed       | $0.5 \times t_{SPICC} + 2.5 \times T_{C} + 43$      | 111.8 | _     | ns   |
|     |  |              | Narrow         | 0.5 ×t <sub>SPICC</sub> +<br>2.5×T <sub>C</sub> +43 | 164.8 | _     | ns   |
|     |  |              | Wide           | 0.5 ×t <sub>SPICC</sub> +<br>2.5×T <sub>C</sub> +43 | 200.3 | _     | ns   |
| 162 | HREQ in deassertion to last SCK<br>sampling edge (HREQ in set-up time)<br>(CPHA = 1) | Master       | —              | 0   | 0     |       | ns   |
| 163 | First SCK edge to HREQ in not asserted (HREQ in hold time)                           | Master       | —              | 0   | 0     | —     | ns   |

 $^{1}$  V<sub>CC</sub> = 3.16 V ± 0.16 V; T<sub>J</sub> = -40°C to +110°C, C<sub>L</sub> = 50 pF  $^{2}$  Periodically sampled, not 100% tested

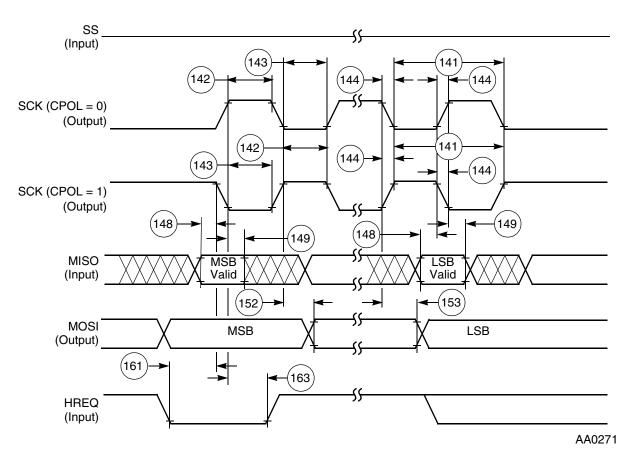


Figure 3-27 SPI Master Timing (CPHA = 0)

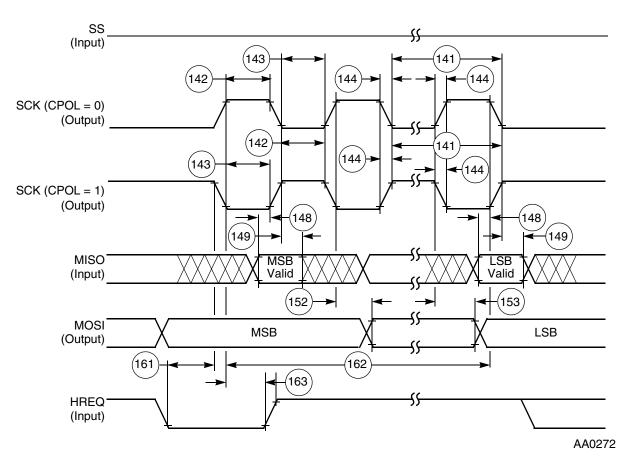


Figure 3-28 SPI Master Timing (CPHA = 1)

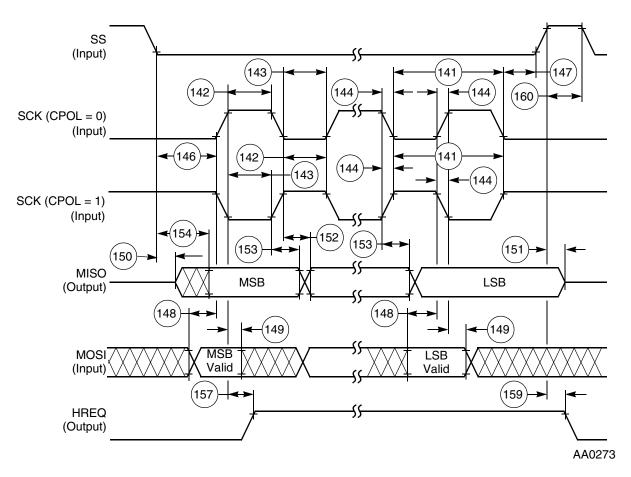


Figure 3-29 SPI Slave Timing (CPHA = 0)

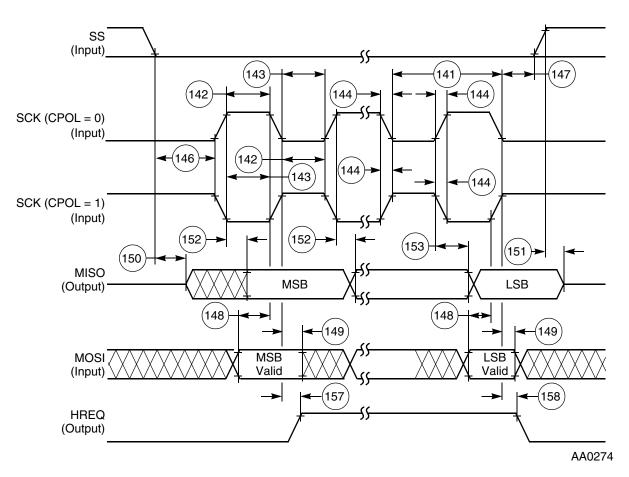


Figure 3-30 SPI Slave Timing (CPHA = 1)

# 3.13 Serial Host Interface (SHI) I<sup>2</sup>C Protocol Timing

| Table 3-20 | SHI I <sup>2</sup> C Protocol Timing |
|------------|--------------------------------------|
|------------|--------------------------------------|

| No. | Characteristics <sup>1,2,3</sup>                              | Symbol/             |      | dard<br>de <sup>4</sup> | Fast Mode <sup>5</sup> |     | Unit |
|-----|---|---------------------|------|-------------------------|------------------------|-----|------|
|     |   | Expression          | Min  | Max                     | Min                    | Мах |      |
|     | Tolerable spike width on SCL or SDA                           |                     |      |                         |                        |     |      |
|     | Filters bypassed  | _                   | —    | 0                       | —                      | 0   | ns   |
|     | Narrow filters enabled  |                     | —    | 50                      | —                      | 50  | ns   |
|     | Wide filters enabled  |                     | —    | 100                     | —                      | 100 | ns   |
| 171 | SCL clock frequency   | F <sub>SCL</sub>    | _    | 100                     | —                      | 400 | kHz  |
| 171 | SCL clock cycle   | T <sub>SCL</sub>    | 10   | _                       | 2.5                    | —   | μs   |
| 172 | Bus free time   | T <sub>BUF</sub>    | 4.7  | _                       | 1.3                    | —   | μs   |
| 173 | Start condition set-up time                                   | T <sub>SU;STA</sub> | 4.7  | _                       | 0.6                    | —   | μs   |
| 174 | Start condition hold time                                     | T <sub>HD;STA</sub> | 4.0  | _                       | 0.6                    | —   | μs   |
| 175 | SCL low period  | T <sub>LOW</sub>    | 4.7  | _                       | 1.3                    | —   | μs   |
| 176 | SCL high period   | T <sub>HIGH</sub>   | 4.0  | _                       | 1.3                    | —   | μs   |
| 177 | SCL and SDA rise time   | т <sub>R</sub>      | _    | 1000                    | $20 + 0.1 \times C_b$  | 300 | ns   |
| 178 | SCL and SDA fall time   | Т <sub>F</sub>      | _    | 300                     | $20 + 0.1 \times C_b$  | 300 | ns   |
| 179 | Data set-up time  | T <sub>SU;DAT</sub> | 250  | —                       | 100                    | —   | ns   |
| 180 | Data hold time  | T <sub>HD;DAT</sub> | 0.0  | _                       | 0.0                    | 0.9 | μs   |
| 181 | DSP clock frequency   | F <sub>DSP</sub>    |      |                         |                        |     | MHz  |
|     | Filters bypassed  |                     | 10.6 | —                       | 28.5                   | —   |      |
|     | Narrow filters enabled  |                     | 11.8 | _                       | 39.7                   | —   |      |
|     | Wide filters enabled  |                     | 13.1 | _                       | 61.0                   | —   |      |
| 182 | SCL low to data out valid                                     | T <sub>VD;DAT</sub> | —    | 3.4                     | _                      | 0.9 | μs   |
| 183 | Stop condition set-up time                                    | T <sub>SU;STO</sub> | 4.0  | _                       | 0.6                    | —   | μS   |
| 184 | HREQ in deassertion to last SCL edge<br>(HREQ in set-up time) | <sup>t</sup> su;rqi | 0.0  | —                       | 0.0                    | —   | ns   |

| No. | Characteristics <sup>1,2,3</sup>                           | Symbol/<br>Expression  |       | dard<br>de <sup>4</sup> | Fast Mode <sup>5</sup> |       | Unit |
|-----|--|--|-------|-------------------------|------------------------|-------|------|
|     |  | Lypiession   | Min   | Max                     | Min                    | Мах   |      |
| 186 | First SCL sampling edge to HREQ output deassertion         | T <sub>NG;RQO</sub>  |       |                         |                        |       | ns   |
|     | Filters bypassed   | 2 × T <sub>C</sub> + 30  | —     | 46.7                    | —                      | 46.7  |      |
|     | Narrow filters enabled                                     | 2 × T <sub>C</sub> + 120   | —     | 136.7                   | —                      | 136.7 |      |
|     | Wide filters enabled                                       | $2 	imes T_{C}$ + 208  | —     | 224.7                   | —                      | 224.7 |      |
| 187 | Last SCL edge to HREQ output not deasserted                | T <sub>AS;RQO</sub>  |       |                         |                        |       | ns   |
|     | Filters bypassed   | 2 × T <sub>C</sub> + 30  | 46.7  | —                       | 46.7                   | —     |      |
|     | Narrow filters enabled                                     | 2 × T <sub>C</sub> + 80  | 96.7  | _                       | 96.7                   | —     |      |
|     | Wide filters enabled                                       | 2 × T <sub>C</sub> + 135   | 151.6 | _                       | 151.6                  | —     |      |
| 188 | HREQ in assertion to first SCL edge                        | T <sub>AS;RQI</sub>  |       |                         |                        |       | ns   |
|     | Filters bypassed   | 0.5 × T <sub>I</sub> 2 <sub>CCP</sub> -<br>0.5 × T <sub>C</sub> - 21 | 4440  | —                       | 1041                   | —     |      |
|     | Narrow filters enabled                                     |  | 4373  | _                       | 999                    | —     |      |
|     | Wide filters enabled                                       |  | 4373  | _                       | 958                    | —     |      |
| 189 | First SCL edge to HREQ in not asserted (HREQ in hold time) | <sup>t</sup> HO;RQI  | 0.0   | —                       | 0.0                    | —     | ns   |

### Table 3-20 SHI I<sup>2</sup>C Protocol Timing (continued)

 $\begin{array}{c} 1 \\ V_{CC} = 3.16 \text{ V} \pm 0.16 \text{ V}; \text{ } \text{T}_{\text{J}} = -40^{\circ}\text{C} \text{ to } +110^{\circ}\text{C} \\ \hline 2 \\ \text{Pull-up resistor: } \text{R}_{\text{P}} \text{ (min)} = 1.5 \text{ kOhm} \\ \hline 3 \\ \text{ Capacitive load: } \text{C}_{\text{b}} \text{ (max)} = 400 \text{ pF} \\ \hline 4 \\ \text{ It is recommended to enable the wide filters when operating in the I}^{2}\text{C} \text{ Standard Mode.} \\ \hline 5 \\ \text{ It is recommended to enable the narrow filters when operating in the I}^{2}\text{C} \text{ Fast Mode.} \\ \end{array}$ 

### 3.13.1 Programming the Serial Clock

The programmed serial clock cycle,  $T_{I^2CCP}$ , is specified by the value of the HDM[7:0] and HRS bits of the HCKR (SHI clock control register).

The expression for  $T_{I^2CCP}$  is

$$T_{I^{2}CCP} = [T_{C} \times 2 \times (HDM[7:0] + 1) \times (7 \times (1 - HRS) + 1)]$$

where

HRS is the prescaler rate select bit. When HRS is cleared, the fixed divide-by-eight prescaler is operational. When HRS is set, the prescaler is bypassed.

HDM[7:0] are the divider modulus select bits. A divide ratio from 1 to 256 (HDM[7:0] = \$00 to \$FF) may be selected.

In I<sup>2</sup>C mode, the user may select a value for the programmed serial clock cycle from

 $6 \times T_C$  if HDM[7:0] = \$02 and HRS = 1

to

$$4096 \times T_{C}$$
 if HDM[7:0] = \$FF and HRS = 0

The programmed serial clock cycle ( $T_{I^2CCP}$ ), SCL rise time ( $T_R$ ), and the filters selected should be chosen in order to achieve the desired SCL serial clock cycle ( $T_{SCL}$ ), as shown in Table 3-21.

 Table 3-21
 SCL Serial Clock Cycle (T<sub>SCL</sub>) generated as Master

| Filters bypassed       | $T_{l^2CCP}$ + 2.5 × $T_C$ + 45ns + $T_R$   |
|------------------------|---|
| Narrow filters enabled | $T_{I^2CCP}$ + 2.5 × $T_C$ + 135ns + $T_R$  |
| Wide filters enabled   | $T_{I^2CCP} + 2.5 \times T_C + 223ns + T_R$ |

### EXAMPLE:

For DSP clock frequency of 120 MHz (i.e.  $T_C = 8.33$ ns), operating in a standard mode I<sup>2</sup>C environment ( $F_{SCL} = 100$  kHz (i.e.  $T_{SCL} = 10\mu$ s),  $T_R = 1000$ ns), with wide filters enabled:

$$T_{I^2CCP} = 10\mu s - 2.5 \times 8.33 ns - 223 ns - 1000 ns = 8756 ns$$

Choosing HRS = 0 gives

HDM[7:0] = 8756 ns/ $(2 \times 8.33$  ns  $\times 8) - 1 = 64.67$ 

Thus the HDM[7:0] value should be programmed to \$41 (=65).

The resulting  $T_{I^2CCP}$  will be:

$$T_{I^{2}CCP} = [T_{C} \times 2 \times (HDM[7:0] + 1) \times (7 \times (1 - HRS) + 1)]$$
$$T_{I^{2}CCP} = [8.33 \text{ ns} \times 2 \times (65 + 1) \times (7 \times (1 - 0) + 1)]$$
$$T_{I^{2}CCP} = [8.33 \text{ ns} \times 2 \times 66 \times 8] = 8796.48 \text{ ns}$$

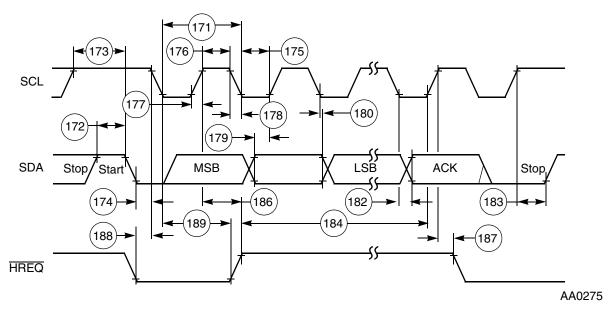


Figure 3-31 I<sup>2</sup>C Timing

## 3.14 Enhanced Serial Audio Interface Timing

Table 3-22 Enhanced Serial Audio Interface Timing

| No. | Characteristics <sup>1, 2, 3</sup>                | Symbol             | Expression                | Min  | Max  | Condition <sup>4</sup> | Unit |
|-----|---|--------------------|---------------------------|------|------|------------------------|------|
| 430 | Clock cycle <sup>5</sup>                          | t <sub>SSICC</sub> | $4 \times T_C$            | 33.3 | _    | i ck                   | ns   |
|     |   |                    | $3 \times T_C$            | 25.0 | —    | x ck                   |      |
|     |   |                    | TXC:max[3*tc; t454]       | 27.2 | —    | x ck                   |      |
| 431 | Clock high period                                 | _                  |                           |      |      |                        | ns   |
|     | For internal clock                                |                    | 2 × T <sub>C</sub> – 10.0 | 6.7  | —    |                        |      |
|     | For external clock                                |                    | $1.5 \times T_{C}$        | 12.5 | —    |                        |      |
| 432 | Clock low period                                  | _                  |                           |      |      |                        | ns   |
|     | For internal clock                                |                    | $2 \times T_{C} - 10.0$   | 6.7  | —    |                        |      |
|     | For external clock                                |                    | 1.5 × T <sub>C</sub>      | 12.5 | —    |                        |      |
| 433 | RXC rising edge to FSR out (bl) high              | _                  | —                         |      | 37.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 22.0 | i ck a                 |      |
| 434 | RXC rising edge to FSR out (bl) low               | _                  | —                         |      | 37.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 22.0 | i ck a                 |      |
| 435 | RXC rising edge to FSR out (wr) high <sup>6</sup> | _                  | —                         | _    | 39.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 24.0 | i ck a                 |      |
| 436 | RXC rising edge to FSR out (wr) low <sup>6</sup>  | _                  | —                         | _    | 39.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 24.0 | i ck a                 |      |
| 437 | RXC rising edge to FSR out (wl) high              | _                  | —                         | _    | 36.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 21.0 | i ck a                 |      |
| 438 | RXC rising edge to FSR out (wl) low               | _                  | —                         | _    | 37.0 | x ck                   | ns   |
|     |   |                    |                           | —    | 22.0 | i ck a                 |      |
| 439 | Data in setup time before RXC (SCK in             | _                  | —                         | 0.0  | _    | x ck                   | ns   |
|     | synchronous mode) falling edge                    |                    |                           | 19.0 | —    | i ck                   |      |
| 440 | Data in hold time after RXC falling edge          | _                  | —                         | 5.0  | —    | x ck                   | ns   |
|     |   |                    |                           | 3.0  | —    | i ck                   |      |
| 441 | FSR input (bl, wr) high before RXC                |                    | _                         | 23.0 | _    | x ck                   | ns   |
|     | falling edge <sup>6</sup>                         |                    |                           | 1.0  | —    | i ck a                 |      |
| 442 | FSR input (wl) high before RXC falling            |                    | _                         | 1.0  | _    | x ck                   | ns   |
|     | edge  |                    |                           | 23.0 | _    | i ck a                 |      |
| 443 | FSR input hold time after RXC falling             |                    | —                         | 3.0  | _    | x ck                   | ns   |
|     | edge  |                    |                           | 0.0  | —    | i ck a                 |      |

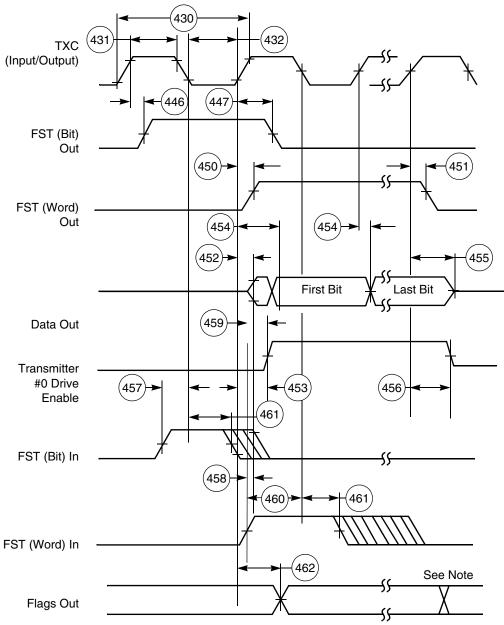
| No. | Characteristics <sup>1, 2, 3</sup>                                      | Symbol | Expression                        | Min         | Max          | Condition <sup>4</sup> | Unit |
|-----|---|--------|-----------------------------------|-------------|--------------|------------------------|------|
| 444 | Flags input setup before RXC falling edge                               | _      | _                                 | 0.0<br>19.0 | _            | x ck<br>i ck s         | ns   |
| 445 | Flags input hold time after RXC falling edge                            | _      |                                   | 6.0<br>0.0  | _            | x ck<br>i ck s         | ns   |
| 446 | TXC rising edge to FST out (bl) high                                    | _      | _                                 |             | 29.0<br>15.0 | x ck<br>i ck           | ns   |
| 447 | TXC rising edge to FST out (bl) low                                     | _      | _                                 | _           | 31.0<br>17.0 | x ck<br>i ck           | ns   |
| 448 | TXC rising edge to FST out (wr) high <sup>6</sup>                       |        | _                                 | _           | 31.0<br>17.0 | x ck<br>i ck           | ns   |
| 449 | TXC rising edge to FST out (wr) low <sup>6</sup>                        | _      | _                                 | _           | 33.0<br>19.0 | x ck<br>i ck           | ns   |
| 450 | TXC rising edge to FST out (wI) high                                    | _      | _                                 |             | 30.0<br>16.0 | x ck<br>i ck           | ns   |
| 451 | TXC rising edge to FST out (wl) low                                     | _      | _                                 | _           | 31.0<br>17.0 | x ck<br>i ck           | ns   |
| 452 | TXC rising edge to data out enable from<br>high impedance               | _      | _                                 | _           | 31.0<br>17.0 | x ck<br>i ck           | ns   |
| 453 | TXC rising edge to transmitter #0 drive enable assertion                | _      | _                                 | _           | 34.0<br>20.0 | x ck<br>i ck           | ns   |
| 454 | TXC rising edge to data out valid                                       | _      | 23 + 0.5 × T <sub>C</sub><br>21.0 | _           | 27.2<br>21.0 | x ck<br>i ck           | ns   |
| 455 | TXC rising edge to data out high impedance <sup>7</sup>                 |        | _                                 | _           | 31.0<br>16.0 | x ck<br>i ck           | ns   |
| 456 | TXC rising edge to transmitter #0 drive enable deassertion <sup>7</sup> |        | _                                 |             | 34.0<br>20.0 | x ck<br>i ck           | ns   |
| 457 | FST input (bl, wr) setup time before TXC falling edge <sup>6</sup>      |        | _                                 | 2.0<br>21.0 | _            | x ck<br>i ck           | ns   |
| 458 | FST input (wl) to data out enable from high impedance                   |        |                                   | _           | 27.0         | _                      | ns   |
| 459 | FST input (wI) to transmitter #0 drive enable assertion                 |        | _                                 | -           | 31.0         | _                      | ns   |

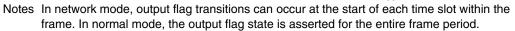
| No. | Characteristics <sup>1, 2, 3</sup>                | Symbol | Expression | Min         | Max          | Condition <sup>4</sup> | Unit |
|-----|---|--------|------------|-------------|--------------|------------------------|------|
| 460 | FST input (wl) setup time before TXC falling edge | _      | —          | 2.0<br>21.0 |              | x ck<br>i ck           | ns   |
| 461 | FST input hold time after TXC falling edge        | —      | _          | 4.0<br>0.0  |              | x ck<br>i ck           | ns   |
| 462 | Flag output valid after TXC rising edge           | —      | —          | _           | 32.0<br>18.0 | x ck<br>i ck           | ns   |
| 463 | HCKR/HCKT clock cycle                             | —      |            | 40.0        |              |                        | ns   |
| 464 | HCKT input rising edge to TXC output              | _      | —          | _           | 27.5         |                        | ns   |
| 465 | HCKR input rising edge to RXC output              | _      | —          |             | 27.5         |                        | ns   |

 Table 3-22
 Enhanced Serial Audio Interface Timing (continued)

<sup>1</sup>  $V_{CC} = 3.16 \text{ V} \pm 0.16 \text{ V}; T_{J} = -40^{\circ}\text{C} \text{ to } +110^{\circ}\text{C}, C_{L} = 50 \text{ pF}$ 

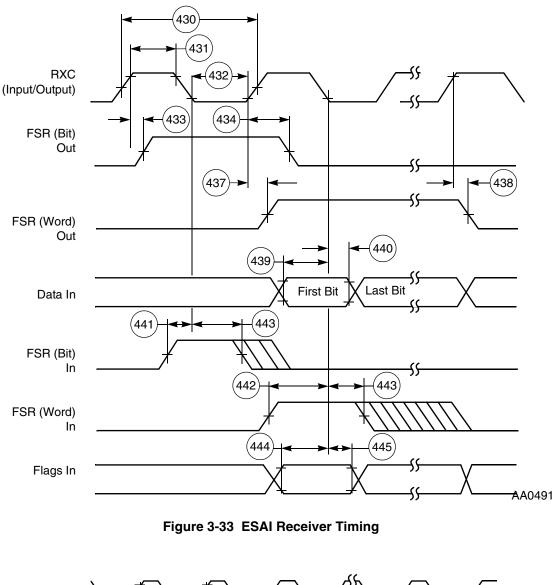
- <sup>2</sup> i ck = internal clock
  - x ck = external clock
  - i ck a = internal clock, asynchronous mode
  - (asynchronous implies that TXC and RXC are two different clocks)
  - i ck s = internal clock, synchronous mode
  - (synchronous implies that TXC and RXC are the same clock)
- <sup>3</sup> bl = bit length
  - wl = word length
  - wr = word length relative
- <sup>4</sup> TXC(SCKT pin) = transmit clock RXC(SCKR pin) = receive clock FST(FST pin) = transmit frame sync FSR(FSR pin) = receive frame sync HCKT(HCKT pin) = transmit high frequency clock HCKR(HCKR pin) = receive high frequency clock
- <sup>5</sup> For the internal clock, the external clock cycle is defined by Icyc and the ESAI control register.
- <sup>6</sup> The word-relative frame sync signal waveform relative to the clock operates in the same manner as the bit-length frame sync signal waveform, but spreads from one serial clock before first bit clock (same as bit length frame sync signal), until the one before last bit clock of the first word in frame.
- <sup>7</sup> Periodically sampled and not 100% tested





AA0490

Figure 3-32 ESAI Transmitter Timing



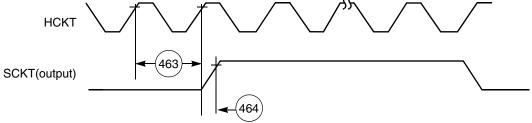


Figure 3-34 ESAI HCKT Timing

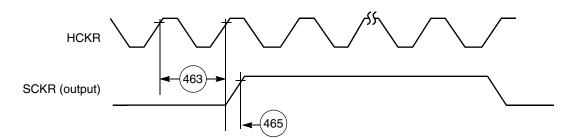
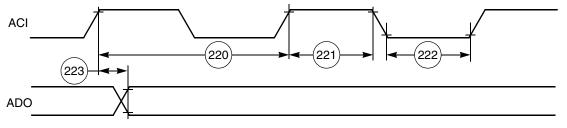


Figure 3-35 ESAI HCKR Timing

### 3.15 Digital Audio Transmitter Timing

Table 3-23 Digital Audio Transmitter Timing

| No. | Characteristic   | Expression                | 120  | Unit |     |  |  |  |  |
|-----|--|---------------------------|------|------|-----|--|--|--|--|
| NO. |  | Expression                | Min  | Мах  | Om  |  |  |  |  |
|     | ACI frequency (see note)   | 1 / (2 x T <sub>C</sub> ) | —    | 60   | MHz |  |  |  |  |
| 220 | ACI period   | $2 \times T_{C}$          | 16.7 | _    | ns  |  |  |  |  |
| 221 | ACI high duration  | $0.5 	imes T_C$           | 4.2  | _    | ns  |  |  |  |  |
| 222 | ACI low duration   | $0.5 	imes T_C$           | 4.2  | _    | ns  |  |  |  |  |
| 223 | ACI rising edge to ADO valid   | 1.5 × T <sub>C</sub>      | —    | 12.5 | ns  |  |  |  |  |
| clo | Note: In order to assure proper operation of the DAX, the ACI frequency should be less than 1/2 of the DSP56366 internal clock frequency. For example, if the DSP56366 is running at 120 MHz internally, the ACI frequency should be less than 60 MHz. |                           |      |      |     |  |  |  |  |



AA1280

Figure 3-36 Digital Audio Transmitter Timing

### **Timer Timing** 3.16

| No.     | Characteristics  | Expression             | 120  | Unit |      |  |  |
|---------|--|------------------------|------|------|------|--|--|
|         |  | Expression             | Min  | Мах  | Onit |  |  |
| 480     | TIO Low  | $2 \times T_{C} + 2.0$ | 18.7 | _    | ns   |  |  |
| 481     | TIO High   | $2 \times T_{C} + 2.0$ | 18.7 | _    | ns   |  |  |
| Note: V | <b>Note:</b> $V_{CC} = 3.3 \text{ V} \pm 0.16 \text{ V}$ ; $T_J = -40^{\circ}\text{C}$ to $+110^{\circ}\text{C}$ , $C_L = 50 \text{ pF}$ |                        |      |      |      |  |  |

Table 3-24 Timer Timing

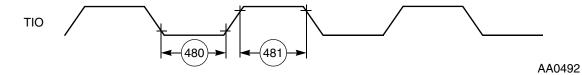


Figure 3-37 TIO Timer Event Input Restrictions

#### **GPIO** Timing 3.17

### Table 3-25 GPIO Timing

| No.              | Characteristics <sup>1</sup>                          | Expression                 | Min  | Max  | Unit |
|------------------|---|----------------------------|------|------|------|
| 490 <sup>2</sup> | EXTAL edge to GPIO out valid (GPIO out delay time)    |                            | _    | 32.8 | ns   |
| 491              | EXTAL edge to GPIO out not valid (GPIO out hold time) |                            | 4.8  | _    | ns   |
| 492              | GPIO In valid to EXTAL edge (GPIO in set-up time)     |                            | 10.2 | _    | ns   |
| 493              | EXTAL edge to GPIO in not valid (GPIO in hold time)   |                            | 1.8  | _    | ns   |
| 494 <sup>2</sup> | Fetch to EXTAL edge before GPIO change                | 6.75 × T <sub>C</sub> -1.8 | 54.5 | _    | ns   |
| 495              | GPIO out rise time                                    | _                          | _    | 13   | ns   |
| 496              | GPIO out fall time                                    | _                          | _    | 13   | ns   |

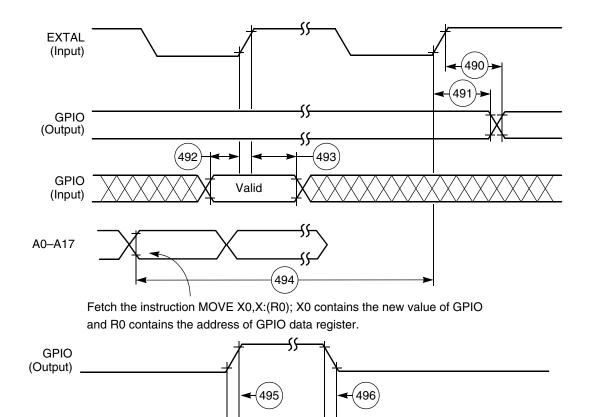


Figure 3-38 GPIO Timing

## 3.18 JTAG Timing

Table 3-26 JTAG Timing<sup>1, 2</sup>

| No. | Characteristics   | All freq | uencies | Unit |
|-----|---|----------|---------|------|
| NO. | Characteristics   | Min      | Max     | Unit |
| 500 | TCK frequency of operation $(1/(T_C \times 3); maximum 22 MHz)$ | 0.0      | 22.0    | MHz  |
| 501 | TCK cycle time in Crystal mode                                  | 45.0     | _       | ns   |
| 502 | TCK clock pulse width measured at 1.5 V                         | 20.0     | _       | ns   |
| 503 | TCK rise and fall times   | 0.0      | 3.0     | ns   |
| 504 | Boundary scan input data setup time                             | 5.0      | —       | ns   |
| 505 | Boundary scan input data hold time                              | 24.0     | _       | ns   |
| 506 | TCK low to output data valid                                    | 0.0      | 40.0    | ns   |
| 507 | TCK low to output high impedance                                | 0.0      | 40.0    | ns   |
| 508 | TMS, TDI data setup time  | 5.0      |         | ns   |

| No.          | Characteristics               | All freq | Unit |      |
|--------------|-------------------------------|----------|------|------|
|              |                               | Min      | Мах  | Gint |
| 509          | TMS, TDI data hold time       | 25.0     | —    | ns   |
| 510          | TCK low to TDO data valid     | 0.0      | 44.0 | ns   |
| 511          | TCK low to TDO high impedance | 0.0      | 44.0 | ns   |
| Notes:<br>4. | 1.                            |          |      |      |

 Table 3-26
 JTAG Timing<sup>1, 2</sup> (continued)

<sup>1</sup>  $V_{CC} = 3.3 \text{ V} \pm 0.16 \text{ V}; T_J = -40^{\circ}\text{C}$  to +110°C,  $C_L = 50 \text{ pF}$ <sup>2</sup> All timings apply to OnCE module data transfers because it uses the JTAG port as an interface.

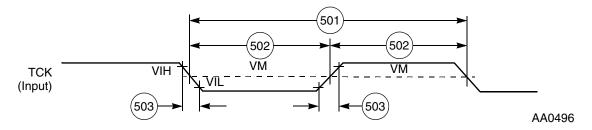


Figure 3-39 Test Clock Input Timing Diagram

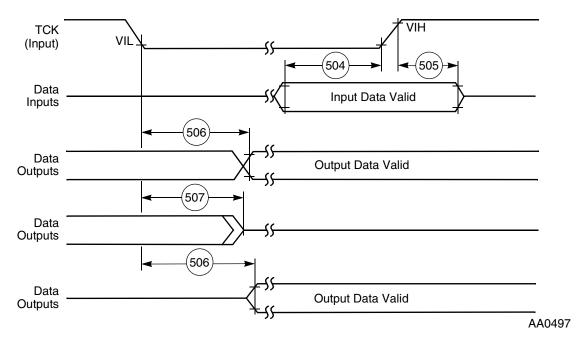


Figure 3-40 Boundary Scan (JTAG) Timing Diagram

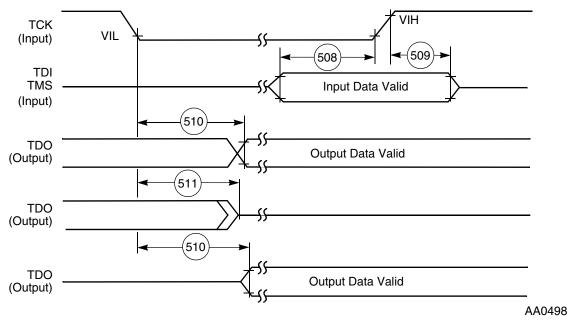


Figure 3-41 Test Access Port Timing Diagram

NOTES

# 4 Packaging

### 4.1 Pin-out and Package Information

This section provides information about the available package for this product, including diagrams of the package pinouts and tables describing how the signals described in Section 2, "Signal/Connection Descriptions" 1 are allocated for the package. The DSP56366 is available in a 144-pin LQFP package. Table 4-1 and Table 4-2 show the pin/name assignments for the packages.

### 4.1.1 LQFP Package Description

Top view of the 144-pin LQFP package is shown in Figure 4-1 with its pin-outs. The package drawing is shown in Figure 4-2.

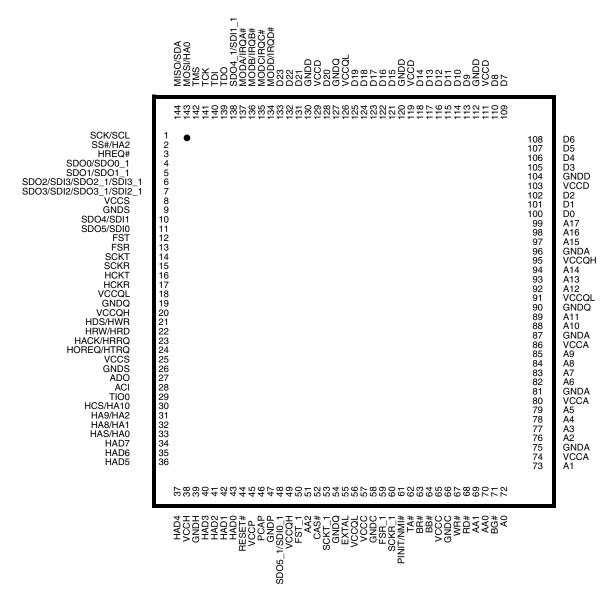


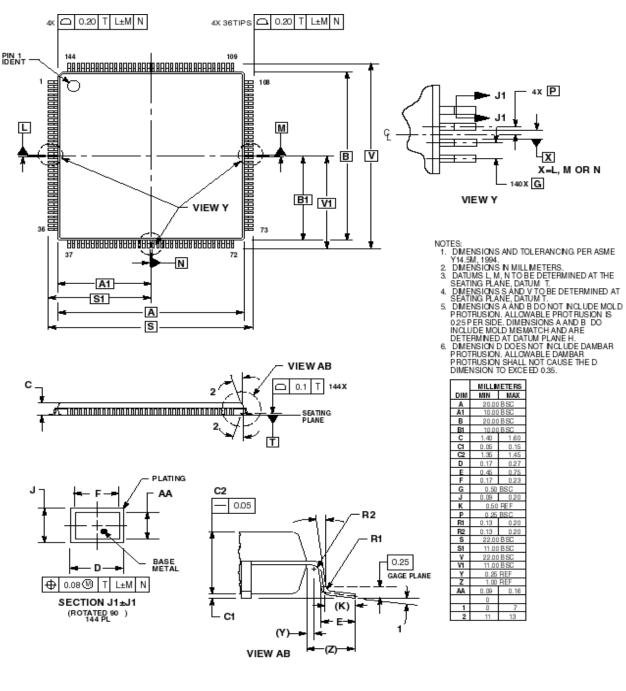
Figure 4-1 144-pin package

| Signal Name | Pin No. | Signal Name | Pin No. | Signal Name | Pin No. | Signal Name             | Pin No. |
|-------------|---------|-------------|---------|-------------|---------|-------------------------|---------|
| A0          | 72      | D9          | 113     | GNDS        | 9       | SDO0/SDO0_1             | 4       |
| A1          | 73      | D10         | 114     | GNDS        | 26      | SDO1/SDO1_1             | 5       |
| A2          | 76      | D11         | 115     | HA8/HA1     | 32      | SDO2/SDI3/SDO2_1/SDI3_1 | 6       |
| A3          | 77      | D12         | 116     | HA9/HA2     | 31      | SDO3/SDI2/SDO3_1/SDI2_1 | 7       |
| A4          | 78      | D13         | 117     | HACK/HRRQ   | 23      | SDO4/SDI1               | 10      |
| A5          | 79      | D14         | 118     | HAD0        | 43      | SDO4_1/SDI1_1           | 138     |
| A6          | 82      | D15         | 121     | HAD1        | 42      | SDO5/SDI0               | 11      |
| A7          | 83      | D16         | 122     | HAD2        | 41      | SDO5_1/SDI0_1           | 48      |
| A8          | 84      | D17         | 123     | HAD3        | 40      | SS#/HA2                 | 2       |
| A9          | 85      | D18         | 124     | HAD4        | 37      | TA#                     | 62      |
| A10         | 88      | D19         | 125     | HAD5        | 36      | TCK                     | 141     |
| A11         | 89      | D20         | 128     | HAD6        | 35      | TDI                     | 140     |
| A12         | 92      | D21         | 131     | HAD7        | 34      | TDO                     | 139     |
| A13         | 93      | D22         | 132     | HAS/HA0     | 33      | TIO0                    | 29      |
| A14         | 94      | D23         | 133     | HCKR        | 17      | TMS                     | 142     |
| A15         | 97      | EXTAL       | 55      | HCKT        | 16      | VCCA                    | 74      |
| A16         | 98      | FSR         | 13      | HCS/HA10    | 30      | VCCA                    | 80      |
| A17         | 99      | FSR_1       | 59      | HDS/HWR     | 21      | VCCA                    | 86      |
| AA0         | 70      | FST         | 12      | HOREQ/HTRQ  | 24      | VCCC                    | 57      |
| AA1         | 69      | FST_1       | 50      | HREQ#       | 3       | VCCC                    | 65      |
| AA2         | 51      | GNDA        | 75      | HRW/HRD     | 22      | VCCD                    | 103     |
| ACI         | 28      | GNDA        | 81      | MODA/IRQA#  | 137     | VCCD                    | 111     |
| ADO         | 27      | GNDA        | 87      | MODB/IRQB#  | 136     | VCCD                    | 119     |
| BB#         | 64      | GNDA        | 96      | MODC/IRQC#  | 135     | VCCD                    | 129     |
| BG#         | 71      | GNDC        | 58      | MODD/IRQD#  | 134     | VCCH                    | 38      |
| BR#         | 63      | GNDC        | 66      | MISO/SDA    | 144     | VCCQH                   | 20      |
| CAS#        | 52      | GNDD        | 104     | MOSI/HA0    | 143     | VCCQH                   | 95      |
| D0          | 100     | GNDD        | 112     | PCAP        | 46      | VCCQH                   | 49      |
| D1          | 101     | GNDD        | 120     | PINIT/NMI#  | 61      | VCCQL                   | 18      |
| D2          | 102     | GNDD        | 130     | RD#         | 68      | VCCQL                   | 56      |
| D3          | 105     | GNDH        | 39      | RESET#      | 44      | VCCQL                   | 91      |
| D4          | 106     | GNDP        | 47      | SCK/SCL     | 1       | VCCQL                   | 126     |
| D5          | 107     | GNDQ        | 19      | SCKR        | 15      | VCCP                    | 45      |
| D6          | 108     | GNDQ        | 54      | SCKR_1      | 60      | VCCS                    | 8       |
| D7          | 109     | GNDQ        | 90      | SCKT        | 14      | VCCS                    | 25      |
| D8          | 110     | GNDQ        | 127     | SCKT_1      | 53      | WR#                     | 67      |

| Table 4-1 | Signal Identification by Name |
|-----------|-------------------------------|
|-----------|-------------------------------|

| Pin No. | Signal Name             | Pin No. | Signal Name   | Pin No. | Signal Name | Pin No. | Signal Name   |
|---------|-------------------------|---------|---------------|---------|-------------|---------|---------------|
| 1       | SCK/SCL                 | 37      | HAD4          | 73      | A1          | 109     | D7            |
| 2       | SS#/HA2                 | 38      | VCCH          | 74      | VCCA        | 110     | D8            |
| 3       | HREQ#                   | 39      | GNDH          | 75      | GNDA        | 111     | VCCD          |
| 4       | SDO0/SDO0_1             | 40      | HAD3          | 76      | A2          | 112     | GNDD          |
| 5       | SDO1/SDO1_1             | 41      | HAD2          | 77      | A3          | 113     | D9            |
| 6       | SDO2/SDI3/SDO2_1/SDI3_1 | 42      | HAD1          | 78      | A4          | 114     | D10           |
| 7       | SDO3/SDI2/SDO3_1/SDI2_1 | 43      | HAD0          | 79      | A5          | 115     | D11           |
| 8       | VCCS                    | 44      | RESET#        | 80      | VCCA        | 116     | D12           |
| 9       | GNDS                    | 45      | VCCP          | 81      | GNDA        | 117     | D13           |
| 10      | SDO4/SDI1               | 46      | PCAP          | 82      | A6          | 118     | D14           |
| 11      | SDO5/SDI0               | 47      | GND           | 83      | A7          | 119     | VCCD          |
| 12      | FST                     | 48      | SDO5_1/SDI0_1 | 84      | A8          | 120     | GNDD          |
| 13      | FSR                     | 49      | VCCQH         | 85      | A9          | 121     | D15           |
| 14      | SCKT                    | 50      | FST_1         | 86      | VCCA        | 122     | D16           |
| 15      | SCKR                    | 51      | AA2           | 87      | GNDA        | 123     | D17           |
| 16      | НСКТ                    | 52      | CAS#          | 88      | A10         | 124     | D18           |
| 17      | HCKR                    | 53      | SCKT_1        | 89      | A11         | 125     | D19           |
| 18      | VCCQL                   | 54      | GNDQ          | 90      | GNDQ        | 126     | VCCQL         |
| 19      | GNDQ                    | 55      | EXTAL         | 91      | VCCQL       | 127     | GNDQ          |
| 20      | VCCQH                   | 56      | VCCQL         | 92      | A12         | 128     | D20           |
| 21      | HDS/HWR                 | 57      | VCCC          | 93      | A13         | 129     | VCCD          |
| 22      | HRW/HRD                 | 58      | GNDC          | 94      | A14         | 130     | GNDD          |
| 23      | HACK/HRRQ               | 59      | FSR_1         | 95      | VCCQH       | 131     | D21           |
| 24      | HOREQ/HTRQ              | 60      | SCKR_1        | 96      | GNDA        | 132     | D22           |
| 25      | VCCS                    | 61      | PINIT/NMI#    | 97      | A15         | 133     | D23           |
| 26      | GNDS                    | 62      | TA#           | 98      | A16         | 134     | MODD/IRQD#    |
| 27      | ADO                     | 63      | BR#           | 99      | A17         | 135     | MODC/IRQC#    |
| 28      | ACI                     | 64      | BB#           | 100     | D0          | 136     | MODB/IRQB#    |
| 29      | TIO0                    | 65      | VCCC          | 101     | D1          | 137     | MODA/IRQA#    |
| 30      | HCS/HA10                | 66      | GNDC          | 102     | D2          | 138     | SDO4_1/SDI1_1 |
| 31      | HA9/HA2                 | 67      | WR#           | 103     | VCCD        | 139     | TDO           |
| 32      | HA8/HA1                 | 68      | RD#           | 104     | GNDD        | 140     | TDI           |
| 33      | HAS/HA0                 | 69      | AA1           | 105     | D3          | 141     | тск           |
| 34      | HAD7                    | 70      | AA0           | 106     | D4          | 142     | TMS           |
| 35      | HAD6                    | 71      | BG#           | 107     | D5          | 143     | MOSI/HA0      |
| 36      | HAD5                    | 72      | A0            | 108     | D6          | 144     | MISO/SDA      |

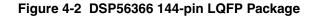
 Table 4-2
 Signal Identification by Pin Number



### 4.1.2 LQFP Package Mechanical Drawing

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# 5 Design Considerations

### 5.1 Thermal Design Considerations

An estimation of the chip junction temperature, T<sub>J</sub>, in °C can be obtained from the following equation:

$$T_{J} = T_{A} + (P_{D} \times R_{\theta JA})$$

Where:

 $T_A$  = ambient temperature °C

 $R_{aJA}$  = package junction-to-ambient thermal resistance °C/W

 $P_D$  = power dissipation in package W

Historically, thermal resistance has been expressed as the sum of a junction-to-case thermal resistance and a case-to-ambient thermal resistance.

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$$

Where:

 $R_{\theta JA}$  = package junction-to-ambient thermal resistance °C/W

 $R_{\theta JC}$  = package junction-to-case thermal resistance °C/W

 $R_{\theta CA}$  = package case-to-ambient thermal resistance °C/W

 $R_{\theta JC}$  is device-related and cannot be influenced by the user. The user controls the thermal environment to change the case-to-ambient thermal resistance,  $R_{\theta CA}$ . For example, the user can change the air flow around the device, add a heat sink, change the mounting arrangement on the printed circuit board (PCB), or otherwise change the thermal dissipation capability of the area surrounding the device on a PCB. This model is most useful for ceramic packages with heat sinks; some 90% of the heat flow is dissipated through the case to the heat sink and out to the ambient environment. For ceramic packages, in situations where the heat flow is split between a path to the case and an alternate path through the PCB, analysis of the device thermal performance may need the additional modeling capability of a system level thermal simulation tool.

The thermal performance of plastic packages is more dependent on the temperature of the PCB to which the package is mounted. Again, if the estimations obtained from  $R_{\theta JA}$  do not satisfactorily answer whether the thermal performance is adequate, a system level model may be appropriate.

A complicating factor is the existence of three common ways for determining the junction-to-case thermal resistance in plastic packages.

• To minimize temperature variation across the surface, the thermal resistance is measured from the junction to the outside surface of the package (case) closest to the chip mounting area when that surface has a proper heat sink.

- To define a value approximately equal to a junction-to-board thermal resistance, the thermal resistance is measured from the junction to where the leads are attached to the case.
- If the temperature of the package case  $(T_T)$  is determined by a thermocouple, the thermal resistance is computed using the value obtained by the equation  $(T_J T_T)/P_D$ .

As noted above, the junction-to-case thermal resistances quoted in this data sheet are determined using the first definition. From a practical standpoint, that value is also suitable for determining the junction temperature from a case thermocouple reading in forced convection environments. In natural convection, using the junction-to-case thermal resistance to estimate junction temperature from a thermocouple reading on the case of the package will estimate a junction temperature slightly hotter than actual temperature. Hence, the new thermal metric, thermal characterization parameter or  $\Psi_{JT}$ , has been defined to be  $(T_J - T_T)/P_D$ . This value gives a better estimate of the junction temperature in natural convection when using the surface temperature of the package. Remember that surface temperature readings of packages are subject to significant errors caused by inadequate attachment of the sensor to the surface and to errors caused by heat loss to the sensor. The recommended technique is to attach a 40-gauge thermocouple wire and bead to the top center of the package with thermally conductive epoxy.

## 5.2 Electrical Design Considerations

### CAUTION

This device contains circuitry protecting against damage due to high static voltage or electrical fields. However, normal precautions should be taken to avoid exceeding maximum voltage ratings. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). The suggested value for a pullup or pulldown resistor is 10 kOhm.

Use the following list of recommendations to assure correct DSP operation:

- Provide a low-impedance path from the board power supply to each  $V_{CC}$  pin on the DSP and from the board ground to each GND pin.
- Use at least six 0.01–0.1  $\mu$ F bypass capacitors positioned as close as possible to the four sides of the package to connect the V<sub>CC</sub> power source to GND.
- Ensure that capacitor leads and associated printed circuit traces that connect to the chip  $V_{CC}$  and GND pins are less than 1.2 cm (0.5 inch) per capacitor lead.
- Use at least a four-layer PCB with two inner layers for  $V_{CC}$  and GND.
- Because the DSP output signals have fast rise and fall times, PCB trace lengths should be minimal. <u>This recommendation particularly</u> applies to the address and data buses as well as the <u>IRQA</u>, <u>IRQB</u>, <u>IRQC</u>, <u>IRQD</u>, <u>TA and BG</u> pins. Maximum PCB trace lengths on the order of 15 cm (6 inches) are recommended.
- Consider all device loads as well as parasitic capacitance due to PCB traces when calculating capacitance. This is especially critical in systems with higher capacitive loads that could create higher transient currents in the  $V_{CC}$  and GND circuits.
- All inputs must be terminated (i.e., not allowed to float) using CMOS levels, except for the three pins with internal pull-up resistors (TMS, TDI, TCK).

- Take special care to minimize noise levels on the  $V_{CCP}$  and  $GND_P$  pins.
- If multiple DSP56366 devices are on the same board, check for cross-talk or excessive spikes on the supplies due to synchronous operation of the devices.
- RESET must be asserted when the chip is powered up. A stable EXTAL signal must be supplied while RESET is being asserted.
- At power-up, ensure that the voltage difference between the 5 V tolerant pins and the chip  $V_{CC}$  never exceeds 3.95 V.

## 5.3 **Power Consumption Considerations**

Power dissipation is a key issue in portable DSP applications. Some of the factors which affect current consumption are described in this section. Most of the current consumed by CMOS devices is alternating current (ac), which is charging and discharging the capacitances of the pins and internal nodes.

Current consumption is described by the following formula:

$$I = C \times V \times f$$

where:

C = node/pin capacitance

V = voltage swing

f = frequency of node/pin toggle

### **Example 1. Current Consumption**

For a Port A address pin loaded with 50 pF capacitance, operating at 3.3 V, and with a 120 MHz clock, toggling at its maximum possible rate (60 MHz), the current consumption is

$$I = 50 \times 10^{-12} \times 3.3 \times 60 \times 10^{6} = 9.9 \text{ mA}$$

The maximum internal current ( $I_{CCI}$ max) value reflects the typical possible switching of the internal buses on best-case operation conditions, which is not necessarily a real application case. The typical internal current ( $I_{CCItvp}$ ) value reflects the average switching of the internal buses on typical operating conditions.

For applications that require very low current consumption, do the following:

- Set the EBD bit when not accessing external memory.
- Minimize external memory accesses and use internal memory accesses.
- Minimize the number of pins that are switching.
- Minimize the capacitive load on the pins.
- Connect the unused inputs to pull-up or pull-down resistors.
- Disable unused peripherals.

One way to evaluate power consumption is to use a current per MIPS measurement methodology to minimize specific board effects (i.e., to compensate for measured board current not caused by the DSP). A benchmark power consumption test algorithm is listed in **Appendix A**. Use the test algorithm, specific test current measurements, and the following equation to derive the current per MIPS value.

$$I/MIPS = I/MHz = (I_{tvpF2} - I_{tvpF1})/(F2 = F1)$$

where:

$$\begin{split} I_{typF2} &= \text{ current at F2} \\ I_{typF1} &= \text{ current at F1} \\ F2 &= \text{ high frequency (any specified operating frequency)} \\ F1 &= \text{ low frequency (any specified operating frequency lower than F2)} \end{split}$$

### NOTE

F1 should be significantly less than F2. For example, F2 could be 66 MHz and F1 could be 33 MHz. The degree of difference between F1 and F2 determines the amount of precision with which the current rating can be determined for an application.

## 5.4 PLL Performance Issues

The following explanations should be considered as general observations on expected PLL behavior. There is no testing that verifies these exact numbers. These observations were measured on a limited number of parts and were not verified over the entire temperature and voltage ranges.

### 5.4.1 Phase Jitter Performance

The phase jitter of the PLL is defined as the variations in the skew between the falling edges of EXTAL and the internal DSP clock for a given device in specific temperature, voltage, input frequency and MF. These variations are a result of the PLL locking mechanism. For input frequencies greater than 15 MHz and MF  $\leq$  4, this jitter is less than ±0.6 ns; otherwise, this jitter is not guaranteed. However, for MF < 10 and input frequencies greater than 10 MHz, this jitter is less than ±2 ns.

### 5.4.2 Frequency Jitter Performance

The frequency jitter of the PLL is defined as the variation of the frequency of the internal DSP clock. For small MF (MF < 10) this jitter is smaller than 0.5%. For mid-range MF (10 < MF < 500) this jitter is between 0.5% and approximately 2%. For large MF (MF > 500), the frequency jitter is 2–3%.

## 5.4.3 Input (EXTAL) Jitter Requirements

The allowed jitter on the frequency of EXTAL is 0.5%. If the rate of change of the frequency of EXTAL is slow (i.e., it does not jump between the minimum and maximum values in one cycle) or the frequency of the jitter is fast (i.e., it does not stay at an extreme value for a long time), then the allowed jitter can be 2%. The phase and frequency jitter performance results are only valid if the input jitter is less than the prescribed values.

## 5.5 Host Port Considerations

Careful synchronization is required when reading multi-bit registers that are written by another asynchronous system. This synchronization is a common problem when two asynchronous systems are connected, as they are in the host interface. The following paragraphs present considerations for proper operation.

### 5.5.1 Host Programming Considerations

- Unsynchronized Reading of Receive Byte Registers—When reading the receive byte registers, receive register high (RXH), receive register middle (RXM), or receive register low (RXL), the host interface programmer should use interrupts or poll the receive register data full (RXDF) flag that indicates whether data is available. This ensures that the data in the receive byte registers will be valid.
- **Overwriting Transmit Byte Registers**—The host interface programmer should not write to the transmit byte registers, transmit register high (TXH), transmit register middle (TXM), or transmit register low (TXL), unless the transmit register data empty (TXDE) bit is set, indicating that the transmit byte registers are empty. This ensures that the transmit byte registers will transfer valid data to the host receive (HRX) register.
- **Synchronization of Status Bits from DSP to Host**—HC, HOREQ, DMA, HF3, HF2, TRDY, TXDE, and RXDF status bits are set or cleared from inside the DSP and read by the host processor (refer to the user's manual for descriptions of these status bits). The host can read these status bits very quickly without regard to the clock rate used by the DSP, but the state of the bit could be changing during the read operation. This is not generally a system problem, because the bit will be read correctly in the next pass of any host polling routine.

However, if the host asserts  $\overline{\text{HEN}}$  for more than timing number 31, with a minimum cycle time of timing number 31 + 32, then these status bits are guaranteed to be stable. Exercise care when reading status bits HF3 and HF2 as an encoded pair. If the DSP changes HF3 and HF2 from 00 to 11, there is a small probability that the host could read the bits during the transition and receive 01 or 10 instead of 11. If the combination of HF3 and HF2 has significance, the host could read the wrong combination. Therefore, read the bits twice and check for consensus.

- **Overwriting the Host Vector**—The host interface programmer should change the host vector (HV) register only when the host command (HC) bit is clear. This ensures that the DSP interrupt control logic will receive a stable vector.
- **Cancelling a Pending Host Command Exception**—The host processor may elect to clear the HC bit to cancel the host command exception request at any time before it is recognized by the DSP. Because the host does not know exactly when the exception will be recognized (due to exception processing synchronization and pipeline delays), the DSP may execute the host command exception after the HC bit is cleared. For these reasons, the HV bits must not be changed at the same time that the HC bit is cleared.
- Variance in the Host Interface Timing—The host interface (HDI) may vary (e.g. due to the PLL lock time at reset). Therefore, a host which attempts to load (bootstrap) the DSP should first make

sure that the part has completed its HI port programming (e.g., by setting the INIT bit in ICR then polling it and waiting it to be cleared, then reading the ISR or by writing the TREQ/RREQ together with the INIT and then polling INIT, ISR, and the  $\overline{\text{HOREQ}}$  pin).

### 5.5.2 DSP Programming Considerations

- **Synchronization of Status Bits from Host to DSP**—DMA, HF1, HF0, HCP, HTDE, and HRDF status bits are set or cleared by the host processor side of the interface. These bits are individually synchronized to the DSP clock. (Refer to the user's manual for descriptions of these status bits.)
- **Reading HF0 and HF1 as an Encoded Pair**—Care must be exercised when reading status bits HF0 and HF1 as an encoded pair, (i.e., the four combinations 00, 01, 10, and 11 each have significance). A very small probability exists that the DSP will read the status bits synchronized during transition. Therefore, HF0 and HF1 should be read twice and checked for consensus.

# 6 Ordering Information

Consult a Freescale Semiconductor, Inc. sales office or authorized distributor to determine product availability and to place an order.

For information on ordering DSP Audio products, refer to the current SG1004, DSP Selector Guide, at <u>http://www.freescale.com</u>

NOTES

# **Appendix A Power Consumption Benchmark**

The following benchmark program permits evaluation of DSP power usage in a test situation. It enables the PLL, disables the external clock, and uses repeated multiply-accumulate instructions with a set of synthetic DSP application data to emulate intensive sustained DSP operation.

```
;* ;* CHECKS
           Typical Power Consumption
200,55,0,0,0
       page
       nolist
I VEC EQU $000000 ; Interrupt vectors for program debug only
START EQU $8000 ; MAIN (external) program starting address
INT PROG EQU $100 ; INTERNAL program memory starting address
INT XDAT EQU $0 ; INTERNAL X-data memory starting address
INT YDAT EQU $0 ; INTERNAL Y-data memory starting address
       INCLUDE "ioequ.asm"
       INCLUDE "intequ.asm"
       list
       org
             P:START
;
       movep #$0123FF, x:M BCR; BCR: Area 3 : 1 w.s (SRAM)
; Default: 1 w.s (SRAM)
;
             #$0d0000,x:M PCTL
                                    ; XTAL disable
       movep
                      ; PLL enable
                      ; CLKOUT disable
;
; Load the program
;
            #INT_PROG,r0
       move
       move
             #PROG START, r1
       do
             #(PROG END-PROG START), PLOAD LOOP
       move
             p:(r1)+,x0
       move
              x0,p:(r0)+
       nop
PLOAD LOOP
;
; Load the X-data
;
              #INT XDAT, r0
       move
```

```
#XDAT START,r1
          move
                    #(XDAT_END-XDAT_START),XLOAD_LOOP
          do
          move
                    p:(r1)+,x0
                    x0,x:(r0)+
          move
XLOAD LOOP
;
; Load the Y-data
;
                    #INT_YDAT,r0
          move
                    #YDAT START,r1
          move
          do
                    #(YDAT_END-YDAT_START),YLOAD_LOOP
          move
                    p:(r1)+,x0
                    x0,y:(r0)+
          move
YLOAD_LOOP
;
          jmp
                    INT PROG
PROG START
                    #$0,r0
          move
                    #$0,r4
          move
                    #$3f,m0
          move
          move
                    #$3f,m4
;
          clr
                    а
          clr
                    b
                    #$0,x0
          move
                    #$0,x1
          move
                    #$0,y0
          move
                    #$0,y1
          move
          bset
                    #4, omr
                                        ; ebd
;
sbr
          dor
                    #60,_end
          mac
                    x0,y0,a
                             x:(r0)+,x1
                                                  y:(r4)+,y1
                    x1,y1,a
                             x:(r0)+,x0
          mac
                                                  y:(r4)+,y0
          add
                    a,b
                    x0,y0,a
                            x:(r0)+,x1
          mac
                                                  y:(r4)+,y0
          mac
                    x1,y1,a
          move
                    b1,x:$ff
_end
          bra
                    sbr
          nop
          nop
          nop
          nop
PROG END
          nop
          nop
XDAT START
          org
                    x:0
;
          dc
                    $262EB9
          dc
                    $86F2FE
          dc
                    $E56A5F
```

| dc | \$616CAC             |
|----|----------------------|
| dc | \$8FFD75             |
| dc | \$9210A              |
| dc | \$A06D7B             |
| dc | \$CEA798             |
| dc | \$8DFBF1             |
| dc | \$A063D6             |
| dc | \$6C6657             |
| dc | \$C2A544             |
| dc | \$A3662D             |
| dc |                      |
|    | \$A4E762             |
| dc | \$84F0F3             |
| dc | \$E6F1B0             |
| dc | \$B3829              |
| dc | \$8BF7AE             |
| dc | \$63A94F             |
| dc | \$EF78DC             |
| dc | \$242DE5             |
| dc | \$A3E0BA             |
| dc | \$EBAB6B             |
| dc | \$8726C8             |
| dc | \$CA361              |
| dc | \$2F6E86             |
| dc | \$A57347             |
| dc | \$4BE774             |
| dc | \$8F349D             |
| dc | \$A1ED12             |
| dc | \$4BFCE3             |
| dc | \$EA26E0             |
| dc | \$CD7D99             |
| dc | \$4BA85E             |
| dc | \$46A05E<br>\$27A43F |
| dc |                      |
|    | \$A8B10C             |
| dc | \$D3A55              |
| dc | \$25EC6A             |
| dc | \$2A255B             |
| dc | \$A5F1F8             |
| dc | \$2426D1             |
| dc | \$AE6536             |
| dc | \$CBBC37             |
| dc | \$6235A4             |
| dc | \$37F0D              |
| dc | \$63BEC2             |
| dc | \$A5E4D3             |
| dc | \$8CE810             |
| dc | \$3FF09              |
| dc | \$60E50E             |
| dc | \$CFFB2F             |
| dc | \$40753C             |
| dc | \$8262C5             |
| dc | \$CA641A             |
| dc | \$EB3B4B             |
| dc | \$2DA928             |
| dc | \$AB6641             |
| dc | \$28A7E6             |
|    | ,                    |

| dc       | \$4E2127 |
|----------|----------|
| dc       | \$482FD4 |
| dc       | \$7257D  |
| dc       | \$E53C72 |
| dc       | \$1A8C3  |
| dc       | \$E27540 |
| XDAT_END |          |

YDAT\_START

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| 'AR'I' |          |
|--------|----------|
| org    | у:О      |
| dc     | \$5B6DA  |
| dc     | \$C3F70B |
| dc     | \$6A39E8 |
| dc     | \$81E801 |
| dc     | \$C666A6 |
| dc     | \$46F8E7 |
| dc     | \$AAEC94 |
| dc     | \$24233D |
| dc     | \$802732 |
| dc     | \$2E3C83 |
| dc     | \$A43E00 |
| dc     | \$C2B639 |
| dc     | \$85A47E |
| dc     | \$ABFDDF |
| dc     | \$F3A2C  |
| dc     | \$2D7CF5 |
| dc     | \$E16A8A |
| dc     | \$ECB8FB |
| dc     | \$4BED18 |
| dc     | \$43F371 |
| dc     | \$83A556 |
| dc     | \$E1E9D7 |
| dc     | \$ACA2C4 |
| dc     | \$8135AD |
| dc     | \$2CE0E2 |
| dc     | \$8F2C73 |
| dc     | \$432730 |
| dc     | \$A87FA9 |
| dc     | \$4A292E |
| dc     | \$A63CCF |
| dc     | \$6BA65C |
| dc     | \$E06D65 |
| dc     | \$1AA3A  |
| dc     | \$A1B6EB |
| dc     | \$48AC48 |
| dc     | \$EF7AE1 |
| dc     | \$6E3006 |
| dc     | \$62F6C7 |
| dc     | \$6064F4 |
| dc     | \$87E41D |
| dc     | \$CB2692 |
| dc     | \$2C3863 |
| dc     | \$C6BC60 |
| dc     | \$43A519 |
| dc     | \$6139DE |
|        |          |

| dc | \$ADF7BF |
|----|----------|
| dc | \$4B3E8C |
| dc | \$6079D5 |
| dc | \$E0F5EA |
| dc | \$8230DB |
| dc | \$A3B778 |
| dc | \$2BFE51 |
| dc | \$E0A6B6 |
| dc | \$68FFB7 |
| dc | \$28F324 |
| dc | \$8F2E8D |
| dc | \$667842 |
| dc | \$83E053 |
| dc | \$A1FD90 |
| dc | \$6B2689 |
| dc | \$85B68E |
| dc | \$622EAF |
| dc | \$6162BC |
| dc | \$E4A245 |
|    |          |

YDAT\_END

### NOTES

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